

## TAS5756M Digital Input, Closed-Loop Class-D Amplifier With Processing

### 1 Features

- Flexible Audio I/O Configuration
  - Supports I<sup>2</sup>S, TDM, LJ, RJ Digital Input
  - 8 kHz to 192 kHz Sample Rate Support
  - Stereo Bridge Tied Load (BTL) or Mono Parallel Bridge Tied Load (PBTL) Operation
  - BD Amplifier Modulation
  - Supports 3-Wire Digital Audio Interface (No MCLK required)
- High-Performance Closed-Loop Architecture (PVDD = 12V, R<sub>SPK</sub> = 8 Ω, SPK\_GAIN = 20 dBV)
  - Idle Channel Noise = 56 μVrms (A-Wtd)
  - THD+N = 0.006 % (at 1 W, 1 kHz)
  - SNR = 104 A-Wtd (Ref. to THD+N = 1%)
- PurePath™ HybridFlow Processing Architecture
  - Several Configurable MiniDSP Programs (called HybridFlows)
  - Download Time <100 ms (typ)
  - Advanced Audio Processing Algorithms <sup>(2)</sup>
- Communication Features
  - Software Mode Control via I<sup>2</sup>C Port
  - Two Address Select Pins – Up to 4 Devices
- Robustness and Reliability Features
  - Clock Error, DC, and Short-Circuit Protection
  - Over Temperature and Overcurrent Protection

### 2 Applications

- LCD, LED TV, and Multi-Purpose Monitors
- Sound Bars, Docking Stations, PC Audio
- Wireless Subwoofers, Bluetooth and Active Speakers

### 3 Description

The TAS5756M device is a high-performance, stereo closed-loop amplifier with integrated audio processor with architecture. To convert from digital to analog, the device uses a high performance DAC with Burr-Brown® mixed signal heritage. It requires only two power supplies; one DVDD for low-voltage circuitry and one PVDD for high-voltage circuitry. It is controlled by a software control port using standard I<sup>2</sup>C communication. In the family, the TAS5756M uses traditional BD modulation, ensuring low distortion characteristics. The TAS5754M uses 1SPW modulation to reduce output ripple current, the expense of slightly higher distortion.

The unique HybridFlow architecture allows the system designer to choose from several configurable DSP programs that are specifically designed for use in popular audio end equipment such as bluetooth (BT) speakers, sound bars, docking stations, and subwoofers. This architecture combines the flexibility of a fully programmable device with the fast download time and ease of use of a fixed-function ROM device.

An optimal mix of thermal performance and device cost is provided in the 90 mΩ r<sub>DS(on)</sub> of the output MOSFETs. Additionally, a thermally enhanced 48-Pin HTSSOP provides excellent operation in the elevated ambient temperatures found in modern consumer electronic devices.

#### Device Information<sup>(1)</sup>

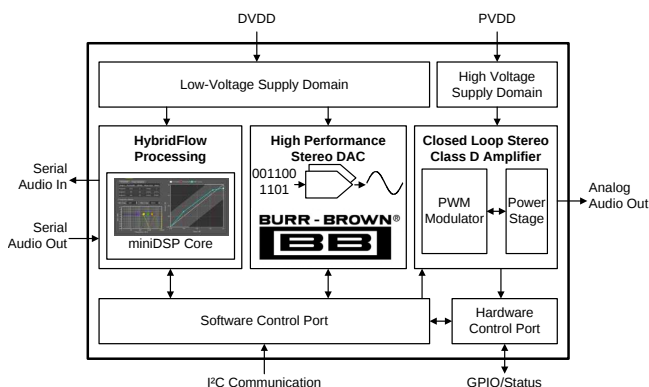
| PART NUMBER | PACKAGE     | BODY SIZE (NOM)    |
|-------------|-------------|--------------------|
| TAS5756M    | HTSSOP (48) | 12.50 mm × 6.10 mm |

(1) For all available packages, see the orderable addendum at the end of the datasheet.

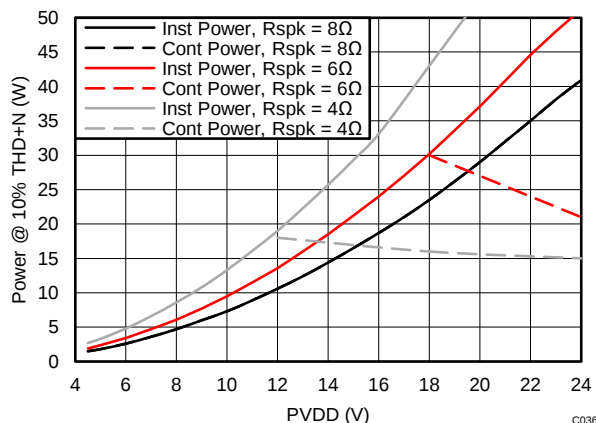
(2) Please refer to [SLAU577](#) for information regarding Audio Processing options available via the HybridFlow library.

(3) Tested on TAS5756MDCAEVM.

#### Simplified Block Diagram



#### Power at 10% THD+N vs PVDD<sup>(3)</sup>



C036



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## 4 Revision History

| Changes from Revision A (January 2015) to Revision B                                                                                                         | Page |
|--------------------------------------------------------------------------------------------------------------------------------------------------------------|------|
| • Added TAS880021DCA device to <a href="#">Device Comparison Table</a> .....                                                                                 | 3    |
| • Clarified OCE <sub>CLRTIME</sub> specification in <i>Electrical Characteristics</i> table .....                                                            | 11   |
| • Clarified OTE <sub>CLRTIME</sub> specification in <i>Electrical Characteristics</i> table .....                                                            | 11   |
| • Corrected several typographical errors in <i>Electrical Characteristics</i> table .....                                                                    | 12   |
| • Removed reference to Frequency Response graphs in <a href="#">Table 25</a> .....                                                                           | 24   |
| • Clarified clock generation explanation in <a href="#">Device Clocking</a> section .....                                                                    | 33   |
| • Clarified description of the modulation scheme used in the Class D amplifier in <a href="#">Modulation Scheme</a> section .....                            | 49   |
| • Added clarity to <a href="#">Adjustable Amplifier Gain and Switching Frequency Selection</a> section .....                                                 | 51   |
| • Added example resistor values for SPK_GAIN/FREQ pin configuration to <a href="#">Table 15</a> .....                                                        | 52   |
| • Clarified the description of overtemperature error from latching to self-clearing in <a href="#">Device Overtemperature Protection</a> section .....       | 52   |
| • Corrected description of the overcurrent protection error from latching to self-clearing in <a href="#">SPK_OUTxx Overcurrent Protection</a> section ..... | 53   |
| • Added clarity to <a href="#">I<sup>2</sup>C Communication Port</a> section .....                                                                           | 55   |
| • Added <a href="#">Programming the TAS5756M</a> section .....                                                                                               | 61   |
| • Updated <a href="#">Table 22</a> .....                                                                                                                     | 64   |
| • Updated <a href="#">Table 25</a> .....                                                                                                                     | 69   |
| • Updated <a href="#">Table 27</a> .....                                                                                                                     | 73   |

## Changes from Original (June 2014) to Revision A

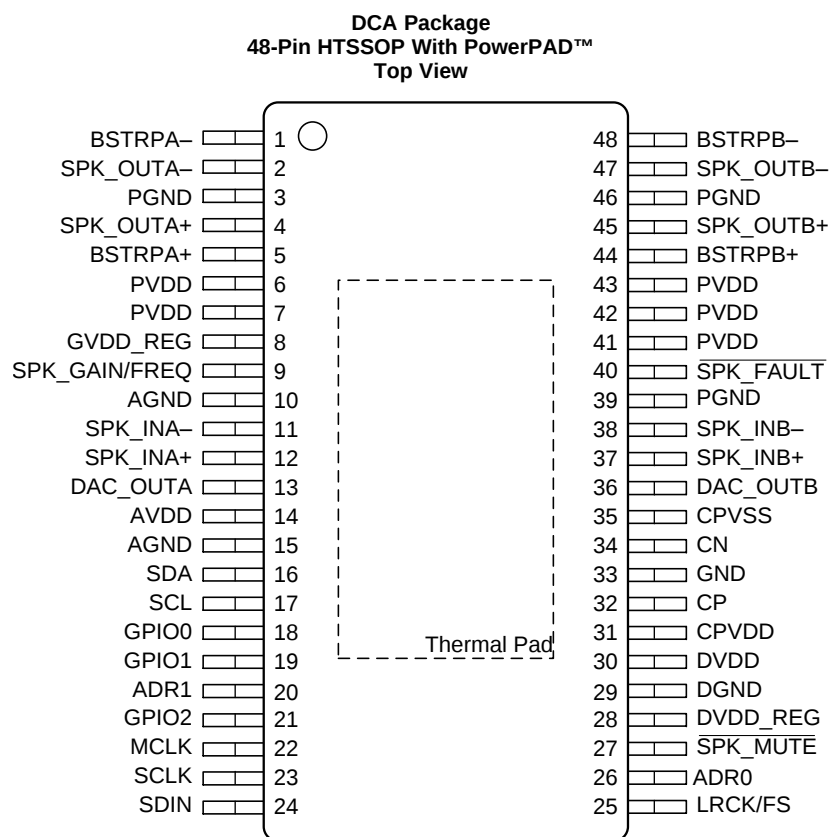
Page

|                                                                                                      |    |
|------------------------------------------------------------------------------------------------------|----|
| • Corrected typographical error in Device Information table .....                                    | 1  |
| • Updated <a href="#">Functional Block Diagram</a> .....                                             | 33 |
| • Updated <a href="#">Table 15</a> .....                                                             | 52 |
| • Added component specification note in <a href="#">Application and Implementation</a> section ..... | 60 |

## 5 Device Comparison Table

| DEVICE NAME  | MODULATION STYLE | PROCESSING TYPE                                                                             |
|--------------|------------------|---------------------------------------------------------------------------------------------|
| TAS5754MDCA  | 1SPW (Ternary)   | 50MIPs, HybridFlow (Uses mixture of RAM and ROM components to create several process flows) |
| TAS5756MDCA  | BD Modulation    | 50MIPs, HybridFlow (Uses mixture of RAM and ROM components to create several process flows) |
| TAS880021DCA | 1SPW (Ternary)   | 100MIPs, Fixed-Function (Uses single ROM image of process flow)                             |

## 6 Pin Configuration and Functions



## Pin Functions

| PIN      |     | TYPE <sup>(1)</sup> | INTERNAL TERMINATION | DESCRIPTION                                                                                                                                                                                                                                                                                                                                                  |
|----------|-----|---------------------|----------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| NAME     | NO. |                     |                      |                                                                                                                                                                                                                                                                                                                                                              |
| ADR0     | 26  | DI                  | Figure 11            | Sets the LSB of the I <sup>2</sup> C address to 0 if pulled to GND, to 1 if pulled to DVDD                                                                                                                                                                                                                                                                   |
| ADR1     | 20  | DI                  |                      | Sets the second LSB of the I <sup>2</sup> C address to 0 if pulled to GND, to 1 if pulled to DVDD                                                                                                                                                                                                                                                            |
| AGND     | 10  | G                   | —                    | Ground reference for analog circuitry <sup>(2)</sup>                                                                                                                                                                                                                                                                                                         |
|          | 15  |                     |                      |                                                                                                                                                                                                                                                                                                                                                              |
| AVDD     | 14  | P                   | Figure 2             | Power supply for internal analog circuitry                                                                                                                                                                                                                                                                                                                   |
| BSTRPA–  | 1   | P                   | Figure 3             | Connection point for the SPK_OUTA– bootstrap capacitor which is used to create a power supply for the high-side gate drive for SPK_OUTA–                                                                                                                                                                                                                     |
| BSTRPA+  | 5   | P                   |                      | Connection point for the SPK_OUTA+ bootstrap capacitor which is used to create a power supply for the high-side gate drive for SPK_OUTA                                                                                                                                                                                                                      |
| BSTRPB–  | 48  | P                   |                      | Connection point for the SPK_OUTB– bootstrap capacitor which is used to create a power supply for the high-side gate drive for SPK_OUTB–                                                                                                                                                                                                                     |
| BSTRPB+  | 44  | P                   |                      | Connection point for the SPK_OUTB+ bootstrap capacitor which is used to create a power supply for the high-side gate drive for SPK_OUTB+                                                                                                                                                                                                                     |
| CN       | 34  | P                   | Figure 15            | Negative pin for capacitor connection used in the line–driver charge pump                                                                                                                                                                                                                                                                                    |
| CP       | 32  | P                   | Figure 14            | Positive pin for capacitor connection used in the line-driver charge pump                                                                                                                                                                                                                                                                                    |
| CPVDD    | 31  | P                   | Figure 2             | Power supply for charge pump circuitry                                                                                                                                                                                                                                                                                                                       |
| CPVSS    | 35  | P                   | Figure 15            | –3.3-V supply generated by charge pump for the DAC                                                                                                                                                                                                                                                                                                           |
| DAC_OUTA | 13  | AO                  | Figure 8             | Single-ended output for Channel A of the DAC                                                                                                                                                                                                                                                                                                                 |
| DAC_OUTB | 36  | AO                  |                      | Single-ended output for Channel B of the DAC                                                                                                                                                                                                                                                                                                                 |
| DGND     | 29  | G                   | —                    | Ground reference for digital circuitry. Connect this pin to the system ground.                                                                                                                                                                                                                                                                               |
| DVDD     | 30  | P                   | Figure 2             | Power supply for the internal digital circuitry                                                                                                                                                                                                                                                                                                              |
| DVDD_REG | 28  | P                   | Figure 16            | Voltage regulator derived from DVDD supply for use for internal digital circuitry. This pin is provided as a connection point for filtering capacitors for this supply and must not be used to power any external circuitry.                                                                                                                                 |
| GND      | 33  | G                   | —                    | Ground pin for device. This pin should be connected to the system ground.                                                                                                                                                                                                                                                                                    |
| GPIO0    | 18  | DI/O                | Figure 11            | General purpose input/output pins (GPIOx) which can be incorporated in a HybridFlow for a given purpose. Refer to documentation of target HybridFlow to determine if any of these pins are required by the HybridFlow and, if so, how they are to be used. In most HybridFlows, presentation of a serial audio signal, called SDOOUT, is done through GPIO2. |
| GPIO1    | 19  |                     |                      |                                                                                                                                                                                                                                                                                                                                                              |
| GPIO2    | 21  |                     |                      |                                                                                                                                                                                                                                                                                                                                                              |
| GVDD_REG | 8   | P                   | Figure 5             | Voltage regulator derived from PVDD supply to generate the voltage required for the gate drive of output MOSFETs. This pin is provided as a connection point for filtering capacitors for this supply and must not be used to power any external circuitry.                                                                                                  |
| LRCK/FS  | 25  | DI/O                | Figure 12            | Word select clock for the digital signal that is active on the serial port's input data line. In I <sup>2</sup> S, LJ, and RJ, this corresponds to the left channel and right channel boundary. In TDM mode, this corresponds to the frame sync boundary.                                                                                                    |
| MCLK     | 22  | DI                  |                      | Master clock used for internal clock tree and sub-circuit and state machine clocking                                                                                                                                                                                                                                                                         |
| PGND     | 3   | G                   | —                    | Ground reference for power device circuitry. Connect this pin to the system ground.                                                                                                                                                                                                                                                                          |
|          | 39  |                     |                      |                                                                                                                                                                                                                                                                                                                                                              |
|          | 46  |                     |                      |                                                                                                                                                                                                                                                                                                                                                              |
| PVDD     | 6   | P                   | Figure 1             | Power supply for internal power circuitry                                                                                                                                                                                                                                                                                                                    |
|          | 7   |                     |                      |                                                                                                                                                                                                                                                                                                                                                              |
|          | 41  |                     |                      |                                                                                                                                                                                                                                                                                                                                                              |
|          | 42  |                     |                      |                                                                                                                                                                                                                                                                                                                                                              |
|          | 43  |                     |                      |                                                                                                                                                                                                                                                                                                                                                              |
| SCL      | 17  | DI                  | Figure 10            | I <sup>2</sup> C serial control port clock                                                                                                                                                                                                                                                                                                                   |
| SCLK     | 23  | DI/O                | Figure 12            | Bit clock for the digital signal that is active on the input data line of the serial data port                                                                                                                                                                                                                                                               |
| SDA      | 16  | DI/O                | Figure 9             | I <sup>2</sup> C serial control port data                                                                                                                                                                                                                                                                                                                    |
| SDIN     | 24  | DI                  | Figure 12            | Data line to the serial data port                                                                                                                                                                                                                                                                                                                            |
| SPK_INA– | 11  | AI                  | Figure 7             | Negative pin for differential speaker amplifier input A                                                                                                                                                                                                                                                                                                      |
| SPK_INA+ | 12  | AI                  |                      | Positive pin for differential speaker amplifier input A                                                                                                                                                                                                                                                                                                      |
| SPK_INB– | 38  | AI                  |                      | Negative pin for differential speaker amplifier input B                                                                                                                                                                                                                                                                                                      |
| SPK_INB+ | 37  | AI                  |                      | Positive pin for differential speaker amplifier input B                                                                                                                                                                                                                                                                                                      |

(1) AI = Analog input, AO = Analog output, DI = Digital Input, DO = Digital Output, DI/O = Digital Bi-directional (input and output), P = Power, G = Ground (0 V)

(2) This pin should be connected to the system ground.

## Pin Functions (continued)

| PIN           |     | TYPE <sup>(1)</sup> | INTERNAL TERMINATION | DESCRIPTION                                                                                                                                                                                                                                                             |
|---------------|-----|---------------------|----------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| NAME          | NO. |                     |                      |                                                                                                                                                                                                                                                                         |
| SPK_FAULT     | 40  | DO                  | Figure 17            | Fault pin which is pulled low when an overcurrent, overtemperature, overvoltage, undervoltage, or DC detect event occurs                                                                                                                                                |
| SPK_GAIN/FREQ | 9   | AI                  | Figure 6             | Sets the gain and switching frequency of the speaker amplifier, latched in upon start-up of the device.                                                                                                                                                                 |
| SPK_OUTA-     | 2   | AO                  | Figure 4             | Negative pin for differential speaker amplifier output A                                                                                                                                                                                                                |
| SPK_OUTA+     | 4   | AO                  |                      | Positive pin for differential speaker amplifier output A                                                                                                                                                                                                                |
| SPK_OUTB-     | 47  | AO                  |                      | Negative pin for differential speaker amplifier output B                                                                                                                                                                                                                |
| SPK_OUTB+     | 45  | AO                  |                      | Positive pin for differential speaker amplifier output B                                                                                                                                                                                                                |
| SPK_MUTE      | 27  | I                   | Figure 13            | Speaker amplifier mute which must be pulled low (connected to DGND) to mute the device and pulled high (connected to DVDD) to unmute the device.                                                                                                                        |
| Thermal pad   |     | G                   | —                    | Provides both electrical and thermal connection from the device to the board. A matching ground pad must be provided on the PCB and the device connected to it through solder. For proper electrical operation, this ground pad must be connected to the system ground. |

## 6.1 Internal Pin Configurations

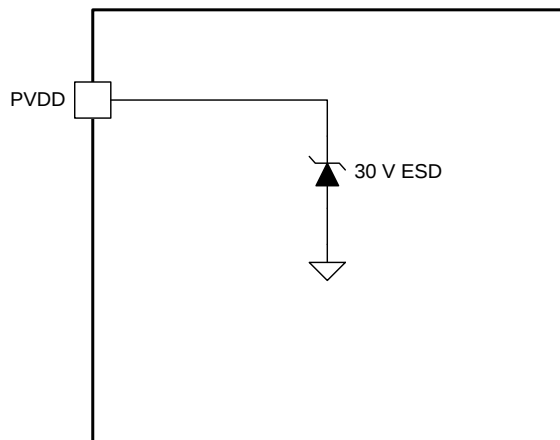


Figure 1. PVDD Pins

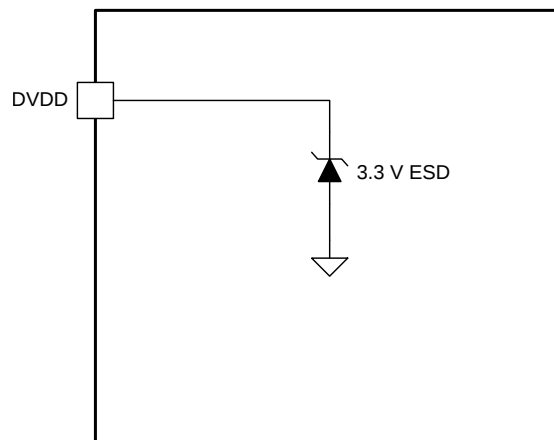


Figure 2. AVDD, DVDD and CPVDD Pins

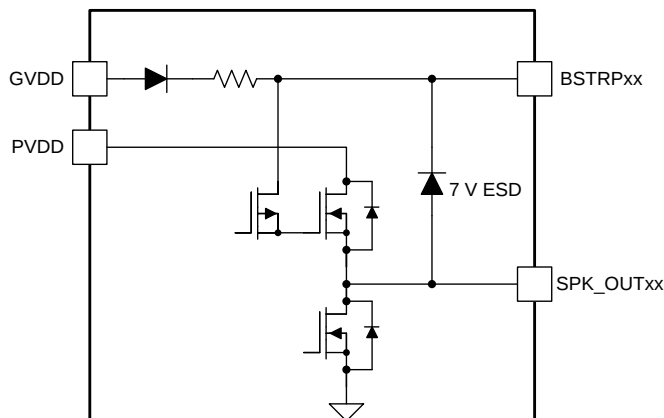


Figure 3. BSTRPxx Pins

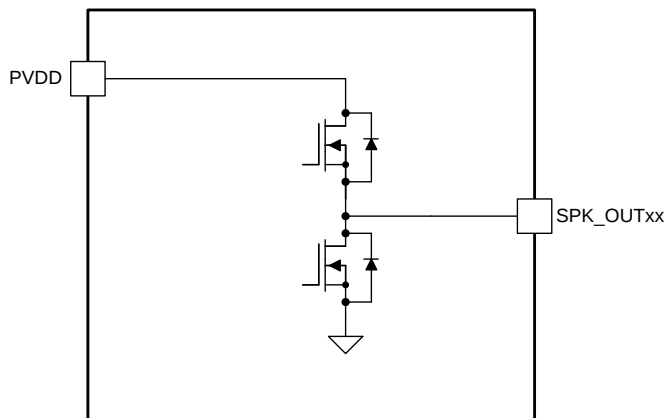
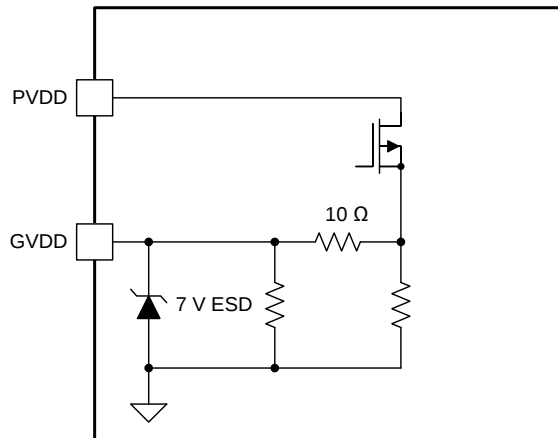
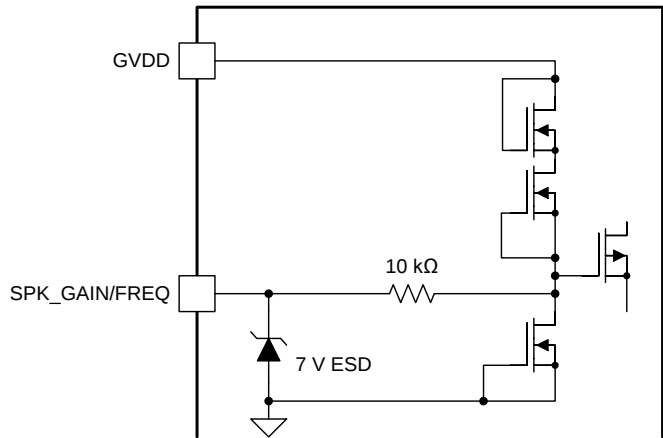


Figure 4. SPK\_OUTxx Pins

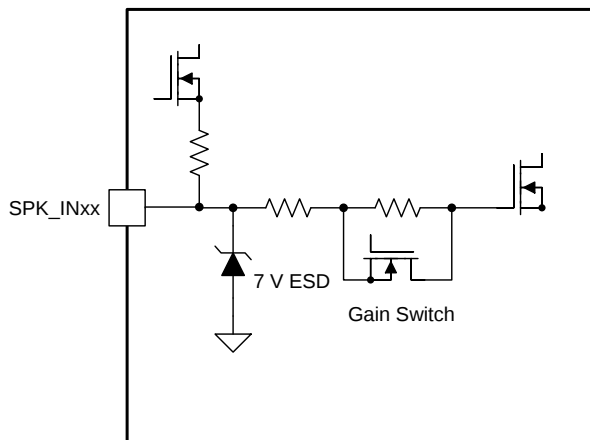
## Internal Pin Configurations (continued)



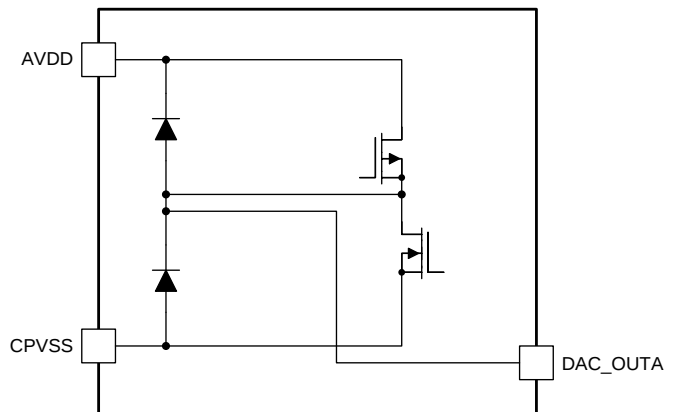
**Figure 5. GVDD\_REG Pin**



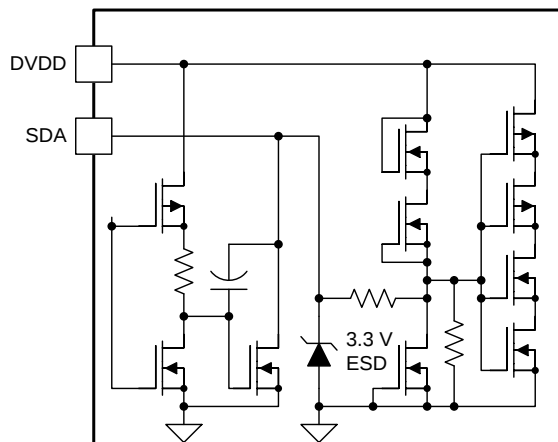
**Figure 6. SPK\_GAIN/FREQ Pin**



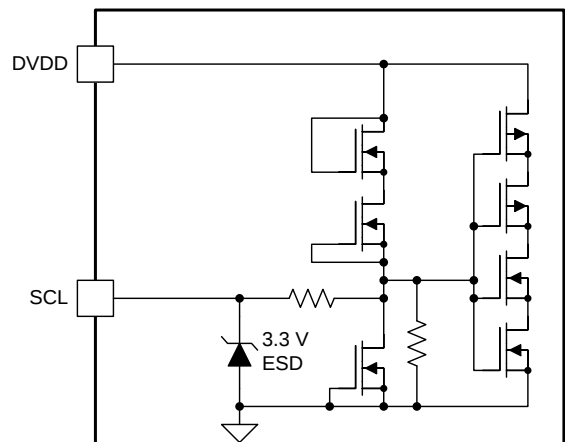
**Figure 7. SPK\_INxx Pins**



**Figure 8. DAC\_OUTx Pins**

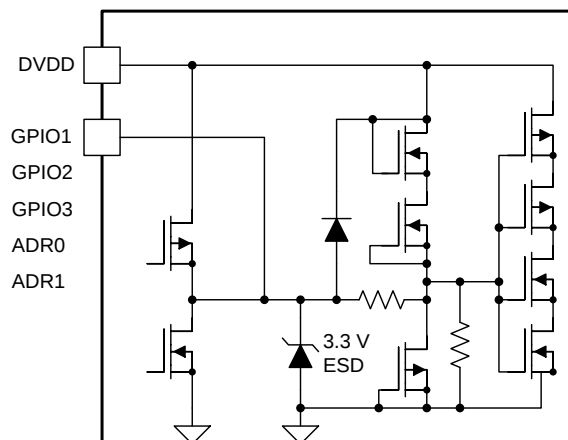


**Figure 9. SDA Pin**

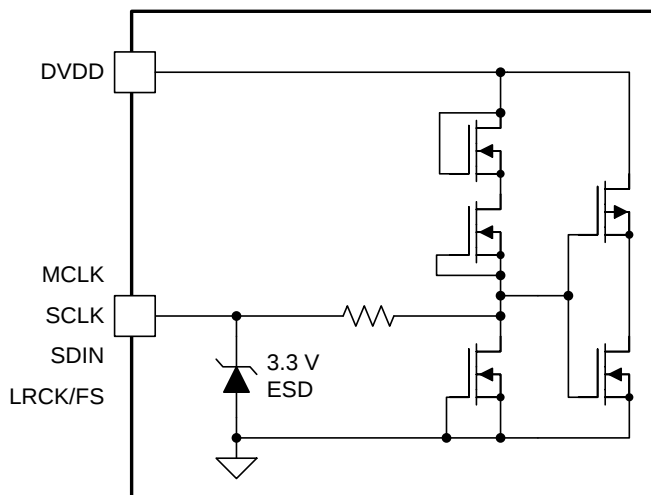


**Figure 10. SCL Pin**

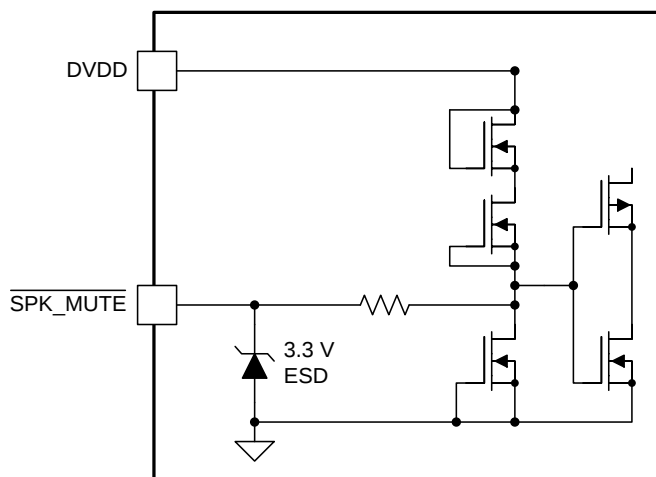
## Internal Pin Configurations (continued)



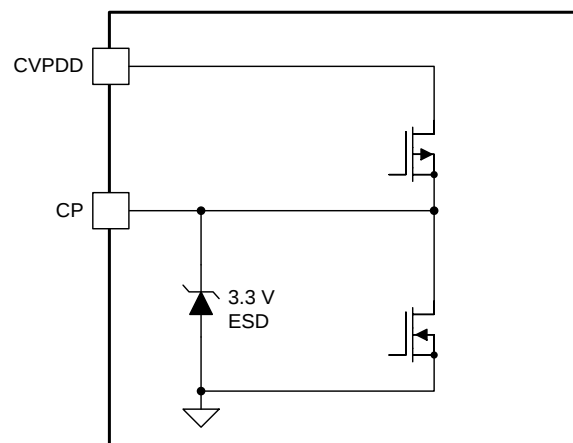
**Figure 11. GPIO and ADR Pins**



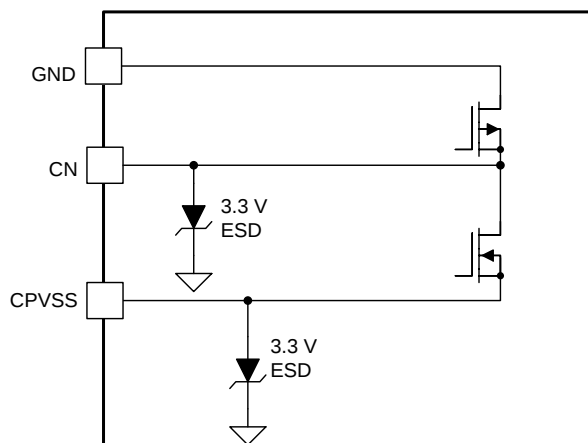
**Figure 12. SCLK, BCLK, SDIN, and LRCK/FS Pins**



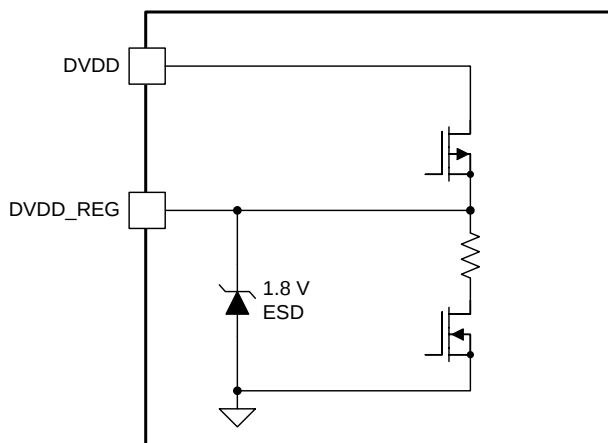
**Figure 13. SPK\_MUTE Pin**



**Figure 14. CP Pin**



**Figure 15. CN and CPVSS Pins**



**Figure 16. DVDD\_REG Pin**

## Internal Pin Configurations (continued)

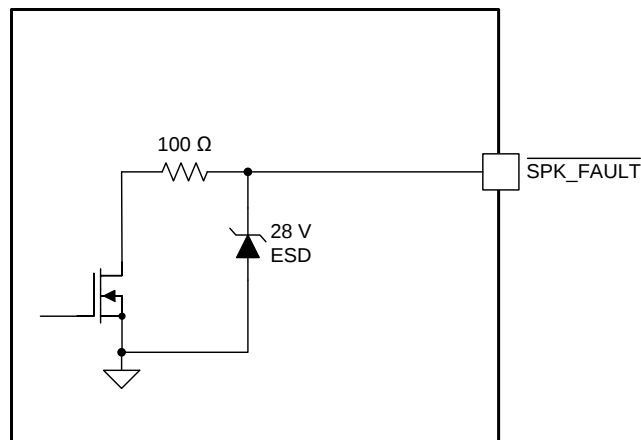


Figure 17. SPK\_FAULT Pin

## 7 Specifications

### 7.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

|                                                    |                        | MIN  | MAX              | UNIT |
|----------------------------------------------------|------------------------|------|------------------|------|
| Low-voltage digital, analog, charge pump supply    | DVDD, AVDD, CPVDD      | −0.3 | 3.9              | V    |
| PVDD supply                                        | PVDD                   | −0.3 | 30               | V    |
| Input voltage for SPK_GAIN/FREQ and SPK_FAULT pins | $V_{I(AmpCtrl)}$       | −0.3 | $V_{GVDD} + 0.3$ | V    |
| DVDD referenced digital inputs <sup>(2)</sup>      | $V_{I(DigIn)}$         | −0.5 | $V_{DVDD} + 0.5$ | V    |
| Analog input into speaker amplifier                | $V_{I(SP_{K\_INxx})}$  | −0.3 | 6.3              | V    |
| Voltage at speaker output pins                     | $V_{I(SP_{K\_OUTxx})}$ | −0.3 | 32               | V    |
| Ambient operating temperature, $T_A$               |                        | −25  | 85               | °C   |
| Storage temperature, $T_{stg}$                     |                        | −40  | 125              | °C   |

- (1) Stresses beyond those listed under *absolute maximum ratings* may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *recommended operating conditions* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) DVDD referenced digital pins include: ADR0, ADR1, GPIO0, GPIO1, GPIO2, LRCK/FS, MCLK, SCL, SCLK, SDA, SDIN, and SPK\_MUTE.

### 7.2 ESD Ratings

|                                     |                                                                                | VALUE | UNIT |
|-------------------------------------|--------------------------------------------------------------------------------|-------|------|
| $V_{(ESD)}$ Electrostatic discharge | Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 <sup>(1)</sup>              | ±2000 | V    |
|                                     | Charged-device model (CDM), per JEDEC specification JESD22-C101 <sup>(2)</sup> | ±500  |      |

- (1) JEDEC document JEP155 states that 2000-V HBM allows safe manufacturing with a standard ESD control process.
- (2) JEDEC document JEP157 states that 500-V CDM allows safe manufacturing with a standard ESD control process.

### 7.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

|                 |                                                                       |                   | MIN                   | NOM | MAX                   | UNIT     |
|-----------------|-----------------------------------------------------------------------|-------------------|-----------------------|-----|-----------------------|----------|
| $V_{(POWER)}$   | Power supply inputs                                                   | DVDD, AVDD, CPVDD | 2.9                   |     | 3.63                  | V        |
|                 |                                                                       | PVDD              | 4.5                   |     | 26.4                  |          |
| $R_{SPK}$       | Minimum speaker load                                                  | BTL Mode          | 3                     |     |                       | $\Omega$ |
|                 |                                                                       | PBTL Mode         | 2                     |     |                       | $\Omega$ |
| $V_{IH(DigIn)}$ | Input logic high for DVDD referenced digital inputs <sup>(1)(2)</sup> |                   | $0.9 \times V_{DVDD}$ |     | $V_{DVDD}$            | V        |
| $V_{IL(DigIn)}$ | Input logic low for DVDD referenced digital inputs <sup>(1)(3)</sup>  |                   | $V_{DVDD}$            | 0   | $0.1 \times V_{DVDD}$ | V        |
| $L_{OUT}$       | Minimum inductor value in LC filter under short-circuit condition     |                   | 1                     | 4.7 |                       | $\mu H$  |

- (1) DVDD referenced digital pins include: ADR0, ADR1, GPIO0, GPIO1, GPIO2, LRCK/FS, MCLK, SCL, SCLK, SDA, SDIN, and SPK\_MUTE.
- (2) The best practice for driving the input pins of the TAS5756M device is to power the drive circuit or pullup resistor from the same supply which provides the DVDD power supply.
- (3) The best practice for driving the input pins of the TAS5756M device low is to pull them down, either actively or through pulldown resistors to the system ground.

### 7.4 Thermal Information

| THERMAL METRIC <sup>(1)(2)</sup> |                                              | TAS5756M<br>DCA (HTSSOP)<br>48 PINS |                                  |                               | UNIT          |
|----------------------------------|----------------------------------------------|-------------------------------------|----------------------------------|-------------------------------|---------------|
|                                  |                                              | JEDEC<br>STANDARD<br>2-LAYER PCB    | JEDEC<br>STANDARD<br>4-LAYER PCB | TAS5756MDCAEVM<br>4-LAYER PCB |               |
| $R_{\theta JA}$                  | Junction-to-ambient thermal resistance       | 41.8                                | 27.6                             | 19.4                          | $^{\circ}C/W$ |
| $R_{\theta JC(top)}$             | Junction-to-case (top) thermal resistance    | 14.4                                | 14.4                             | 14.4                          | $^{\circ}C/W$ |
| $R_{\theta JB}$                  | Junction-to-board thermal resistance         | 9.4                                 | 9.4                              | 9.4                           | $^{\circ}C/W$ |
| $\Psi_{JT}$                      | Junction-to-top characterization parameter   | 0.6                                 | 0.6                              | 2                             | $^{\circ}C/W$ |
| $\Psi_{JB}$                      | Junction-to-board characterization parameter | 8.1                                 | 9.3                              | 4.8                           | $^{\circ}C/W$ |
| $R_{\theta JC(bot)}$             | Junction-to-case (bottom) thermal resistance | 1                                   | 1                                | N/A                           | $^{\circ}C/W$ |

- (1) For more information about traditional and new thermal metrics, see the *Semiconductor and IC Package Thermal Metrics* application report, [SPRA953](#).
- (2) For the PCB layout, see the *Using the TAS5754/6M HybridFlow Processor* user's guide, [SLAU577](#).

### 7.5 Electrical Characteristics

over operating free-air temperature range (unless otherwise noted)

| PARAMETER          | TEST CONDITIONS                                                                      | MIN                        | TYP | MAX | UNIT       |
|--------------------|--------------------------------------------------------------------------------------|----------------------------|-----|-----|------------|
| <b>DIGITAL I/O</b> |                                                                                      |                            |     |     |            |
| $ I_{IH} 1$        | Input logic high current level for DVDD referenced digital input pins <sup>(1)</sup> | $V_{IN(DigIn)} = V_{DVDD}$ |     | 10  | $\mu A$    |
| $ I_{IL} 1$        | Input logic low current level for DVDD referenced digital input pins <sup>(1)</sup>  | $V_{IN(DigIn)} = 0 V$      |     | –10 | $\mu A$    |
| $V_{IH1}$          | Input logic high threshold for DVDD referenced digital inputs <sup>(1)</sup>         |                            | 70% |     | $V_{DVDD}$ |
| $V_{IL1}$          | Input logic low threshold for DVDD referenced digital inputs <sup>(1)</sup>          |                            |     | 30% | $V_{DVDD}$ |
| $V_{OH(DigOut)}$   | Output logic high voltage level <sup>(1)</sup>                                       | $I_{OH} = 4 mA$            | 80% |     | $V_{DVDD}$ |

- (1) DVDD referenced digital pins include: ADR0, ADR1, GPIO0, GPIO1, GPIO2, LRCK/FS, MCLK, SCL, SCLK, SDA, SDIN, and SPK\_MUTE.

**TAS5756M**

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**Electrical Characteristics (continued)**

over operating free-air temperature range (unless otherwise noted)

| PARAMETER                     |                                                                             | TEST CONDITIONS                                      | MIN                   | TYP | MAX | UNIT                          |
|-------------------------------|-----------------------------------------------------------------------------|------------------------------------------------------|-----------------------|-----|-----|-------------------------------|
| V <sub>OL(DigOut)</sub>       | Output logic low voltage level <sup>(1)</sup>                               | I <sub>OH</sub> = −4 mA                              |                       |     | 22% | V <sub>DVDD</sub>             |
| V <sub>OL(SPK_FAULT)</sub>    | Output logic low voltage level for SPK_FAULT                                | With 100-kΩ pullup resistor                          |                       |     | 0.8 | V                             |
| I <sup>2</sup> C CONTROL PORT |                                                                             |                                                      |                       |     |     |                               |
| C <sub>L(I2C)</sub>           | Allowable load capacitance for each I <sup>2</sup> C Line                   |                                                      |                       |     | 400 | pF                            |
| f <sub>SCL(fast)</sub>        | Support SCL frequency                                                       | No wait states, fast mode                            |                       |     | 400 | kHz                           |
| f <sub>SCL(slow)</sub>        | Support SCL frequency                                                       | No wait states, slow mode                            |                       |     | 100 | kHz                           |
| V <sub>NH</sub>               | Noise margin at High level for each connected device (including hysteresis) |                                                      | 0.2 × V <sub>DD</sub> |     |     | V                             |
| MCLK AND PLL SPECIFICATIONS   |                                                                             |                                                      |                       |     |     |                               |
| D <sub>MCLK</sub>             | Allowable MCLK duty cycle                                                   |                                                      | 40%                   |     | 60% |                               |
| f <sub>MCLK</sub>             | Supported MCLK frequencies                                                  | Up to 50 MHz                                         | 128                   |     | 512 | f <sub>S</sub> <sup>(2)</sup> |
| f <sub>PLL</sub>              | PLL input frequency                                                         | Clock divider uses fractional divide<br>D > 0, P = 1 | 6.7                   |     | 20  | MHz                           |
|                               |                                                                             | Clock divider uses integer divide<br>D = 0, P = 1    | 1                     |     | 20  |                               |

(2) A unit of  $f_S$  indicates that the specification is the value listed in the table multiplied by the sample rate of the audio used in the TAS5756M device.

## Electrical Characteristics (continued)

over operating free-air temperature range (unless otherwise noted)

| PARAMETER                                            |                                                                                | TEST CONDITIONS                                                                                                                                                                                                         | MIN   | TYP | MAX    | UNIT        |
|------------------------------------------------------|--------------------------------------------------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------|-----|--------|-------------|
| <b>SERIAL AUDIO PORT</b>                             |                                                                                |                                                                                                                                                                                                                         |       |     |        |             |
| $t_{DLY}$                                            | Required LRCK/FS to SCLK rising edge delay                                     |                                                                                                                                                                                                                         | 5     |     |        | ns          |
| $D_{SCLK}$                                           | Allowable SCLK duty cycle                                                      |                                                                                                                                                                                                                         | 40%   |     | 60%    |             |
| $f_S$                                                | Supported input sample rates                                                   |                                                                                                                                                                                                                         | 8     |     | 192    | kHz         |
| $f_{SCLK}$                                           | Supported SCLK frequencies                                                     |                                                                                                                                                                                                                         | 32    |     | 64     | $f_S^{(2)}$ |
| $f_{SCLK}$                                           | SCLK frequency                                                                 | Either master mode or slave mode                                                                                                                                                                                        |       |     | 24.576 | MHz         |
| <b>SPEAKER AMPLIFIER (ALL OUTPUT CONFIGURATIONS)</b> |                                                                                |                                                                                                                                                                                                                         |       |     |        |             |
| $A_{V(SP\_AMP)}$                                     | Speaker amplifier gain                                                         | SPK_GAIN/FREQ voltage < 3 V, see <a href="#">Adjustable Amplifier Gain and Switching Frequency Selection</a>                                                                                                            |       | 20  |        | dBV         |
|                                                      |                                                                                | SPK_GAIN/FREQ voltage > 3.3 V, see <a href="#">Adjustable Amplifier Gain and Switching Frequency Selection</a>                                                                                                          |       | 26  |        | dBV         |
| $\Delta A_{V(SP\_AMP)}$                              | Typical variation of speaker amplifier gain                                    |                                                                                                                                                                                                                         |       | ±1  |        | dBV         |
| $f_{SP\_AMP}$                                        | Switching frequency of the speaker amplifier                                   | Switching frequency depends on voltage presented at SPK_GAIN/FREQ pin and the clocking arrangement, including the incoming sample rate, see <a href="#">Adjustable Amplifier Gain and Switching Frequency Selection</a> | 176.4 |     | 768    | kHz         |
| $K_{SVR}$                                            | Power supply rejection ratio                                                   | Injected Noise = 50 Hz to 60 Hz, 200 mV <sub>P-P</sub> , Gain = 26 dBV, input audio signal = digital zero                                                                                                               |       | 60  |        | dB          |
| $r_{DS(on)}$                                         | Drain-to-source on resistance of the individual output MOSFETs                 | $V_{PVDD} = 24\text{ V}$ , $I_{(SPK\_OUT)} = 500\text{ mA}$ , $T_J = 25^\circ\text{C}$ , includes PVDD/PGND pins, leadframe, bondwires and metallization layers.                                                        |       | 90  |        | mΩ          |
|                                                      |                                                                                | $V_{PVDD} = 24\text{ V}$ , $I_{(SPK\_OUT)} = 500\text{ mA}$ , $T_J = 25^\circ\text{C}$                                                                                                                                  |       | 90  |        | mΩ          |
| $OCE_{THRES}$                                        | SPK_OUTxx Overcurrent Error Threshold                                          |                                                                                                                                                                                                                         |       | 7.5 |        | A           |
| $OTE_{THRES}$                                        | Overtemperature Error Threshold                                                |                                                                                                                                                                                                                         |       | 150 |        | °C          |
| $OCE_{CLRTIME}$                                      | Time required to clear Overcurrent Error after error condition is removed.     |                                                                                                                                                                                                                         |       | 1.3 |        | s           |
| $OTE_{CLRTIME}$                                      | Time required to clear Overtemperature Error after error condition is removed. |                                                                                                                                                                                                                         |       | 1.3 |        | s           |
| $OVE_{THRES(PVDD)}$                                  | PVDD Overvoltage Error Threshold                                               |                                                                                                                                                                                                                         |       | 27  |        | V           |
| $UVE_{THRES(PVDD)}$                                  | PVDD Undervoltage Error Threshold                                              |                                                                                                                                                                                                                         |       | 4.5 |        | V           |
| <b>SPEAKER AMPLIFIER (STEREO BTL)</b>                |                                                                                |                                                                                                                                                                                                                         |       |     |        |             |
| $ V_{OS} $                                           | Amplifier offset voltage                                                       | Measured differentially with zero input data, SPK_GAIN/FREQ pin configured for 20 dBV gain, $V_{PVDD} = 12\text{ V}$                                                                                                    |       | 2   | 10     | mV          |
|                                                      |                                                                                | Measured differentially with zero input data, SPK_GAIN/FREQ pin configured for 26 dBV gain, $V_{PVDD} = 24\text{ V}$                                                                                                    |       | 6   | 15     |             |

## Electrical Characteristics (continued)

over operating free-air temperature range (unless otherwise noted)

| PARAMETER                                                     | TEST CONDITIONS                                                                                                       | MIN | TYP    | MAX | UNIT          |
|---------------------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------|-----|--------|-----|---------------|
| $I_{CN(SPK)}$ Idle channel noise                              | $V_{PVDD} = 12\text{ V}$ , $SPK\_GAIN = 20\text{ dBV}$ , $R_{SPK} = 8\ \Omega$ , A-Weighted                           |     | 56     |     | $\mu V_{RMS}$ |
|                                                               | $V_{PVDD} = 15\text{ V}$ , $SPK\_GAIN = 20\text{ dBV}$ , $R_{SPK} = 8\ \Omega$ , A-Weighted                           |     | 58     |     |               |
|                                                               | $V_{PVDD} = 19\text{ V}$ , $SPK\_GAIN = 26\text{ dBV}$ , $R_{SPK} = 8\ \Omega$ , A-Weighted                           |     | 86     |     |               |
|                                                               | $V_{PVDD} = 24\text{ V}$ , $SPK\_GAIN = 26\text{ dBV}$ , $R_{SPK} = 8\ \Omega$ , A-Weighted                           |     | 88     |     |               |
| $P_{O(SPK)}$ Output Power (Per Channel)                       | $V_{PVDD} = 12\text{ V}$ , $SPK\_GAIN = 20\text{ dBV}$ , $R_{SPK} = 4\ \Omega$ , THD+N = 0.1%, Unless otherwise noted |     | 15     |     | W             |
|                                                               | $V_{PVDD} = 24\text{ V}$ , $SPK\_GAIN = 26\text{ dBV}$ , $R_{SPK} = 4\ \Omega$ , THD+N = 0.1%, Unless otherwise noted |     | 20     |     |               |
|                                                               | $V_{PVDD} = 24\text{ V}$ , $SPK\_GAIN = 26\text{ dBV}$ , $R_{SPK} = 8\ \Omega$ , THD+N = 0.1%                         |     | 28     |     |               |
|                                                               | $V_{PVDD} = 12\text{ V}$ , $SPK\_GAIN = 20\text{ dBV}$ , $R_{SPK} = 8\ \Omega$ , THD+N = 0.1%                         |     | 20     |     |               |
|                                                               | $V_{PVDD} = 19\text{ V}$ , $SPK\_GAIN = 26\text{ dBV}$ , $R_{SPK} = 4\ \Omega$ , THD+N = 0.1%, Unless otherwise noted |     | 18     |     |               |
|                                                               | $V_{PVDD} = 19\text{ V}$ , $SPK\_GAIN = 26\text{ dBV}$ , $R_{SPK} = 8\ \Omega$ , THD+N = 0.1%                         |     | 18     |     |               |
|                                                               | $V_{PVDD} = 15\text{ V}$ , $SPK\_GAIN = 26\text{ dBV}$ , $R_{SPK} = 4\ \Omega$ , THD+N = 0.1%, Unless otherwise noted |     | 18     |     |               |
|                                                               | $V_{PVDD} = 15\text{ V}$ , $SPK\_GAIN = 26\text{ dBV}$ , $R_{SPK} = 8\ \Omega$ , THD+N = 0.1%                         |     | 12     |     |               |
| SNR Signal-to-noise ratio (referenced to 0 dBFS input signal) | $V_{PVDD} = 15\text{ V}$ , $SPK\_GAIN = 26\text{ dBV}$ , $R_{SPK} = 8\ \Omega$ , A-Weighted, –120 dBFS Input          |     | 104    |     | dB            |
|                                                               | $V_{PVDD} = 12\text{ V}$ , $SPK\_GAIN = 20\text{ dBV}$ , $R_{SPK} = 8\ \Omega$ , A-Weighted, –120 dBFS Input          |     | 104    |     |               |
|                                                               | $V_{PVDD} = 24\text{ V}$ , $SPK\_GAIN = 26\text{ dBV}$ , $R_{SPK} = 8\ \Omega$ , A-Weighted, –120 dBFS Input          |     | 106    |     |               |
|                                                               | $V_{PVDD} = 19\text{ V}$ , $SPK\_GAIN = 26\text{ dBV}$ , $R_{SPK} = 8\ \Omega$ , A-Weighted, –120 dBFS Input          |     | 105    |     |               |
| THD+N <sub>SPK</sub> Total harmonic distortion and noise      | $V_{PVDD} = 12\text{ V}$ , $SPK\_GAIN = 20\text{ dBV}$ , $R_{SPK} = 4\ \Omega$ , $P_O = 1\text{ W}$                   |     | 0.011% |     |               |
|                                                               | $V_{PVDD} = 12\text{ V}$ , $SPK\_GAIN = 20\text{ dBV}$ , $R_{SPK} = 8\ \Omega$ , $P_O = 1\text{ W}$                   |     | 0.007% |     |               |
|                                                               | $V_{PVDD} = 24\text{ V}$ , $SPK\_GAIN = 26\text{ dBV}$ , $R_{SPK} = 4\ \Omega$ , $P_O = 1\text{ W}$                   |     | 0.02%  |     |               |
|                                                               | $V_{PVDD} = 15\text{ V}$ , $SPK\_GAIN = 26\text{ dBV}$ , $R_{SPK} = 4\ \Omega$ , $P_O = 1\text{ W}$                   |     | 0.015% |     |               |
|                                                               | $V_{PVDD} = 15\text{ V}$ , $SPK\_GAIN = 26\text{ dBV}$ , $R_{SPK} = 8\ \Omega$ , $P_O = 1\text{ W}$                   |     | 0.01%  |     |               |
|                                                               | $V_{PVDD} = 19\text{ V}$ , $SPK\_GAIN = 26\text{ dBV}$ , $R_{SPK} = 4\ \Omega$ , $P_O = 1\text{ W}$                   |     | 0.017% |     |               |
|                                                               | $V_{PVDD} = 19\text{ V}$ , $SPK\_GAIN = 26\text{ dBV}$ , $R_{SPK} = 8\ \Omega$ , $P_O = 1\text{ W}$                   |     | 0.015% |     |               |
|                                                               | $V_{PVDD} = 24\text{ V}$ , $SPK\_GAIN = 26\text{ dBV}$ , $R_{SPK} = 8\ \Omega$ , $P_O = 1\text{ W}$                   |     | 0.017% |     |               |

## Electrical Characteristics (continued)

over operating free-air temperature range (unless otherwise noted)

| PARAMETER                     |                                                                          | TEST CONDITIONS                                                                                                      | MIN | TYP  | MAX | UNIT              |
|-------------------------------|--------------------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------|-----|------|-----|-------------------|
| X-talk <sub>SPK</sub>         | Cross-talk (worst case between left-to-right and right-to-left coupling) | V <sub>PVDD</sub> = 15 V, SPK_GAIN = 26 dBV, R <sub>SPK</sub> = 8 Ω, Input Signal 250 mVrms, 1-kHz Sine, across f(S) |     | –88  |     | dB                |
|                               |                                                                          | V <sub>PVDD</sub> = 12 V, SPK_GAIN = 20 dBV, R <sub>SPK</sub> = 8 Ω, Input Signal 250 mVrms, 1-kHz Sine, across f(S) |     | –97  |     |                   |
|                               |                                                                          | V <sub>PVDD</sub> = 24 V, SPK_GAIN = 26 dBV, R <sub>SPK</sub> = 8 Ω, Input Signal 250 mVrms, 1-kHz Sine, across f(S) |     | –88  |     |                   |
|                               |                                                                          | V <sub>PVDD</sub> = 19 V, SPK_GAIN = 26 dBV, R <sub>SPK</sub> = 8 Ω, Input Signal 250 mVrms, 1-kHz Sine, across f(S) |     | –88  |     |                   |
| SPEAKER AMPLIFIER (MONO PBTL) |                                                                          |                                                                                                                      |     |      |     |                   |
| V <sub>OS</sub>               | Amplifier offset voltage                                                 | Measured differentially with zero input data, SPK_GAIN/FREQ pin configured for 20 dBV gain, V <sub>PVDD</sub> = 12 V |     | 0.5  | 8   | mV                |
|                               |                                                                          | Measured differentially with zero input data, SPK_GAIN/FREQ pin configured for 26 dBV gain, V <sub>PVDD</sub> = 24 V |     | 1    | 14  |                   |
| I <sub>CN</sub>               | Idle channel noise                                                       | V <sub>PVDD</sub> = 15 V, SPK_GAIN = 20 dBV, R <sub>SPK</sub> = 8 Ω, A-Weighted                                      |     | 58   |     | μV <sub>RMS</sub> |
|                               |                                                                          | V <sub>PVDD</sub> = 12 V, SPK_GAIN = 20 dBV, R <sub>SPK</sub> = 8 Ω, A-Weighted                                      |     | 57   |     |                   |
|                               |                                                                          | V <sub>PVDD</sub> = 19 V, SPK_GAIN = 26 dBV, R <sub>SPK</sub> = 8 Ω, A-Weighted                                      |     | 85   |     |                   |
|                               |                                                                          | V <sub>PVDD</sub> = 24 V, SPK_GAIN = 26 dBV, R <sub>SPK</sub> = 8 Ω, A-Weighted                                      |     | 85   |     |                   |
| P <sub>O</sub>                | Output Power (Per Channel)                                               | V <sub>PVDD</sub> = 24 V, SPK_GAIN = 26 dBV, R <sub>SPK</sub> = 2 Ω, THD+N = 0.1%, Unless otherwise noted            |     | 40   |     | W                 |
|                               |                                                                          | V <sub>PVDD</sub> = 24 V, SPK_GAIN = 26 dBV, R <sub>SPK</sub> = 4 Ω, THD+N = 0.1%, Unless otherwise noted            |     | 56   |     |                   |
|                               |                                                                          | V <sub>PVDD</sub> = 24 V, SPK_GAIN = 26 dBV, R <sub>SPK</sub> = 8 Ω, THD+N = 0.1%                                    |     | 34   |     |                   |
|                               |                                                                          | V <sub>PVDD</sub> = 19 V, SPK_GAIN = 26 dBV, R <sub>SPK</sub> = 2 Ω, THD+N = 0.1%, Unless otherwise noted            |     | 40   |     |                   |
|                               |                                                                          | V <sub>PVDD</sub> = 12 V, SPK_GAIN = 20 dBV, R <sub>SPK</sub> = 8 Ω, THD+N = 0.1%                                    |     | 8    |     |                   |
|                               |                                                                          | V <sub>PVDD</sub> = 19 V, SPK_GAIN = 26 dBV, R <sub>SPK</sub> = 4 Ω, THD+N = 0.1%, Unless otherwise noted            |     | 36   |     |                   |
|                               |                                                                          | V <sub>PVDD</sub> = 19 V, SPK_GAIN = 26 dBV, R <sub>SPK</sub> = 8 Ω, THD+N = 0.1%                                    |     | 21.3 |     |                   |
|                               |                                                                          | V <sub>PVDD</sub> = 15 V, SPK_GAIN = 26 dBV, R <sub>SPK</sub> = 2 Ω, THD+N = 0.1%, Unless otherwise noted            |     | 36   |     |                   |
|                               |                                                                          | V <sub>PVDD</sub> = 15 V, SPK_GAIN = 26 dBV, R <sub>SPK</sub> = 4 Ω, THD+N = 0.1%, Unless otherwise noted            |     | 24   |     |                   |
|                               |                                                                          | V <sub>PVDD</sub> = 15 V, SPK_GAIN = 26 dBV, R <sub>SPK</sub> = 8 Ω, THD+N = 0.1%                                    |     | 13.5 |     |                   |
|                               |                                                                          | V <sub>PVDD</sub> = 12 V, SPK_GAIN = 20 dBV, R <sub>SPK</sub> = 2 Ω, THD+N = 0.1%, Unless otherwise noted            |     | 30   |     |                   |
|                               |                                                                          | V <sub>PVDD</sub> = 12 V, SPK_GAIN = 20 dBV, R <sub>SPK</sub> = 4 Ω, THD+N = 0.1%, Unless otherwise noted            |     | 15   |     |                   |

## Electrical Characteristics (continued)

over operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS                                                 | MIN | TYP | MAX | UNIT |
|-----------|-----------------------------------------------------------------|-----|-----|-----|------|
| SNR       | Signal-to-noise ratio<br>(referenced to 0 dBFS<br>input signal) |     | 104 |     | dB   |
|           |                                                                 |     |     |     |      |
|           |                                                                 |     |     |     |      |
|           |                                                                 |     |     |     |      |
| THD+N     | Total harmonic distortion<br>and noise                          |     |     |     |      |
|           |                                                                 |     |     |     |      |
|           |                                                                 |     |     |     |      |
|           |                                                                 |     |     |     |      |
|           |                                                                 |     |     |     |      |
|           |                                                                 |     |     |     |      |
|           |                                                                 |     |     |     |      |
|           |                                                                 |     |     |     |      |
|           |                                                                 |     |     |     |      |
|           |                                                                 |     |     |     |      |
|           |                                                                 |     |     |     |      |
|           |                                                                 |     |     |     |      |

## 7.6 MCLK Timing

See Figure 18.

|                                           | MIN | NOM | MAX  | UNIT |
|-------------------------------------------|-----|-----|------|------|
| t <sub>MCLK</sub> MCLK period             | 20  |     | 1000 | ns   |
| t <sub>MCLKH</sub> MCLK pulse width, high | 9   |     |      | ns   |
| t <sub>MCLKL</sub> MCLK pulse width, low  | 9   |     |      | ns   |

## 7.7 Serial Audio Port Timing – Slave Mode

See Figure 19.

|                                                          | MIN   | NOM | MAX | UNIT |
|----------------------------------------------------------|-------|-----|-----|------|
| f <sub>SCLK</sub> SCLK frequency                         | 1.024 |     |     | MHz  |
| t <sub>SCLK</sub> SCLK period                            | 40    |     |     | ns   |
| t <sub>SCLKL</sub> SCLK pulse width, low                 | 16    |     |     | ns   |
| t <sub>SCLKH</sub> SCLK pulse width, high                | 16    |     |     | ns   |
| t <sub>SL</sub> SCLK rising to LRCK/FS edge              | 8     |     |     | ns   |
| t <sub>LS</sub> LRCK/FS Edge to SCLK rising edge         | 8     |     |     | ns   |
| t <sub>SU</sub> Data setup time, before SCLK rising edge | 8     |     |     | ns   |
| t <sub>DH</sub> Data hold time, after SCLK rising edge   | 8     |     |     | ns   |

## Serial Audio Port Timing – Slave Mode (continued)

See [Figure 19](#).

|                                                  | MIN | NOM | MAX | UNIT |
|--------------------------------------------------|-----|-----|-----|------|
| $t_{DFS}$ Data delay time from SCLK falling edge |     |     | 15  | ns   |

## 7.8 Serial Audio Port Timing – Master Mode

See [Figure 20](#).

|                                                        | MIN | NOM | MAX | UNIT |
|--------------------------------------------------------|-----|-----|-----|------|
| $t_{SCLK}$ SCLK period                                 | 40  |     |     | ns   |
| $t_{SCLKL}$ SCLK pulse width, low                      | 16  |     |     | ns   |
| $t_{SCLKH}$ SCLK pulse width, high                     | 16  |     |     | ns   |
| $t_{LRD}$ LRCK/FS delay time from to SCLK falling edge | –10 |     | 20  | ns   |
| $t_{SU}$ Data setup time, before SCLK rising edge      | 8   |     |     | ns   |
| $t_{DH}$ Data hold time, after SCLK rising edge        | 8   |     |     | ns   |
| $t_{DFS}$ Data delay time from SCLK falling edge       |     |     | 15  | ns   |

## 7.9 I<sup>2</sup>C Bus Timing – Standard

|                                                                                                    | MIN           | MAX  | UNIT |
|----------------------------------------------------------------------------------------------------|---------------|------|------|
| $f_{SCL}$ SCL clock frequency                                                                      |               | 100  | kHz  |
| $t_{BUF}$ Bus free time between a STOP and START condition                                         | 4.7           |      | μs   |
| $t_{LOW}$ Low period of the SCL clock                                                              | 4.7           |      | μs   |
| $t_{HI}$ High period of the SCL clock                                                              | 4             |      | μs   |
| $t_{RS-SU}$ Setup time for (repeated) START condition                                              | 4.7           |      | μs   |
| $t_{S-HD}$ Hold time for (repeated) START condition                                                | 4             |      | μs   |
| $t_{D-SU}$ Data setup time                                                                         | 250           |      | ns   |
| $t_{D-HD}$ Data hold time                                                                          | 0             | 900  | ns   |
| $t_{SCL-R}$ Rise time of SCL signal                                                                | $20 + 0.1C_B$ | 1000 | ns   |
| $t_{SCL-R1}$ Rise time of SCL signal after a repeated START condition and after an acknowledge bit | $20 + 0.1C_B$ | 1000 | ns   |
| $t_{SCL-F}$ Fall time of SCL signal                                                                | $20 + 0.1C_B$ | 1000 | ns   |
| $t_{SDA-R}$ Rise time of SDA signal                                                                | $20 + 0.1C_B$ | 1000 | ns   |
| $t_{SDA-F}$ Fall time of SDA signal                                                                | $20 + 0.1C_B$ | 1000 | ns   |
| $t_{P-SU}$ Setup time for STOP condition                                                           | 4             |      | μs   |

## 7.10 I<sup>2</sup>C Bus Timing – Fast

See [Figure 21](#).

|                                                                                                    | MIN           | MAX | UNIT |
|----------------------------------------------------------------------------------------------------|---------------|-----|------|
| $f_{SCL}$ SCL clock frequency                                                                      |               | 400 | kHz  |
| $t_{BUF}$ Bus free time between a STOP and START condition                                         | 1.3           |     | μs   |
| $t_{LOW}$ Low period of the SCL clock                                                              | 1.3           |     | μs   |
| $t_{HI}$ High period of the SCL clock                                                              | 600           |     | ns   |
| $t_{RS-SU}$ Setup time for (repeated)START condition                                               | 600           |     | ns   |
| $t_{RS-HD}$ Hold time for (repeated)START condition                                                | 600           |     | ns   |
| $t_{D-SU}$ Data setup time                                                                         | 100           |     | ns   |
| $t_{D-HD}$ Data hold time                                                                          | 0             | 900 | ns   |
| $t_{SCL-R}$ Rise time of SCL signal                                                                | $20 + 0.1C_B$ | 300 | ns   |
| $t_{SCL-R1}$ Rise time of SCL signal after a repeated START condition and after an acknowledge bit | $20 + 0.1C_B$ | 300 | ns   |
| $t_{SCL-F}$ Fall time of SCL signal                                                                | $20 + 0.1C_B$ | 300 | ns   |
| $t_{SDA-R}$ Rise time of SDA signal                                                                | $20 + 0.1C_B$ | 300 | ns   |
| $t_{SDA-F}$ Fall time of SDA signal                                                                | $20 + 0.1C_B$ | 300 | ns   |

## I<sup>2</sup>C Bus Timing – Fast (continued)

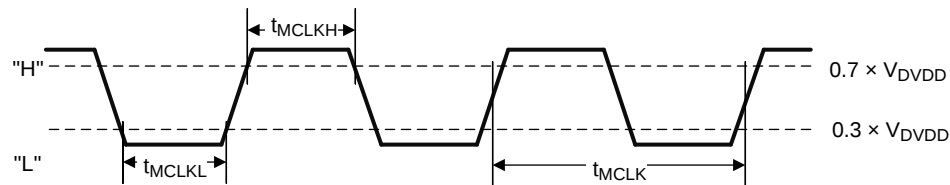
See [Figure 21](#).

|            |                                 | MIN | MAX | UNIT |
|------------|---------------------------------|-----|-----|------|
| $t_{P-SU}$ | Setup time for STOP condition   | 600 |     | ns   |
| $t_{SP}$   | Pulse width of spike suppressed |     | 50  | ns   |

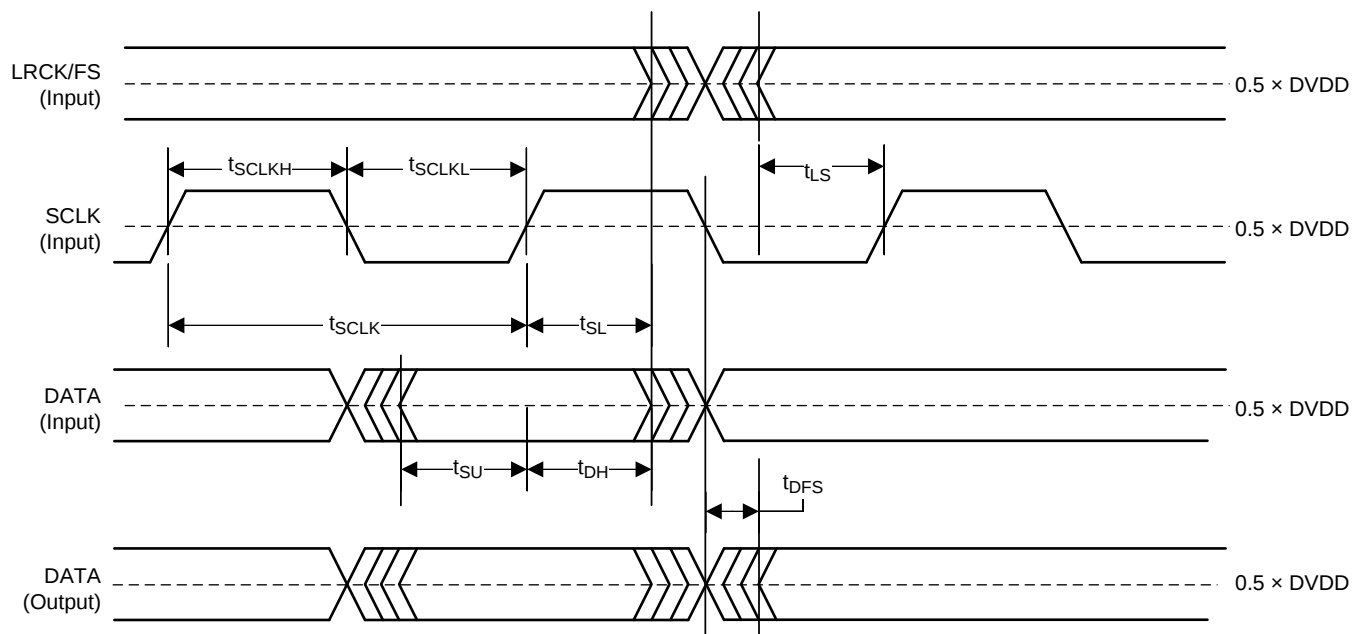
### 7.11 $\overline{SPK\_MUTE}$ Timing

See [Figure 22](#).

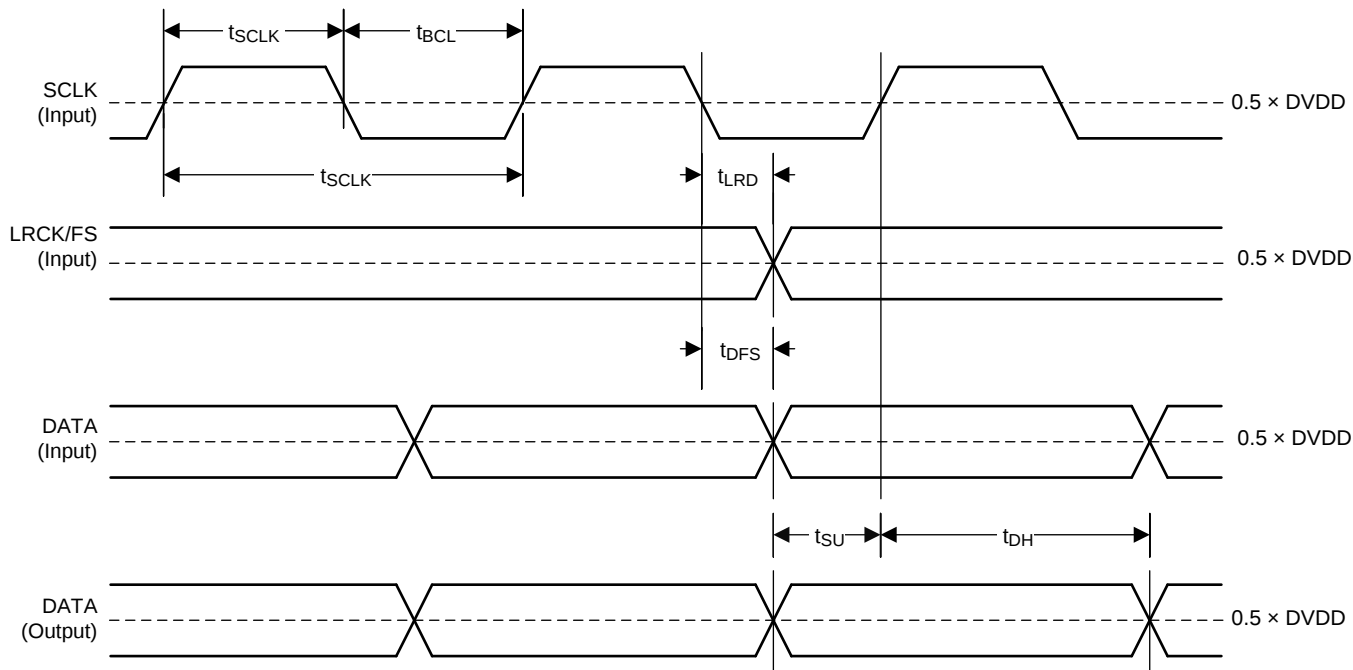
|       |           | MIN | MAX | UNIT |
|-------|-----------|-----|-----|------|
| $t_r$ | Rise time |     | 20  | ns   |
| $t_f$ | Fall time |     | 20  | ns   |



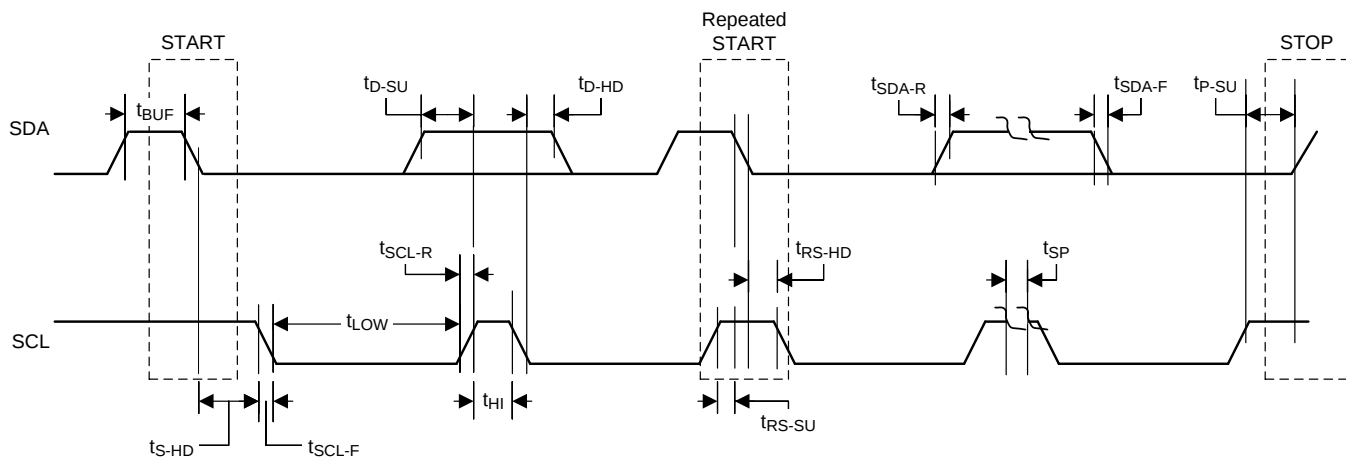
**Figure 18. Timing Requirements for MCLK Input**



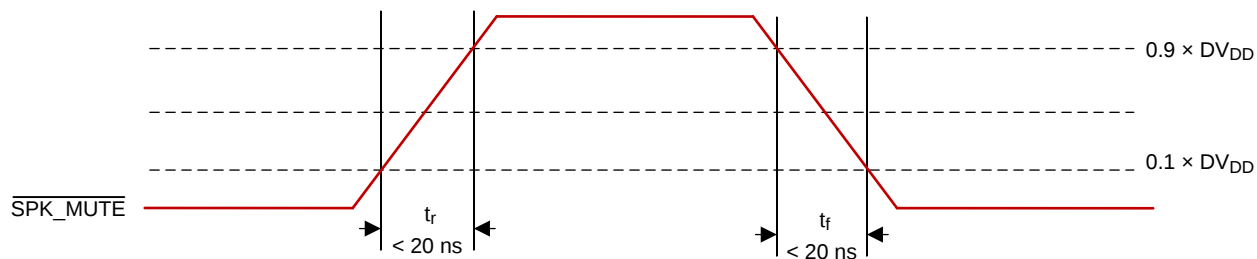
**Figure 19. MCLK Timing Diagram in Slave Mode**



**Figure 20. MCLK Timing Diagram in Master Mode**



**Figure 21. I²C Communication Port Timing Diagram**



**Figure 22. SPK\_MUTE Timing Diagram for Soft Mute Operation via Hardware Pin**

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**7.12 Power Dissipation**

| V <sub>PVDD</sub><br>(V) | SPK_GAIN <sup>(1)(2)(3)</sup><br>(dBV) | f <sub>SPK_AMP</sub><br>(kHz) | STATE OF<br>OPERATION | R <sub>SPK</sub><br>(Ω) | I <sub>PVDD</sub> <sup>(4)</sup><br>(mA) | I <sub>DVDD</sub> <sup>(5)</sup><br>(mA) | P <sub>DISS</sub><br>(W) |
|--------------------------|----------------------------------------|-------------------------------|-----------------------|-------------------------|------------------------------------------|------------------------------------------|--------------------------|
| 7.4                      | 20                                     | 384                           | Idle                  | 4                       | 21.3                                     | 35                                       | 0.273                    |
|                          |                                        |                               |                       | 6                       | 21.33                                    | 35                                       | 0.273                    |
|                          |                                        |                               |                       | 8                       | 21.3                                     | 35                                       | 0.273                    |
|                          |                                        |                               | Mute                  | 4                       | 21.33                                    | 35                                       | 0.273                    |
|                          |                                        |                               |                       | 6                       | 21.34                                    | 35                                       | 0.273                    |
|                          |                                        |                               |                       | 8                       | 21.36                                    | 35                                       | 0.274                    |
|                          |                                        |                               | Standby               | 4                       | 2.08                                     | 17                                       | 0.071                    |
|                          |                                        |                               |                       | 6                       | 2.11                                     | 17                                       | 0.072                    |
|                          |                                        |                               |                       | 8                       | 2.17                                     | 17                                       | 0.072                    |
|                          |                                        |                               | Powerdown             | 4                       | 2.03                                     | 1                                        | 0.018                    |
|                          |                                        |                               |                       | 6                       | 2.04                                     | 1                                        | 0.018                    |
|                          |                                        |                               |                       | 8                       | 2.06                                     | 1                                        | 0.019                    |
|                          |                                        | 768                           | Idle                  | 4                       | 27.48                                    | 35                                       | 0.319                    |
|                          |                                        |                               |                       | 6                       | 27.49                                    | 35                                       | 0.319                    |
|                          |                                        |                               |                       | 8                       | 24.46                                    | 35                                       | 0.297                    |
|                          |                                        |                               | Mute                  | 4                       | 27.5                                     | 35                                       | 0.319                    |
|                          |                                        |                               |                       | 6                       | 27.51                                    | 35                                       | 0.319                    |
|                          |                                        |                               |                       | 8                       | 27.52                                    | 35                                       | 0.319                    |
|                          |                                        |                               | Standby               | 4                       | 2.04                                     | 17                                       | 0.071                    |
|                          |                                        |                               |                       | 6                       | 2.08                                     | 17                                       | 0.071                    |
|                          |                                        |                               |                       | 8                       | 2.11                                     | 17                                       | 0.072                    |
|                          |                                        |                               | Powerdown             | 4                       | 2.06                                     | 1                                        | 0.019                    |
|                          |                                        |                               |                       | 6                       | 2.07                                     | 1                                        | 0.019                    |
|                          |                                        |                               |                       | 8                       | 2.08                                     | 1                                        | 0.019                    |

(1) Mute: P0-R3-B0,B5 = 1

(2) Standby: P0-R2-B5 = 1

(3) P0-R2-B0 = 1

(4) I<sub>PVDD</sub> refers to all current that flows through the PVDD supply for the DUT. Any other current sinks not directly related to the DUT current draw were removed.

(5) I<sub>DVDD</sub> refers to all current that flows through the DVDD (3.3-V) supply for the DUT. Any other current sinks not directly related to the DUT current draw were removed.

**Power Dissipation (continued)**

| V <sub>PVDD</sub><br>(V) | SPK_GAIN <sup>(1)(2)(3)</sup><br>(dBV) | f <sub>SPK_AMP</sub><br>(kHz) | STATE OF<br>OPERATION | R <sub>SPK</sub><br>(Ω) | I <sub>PVDD</sub> <sup>(4)</sup><br>(mA) | I <sub>DVDD</sub> <sup>(5)</sup><br>(mA) | P <sub>DISS</sub><br>(W) |
|--------------------------|----------------------------------------|-------------------------------|-----------------------|-------------------------|------------------------------------------|------------------------------------------|--------------------------|
| 11.1                     | 20                                     | 384                           | Idle                  | 4                       | 24.33                                    | 35                                       | 0.386                    |
|                          |                                        |                               |                       | 6                       | 24.32                                    | 35                                       | 0.385                    |
|                          |                                        |                               |                       | 8                       | 24.36                                    | 35                                       | 0.386                    |
|                          |                                        |                               | Mute                  | 4                       | 24.36                                    | 35                                       | 0.386                    |
|                          |                                        |                               |                       | 6                       | 24.32                                    | 35                                       | 0.385                    |
|                          |                                        |                               |                       | 8                       | 24.37                                    | 35                                       | 0.386                    |
|                          |                                        |                               | Standby               | 4                       | 3.58                                     | 17                                       | 0.096                    |
|                          |                                        |                               |                       | 6                       | 3.57                                     | 17                                       | 0.096                    |
|                          |                                        |                               |                       | 8                       | 3.58                                     | 17                                       | 0.096                    |
|                          |                                        |                               | Powerdown             | 4                       | 3.52                                     | 1                                        | 0.042                    |
|                          |                                        |                               |                       | 6                       | 3.52                                     | 1                                        | 0.042                    |
|                          |                                        |                               |                       | 8                       | 3.54                                     | 1                                        | 0.043                    |
|                          |                                        | 768                           | Idle                  | 4                       | 30.7                                     | 35                                       | 0.456                    |
|                          |                                        |                               |                       | 6                       | 30.65                                    | 35                                       | 0.456                    |
|                          |                                        |                               |                       | 8                       | 30.67                                    | 35                                       | 0.456                    |
|                          |                                        |                               | Mute                  | 4                       | 3.072                                    | 35                                       | 0.150                    |
|                          |                                        |                               |                       | 6                       | 30.69                                    | 35                                       | 0.456                    |
|                          |                                        |                               |                       | 8                       | 30.69                                    | 35                                       | 0.456                    |
|                          |                                        |                               | Standby               | 4                       | 3.54                                     | 17                                       | 0.095                    |
|                          |                                        |                               |                       | 6                       | 3.54                                     | 17                                       | 0.095                    |
|                          |                                        |                               |                       | 8                       | 3.58                                     | 17                                       | 0.096                    |
|                          |                                        |                               | Powerdown             | 4                       | 3.53                                     | 1                                        | 0.042                    |
|                          |                                        |                               |                       | 6                       | 3.53                                     | 1                                        | 0.042                    |
|                          |                                        |                               |                       | 8                       | 3.55                                     | 1                                        | 0.043                    |

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**Power Dissipation (continued)**

| V <sub>PVDD</sub><br>(V) | SPK_GAIN <sup>(1)(2)(3)</sup><br>(dBV) | f <sub>SPK_AMP</sub><br>(kHz) | STATE OF<br>OPERATION | R <sub>SPK</sub><br>(Ω) | I <sub>PVDD</sub> <sup>(4)</sup><br>(mA) | I <sub>DVDD</sub> <sup>(5)</sup><br>(mA) | P <sub>DISS</sub><br>(W) |
|--------------------------|----------------------------------------|-------------------------------|-----------------------|-------------------------|------------------------------------------|------------------------------------------|--------------------------|
| 12                       | 20                                     | 384                           | Idle                  | 4                       | 25.07                                    | 35                                       | 0.416                    |
|                          |                                        |                               |                       | 6                       | 25.08                                    | 35                                       | 0.416                    |
|                          |                                        |                               |                       | 8                       | 25.1                                     | 35                                       | 0.417                    |
|                          |                                        |                               | Mute                  | 4                       | 25.12                                    | 35                                       | 0.417                    |
|                          |                                        |                               |                       | 6                       | 25.08                                    | 35                                       | 0.416                    |
|                          |                                        |                               |                       | 8                       | 25.11                                    | 35                                       | 0.417                    |
|                          |                                        |                               | Standby               | 4                       | 3.92                                     | 17                                       | 0.103                    |
|                          |                                        |                               |                       | 6                       | 3.93                                     | 17                                       | 0.103                    |
|                          |                                        |                               |                       | 8                       | 3.94                                     | 17                                       | 0.103                    |
|                          |                                        |                               | Powerdown             | 4                       | 3.87                                     | 1                                        | 0.050                    |
|                          |                                        |                               |                       | 6                       | 3.85                                     | 1                                        | 0.050                    |
|                          |                                        |                               |                       | 8                       | 3.87                                     | 1                                        | 0.050                    |
|                          |                                        | 768                           | Idle                  | 4                       | 31.31                                    | 35                                       | 0.491                    |
|                          |                                        |                               |                       | 6                       | 31.29                                    | 35                                       | 0.491                    |
|                          |                                        |                               |                       | 8                       | 31.31                                    | 35                                       | 0.491                    |
|                          |                                        |                               | Mute                  | 4                       | 31.31                                    | 35                                       | 0.491                    |
|                          |                                        |                               |                       | 6                       | 31.33                                    | 35                                       | 0.491                    |
|                          |                                        |                               |                       | 8                       | 31.32                                    | 35                                       | 0.491                    |
|                          |                                        |                               | Standby               | 4                       | 3.88                                     | 17                                       | 0.103                    |
|                          |                                        |                               |                       | 6                       | 3.9                                      | 17                                       | 0.103                    |
|                          |                                        |                               |                       | 8                       | 3.91                                     | 17                                       | 0.103                    |
|                          |                                        |                               | Powerdown             | 4                       | 3.89                                     | 1                                        | 0.050                    |
|                          |                                        |                               |                       | 6                       | 3.91                                     | 1                                        | 0.050                    |
|                          |                                        |                               |                       | 8                       | 3.88                                     | 1                                        | 0.050                    |

**Power Dissipation (continued)**

| V <sub>PVDD</sub><br>(V) | SPK_GAIN <sup>(1)(2)(3)</sup><br>(dBV) | f <sub>SPK_AMP</sub><br>(kHz) | STATE OF<br>OPERATION | R <sub>SPK</sub><br>(Ω) | I <sub>PVDD</sub> <sup>(4)</sup><br>(mA) | I <sub>DVDD</sub> <sup>(5)</sup><br>(mA) | P <sub>DISS</sub><br>(W) |
|--------------------------|----------------------------------------|-------------------------------|-----------------------|-------------------------|------------------------------------------|------------------------------------------|--------------------------|
| 15                       | 26                                     | 384                           | Idle                  | 4                       | 27.94                                    | 35                                       | 0.535                    |
|                          |                                        |                               |                       | 6                       | 27.91                                    | 35                                       | 0.534                    |
|                          |                                        |                               |                       | 8                       | 27.75                                    | 35                                       | 0.532                    |
|                          |                                        |                               | Mute                  | 4                       | 27.98                                    | 35                                       | 0.535                    |
|                          |                                        |                               |                       | 6                       | 27.94                                    | 35                                       | 0.535                    |
|                          |                                        |                               |                       | 8                       | 27.88                                    | 35                                       | 0.534                    |
|                          |                                        |                               | Standby               | 4                       | 5.09                                     | 17                                       | 0.132                    |
|                          |                                        |                               |                       | 6                       | 5.12                                     | 17                                       | 0.133                    |
|                          |                                        |                               |                       | 8                       | 5.19                                     | 17                                       | 0.134                    |
|                          |                                        |                               | Powerdown             | 4                       | 5.02                                     | 1                                        | 0.079                    |
|                          |                                        |                               |                       | 6                       | 5.06                                     | 1                                        | 0.079                    |
|                          |                                        |                               |                       | 8                       | 5.14                                     | 1                                        | 0.080                    |
|                          |                                        | 768                           | Idle                  | 4                       | 33.05                                    | 35                                       | 0.611                    |
|                          |                                        |                               |                       | 6                       | 33.03                                    | 35                                       | 0.611                    |
|                          |                                        |                               |                       | 8                       | 33.08                                    | 35                                       | 0.612                    |
|                          |                                        |                               | Mute                  | 4                       | 33.03                                    | 35                                       | 0.611                    |
|                          |                                        |                               |                       | 6                       | 33.04                                    | 35                                       | 0.611                    |
|                          |                                        |                               |                       | 8                       | 33.05                                    | 35                                       | 0.611                    |
|                          |                                        |                               | Standby               | 4                       | 5.07                                     | 17                                       | 0.132                    |
|                          |                                        |                               |                       | 6                       | 5.09                                     | 17                                       | 0.132                    |
|                          |                                        |                               |                       | 8                       | 5.14                                     | 17                                       | 0.133                    |
|                          |                                        |                               | Powerdown             | 4                       | 5.02                                     | 1                                        | 0.079                    |
|                          |                                        |                               |                       | 6                       | 5.04                                     | 1                                        | 0.079                    |
|                          |                                        |                               |                       | 8                       | 5.09                                     | 1                                        | 0.080                    |

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**Power Dissipation (continued)**

| V <sub>PVDD</sub><br>(V) | SPK_GAIN <sup>(1)(2)(3)</sup><br>(dBV) | f <sub>SPK_AMP</sub><br>(kHz) | STATE OF<br>OPERATION | R <sub>SPK</sub><br>(Ω) | I <sub>PVDD</sub> <sup>(4)</sup><br>(mA) | I <sub>DVDD</sub> <sup>(5)</sup><br>(mA) | P <sub>DISS</sub><br>(W) |
|--------------------------|----------------------------------------|-------------------------------|-----------------------|-------------------------|------------------------------------------|------------------------------------------|--------------------------|
| 19.6                     | 26                                     | 384                           | Idle                  | 4                       | 32.27                                    | 35                                       | 0.748                    |
|                          |                                        |                               |                       | 6                       | 32.19                                    | 35                                       | 0.746                    |
|                          |                                        |                               |                       | 8                       | 32.08                                    | 35                                       | 0.744                    |
|                          |                                        |                               | Mute                  | 4                       | 32.27                                    | 35                                       | 0.748                    |
|                          |                                        |                               |                       | 6                       | 32.24                                    | 35                                       | 0.747                    |
|                          |                                        |                               |                       | 8                       | 32.22                                    | 35                                       | 0.747                    |
|                          |                                        |                               | Standby               | 4                       | 6.95                                     | 17                                       | 0.192                    |
|                          |                                        |                               |                       | 6                       | 6.93                                     | 17                                       | 0.192                    |
|                          |                                        |                               |                       | 8                       | 7                                        | 17                                       | 0.193                    |
|                          |                                        |                               | Powerdown             | 4                       | 6.89                                     | 1                                        | 0.138                    |
|                          |                                        |                               |                       | 6                       | 6.9                                      | 1                                        | 0.139                    |
|                          |                                        |                               |                       | 8                       | 6.96                                     | 1                                        | 0.140                    |
|                          |                                        | 768                           | Idle                  | 4                       | 34.99                                    | 35                                       | 0.801                    |
|                          |                                        |                               |                       | 6                       | 34.95                                    | 35                                       | 0.801                    |
|                          |                                        |                               |                       | 8                       | 34.97                                    | 35                                       | 0.801                    |
|                          |                                        |                               | Mute                  | 4                       | 34.96                                    | 35                                       | 0.801                    |
|                          |                                        |                               |                       | 6                       | 34.98                                    | 35                                       | 0.801                    |
|                          |                                        |                               |                       | 8                       | 34.96                                    | 35                                       | 0.801                    |
|                          |                                        |                               | Standby               | 4                       | 6.93                                     | 17                                       | 0.192                    |
|                          |                                        |                               |                       | 6                       | 6.93                                     | 17                                       | 0.192                    |
|                          |                                        |                               |                       | 8                       | 6.98                                     | 17                                       | 0.193                    |
|                          |                                        |                               | Powerdown             | 4                       | 6.84                                     | 1                                        | 0.137                    |
|                          |                                        |                               |                       | 6                       | 6.89                                     | 1                                        | 0.138                    |
|                          |                                        |                               |                       | 8                       | 6.9                                      | 1                                        | 0.139                    |

**Power Dissipation (continued)**

| V <sub>PVDD</sub><br>(V) | SPK_GAIN <sup>(1)(2)(3)</sup><br>(dBV) | f <sub>SPK_AMP</sub><br>(kHz) | STATE OF<br>OPERATION | R <sub>SPK</sub><br>(Ω) | I <sub>PVDD</sub> <sup>(4)</sup><br>(mA) | I <sub>DVDD</sub> <sup>(5)</sup><br>(mA) | P <sub>DISS</sub><br>(W) |
|--------------------------|----------------------------------------|-------------------------------|-----------------------|-------------------------|------------------------------------------|------------------------------------------|--------------------------|
| 24                       | 26                                     | 384                           | Idle                  | 4                       | 36.93                                    | 35                                       | 1.002                    |
|                          |                                        |                               |                       | 6                       | 36.87                                    | 35                                       | 1.000                    |
|                          |                                        |                               |                       | 8                       | 36.77                                    | 35                                       | 0.998                    |
|                          |                                        |                               | Mute                  | 4                       | 36.94                                    | 35                                       | 1.002                    |
|                          |                                        |                               |                       | 6                       | 36.89                                    | 35                                       | 1.001                    |
|                          |                                        |                               |                       | 8                       | 36.85                                    | 35                                       | 1.000                    |
|                          |                                        |                               | Standby               | 4                       | 8.73                                     | 17                                       | 0.266                    |
|                          |                                        |                               |                       | 6                       | 8.72                                     | 17                                       | 0.265                    |
|                          |                                        |                               |                       | 8                       | 8.71                                     | 17                                       | 0.265                    |
|                          |                                        |                               | Powerdown             | 4                       | 8.64                                     | 1                                        | 0.211                    |
|                          |                                        |                               |                       | 6                       | 8.66                                     | 1                                        | 0.211                    |
|                          |                                        |                               |                       | 8                       | 8.69                                     | 1                                        | 0.212                    |
|                          |                                        | 768                           | Idle                  | 4                       | 36.84                                    | 35                                       | 1.000                    |
|                          |                                        |                               |                       | 6                       | 36.86                                    | 35                                       | 1.000                    |
|                          |                                        |                               |                       | 8                       | 36.83                                    | 35                                       | 0.999                    |
|                          |                                        |                               | Mute                  | 4                       | 36.85                                    | 35                                       | 1.000                    |
|                          |                                        |                               |                       | 6                       | 36.84                                    | 35                                       | 1.000                    |
|                          |                                        |                               |                       | 8                       | 36.82                                    | 35                                       | 0.999                    |
|                          |                                        |                               | Standby               | 4                       | 8.66                                     | 17                                       | 0.264                    |
|                          |                                        |                               |                       | 6                       | 8.68                                     | 17                                       | 0.264                    |
|                          |                                        |                               |                       | 8                       | 8.71                                     | 17                                       | 0.265                    |
|                          |                                        |                               | Powerdown             | 4                       | 8.63                                     | 1                                        | 0.210                    |
|                          |                                        |                               |                       | 6                       | 8.64                                     | 1                                        | 0.211                    |
|                          |                                        |                               |                       | 8                       | 8.65                                     | 1                                        | 0.211                    |

## 7.13 Typical Characteristics

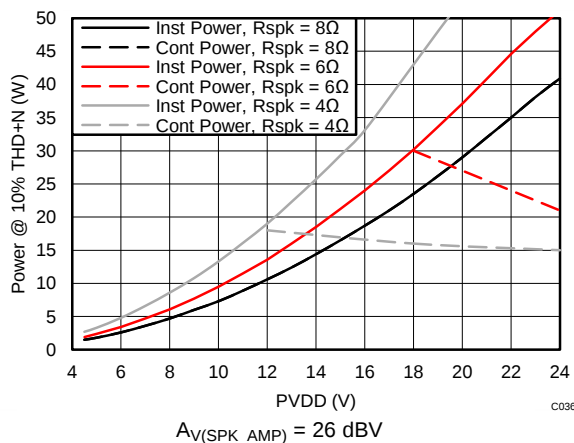
All performance plots were taken using the TAS5754M-56MEVM at room temperature, unless otherwise noted. The term *Traditional LC filter* refers to the output filter that is present by default on the EVM. For *Filterless* measurements, the on-board LC filter was removed and an Audio Precision AUX-025 measurement filter was used to take the measurements.

**Table 1. Quick Reference Table**

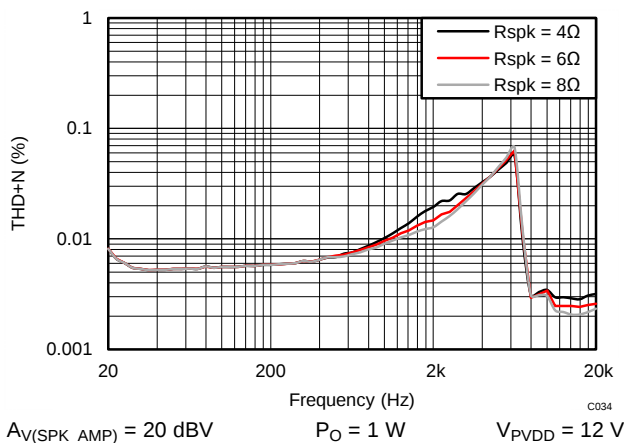
| OUTPUT CONFIGURATIONS                          | PLOT TITLE                                        | FIGURE NUMBER             |
|------------------------------------------------|---------------------------------------------------|---------------------------|
| Bridge Tied Load (BTL) Configuration Curves    | Output Power vs PVDD                              | <a href="#">Figure 23</a> |
|                                                | THD+N vs Frequency, $V_{PVDD} = 12\text{ V}$      | <a href="#">Figure 24</a> |
|                                                | THD+N vs Frequency, $V_{PVDD} = 15\text{ V}$      | <a href="#">Figure 25</a> |
|                                                | THD+N vs Frequency, $V_{PVDD} = 18\text{ V}$      | <a href="#">Figure 26</a> |
|                                                | THD+N vs Frequency, $V_{PVDD} = 24\text{ V}$      | <a href="#">Figure 27</a> |
|                                                | THD+N vs Power, $V_{PVDD} = 12\text{ V}$          | <a href="#">Figure 28</a> |
|                                                | THD+N vs Power, $V_{PVDD} = 15\text{ V}$          | <a href="#">Figure 29</a> |
|                                                | THD+N vs Power, $V_{PVDD} = 18\text{ V}$          | <a href="#">Figure 30</a> |
|                                                | THD+N vs Power, $V_{PVDD} = 24\text{ V}$          | <a href="#">Figure 31</a> |
|                                                | Idle Channel Noise vs PVDD                        | <a href="#">Figure 32</a> |
|                                                | Efficiency vs Output Power                        | <a href="#">Figure 33</a> |
|                                                | Idle Current Draw (Filterless) vs PVDD            | <a href="#">Figure 34</a> |
|                                                | Idle Current Draw (Traditional LC Filter) vs PVDD | <a href="#">Figure 35</a> |
|                                                | Crosstalk vs. Frequency                           | <a href="#">Figure 36</a> |
|                                                | PVDD PSRR vs Frequency                            | <a href="#">Figure 37</a> |
|                                                | DVDD PSRR vs Frequency                            | <a href="#">Figure 38</a> |
|                                                | AVDD PSRR vs Frequency                            | <a href="#">Figure 39</a> |
|                                                | CPVDD PSRR vs Frequency                           | <a href="#">Figure 40</a> |
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|                                                | THD+N vs Frequency, $V_{PVDD} = 12\text{ V}$      | <a href="#">Figure 43</a> |
|                                                | THD+N vs Frequency, $V_{PVDD} = 15\text{ V}$      | <a href="#">Figure 44</a> |
|                                                | THD+N vs Frequency, $V_{PVDD} = 18\text{ V}$      | <a href="#">Figure 45</a> |
|                                                | THD+N vs Frequency, $V_{PVDD} = 24\text{ V}$      | <a href="#">Figure 46</a> |
|                                                | THD+N vs Power, $V_{PVDD} = 12\text{ V}$          | <a href="#">Figure 47</a> |
|                                                | THD+N vs Power, $V_{PVDD} = 15\text{ V}$          | <a href="#">Figure 48</a> |
|                                                | THD+N vs Power, $V_{PVDD} = 18\text{ V}$          | <a href="#">Figure 49</a> |
|                                                | THD+N vs Power, $V_{PVDD} = 24\text{ V}$          | <a href="#">Figure 50</a> |
|                                                | Idle Channel Noise vs PVDD                        | <a href="#">Figure 51</a> |
|                                                | Efficiency vs Output Power                        | <a href="#">Figure 52</a> |
|                                                | Idle Current Draw (filterless) vs PVDD            | <a href="#">Figure 57</a> |
|                                                | Idle Current Draw (traditional LC filter) vs PVDD | <a href="#">Figure 58</a> |
|                                                | PVDD PSRR vs Frequency                            | <a href="#">Figure 53</a> |
|                                                | DVDD PSRR vs Frequency                            | <a href="#">Figure 54</a> |
|                                                | AVDD PSRR vs Frequency                            | <a href="#">Figure 55</a> |
|                                                | CPVDD PSRR vs Frequency                           | <a href="#">Figure 56</a> |
|                                                | Powerdown Current Draw vs PVDD                    | <a href="#">Figure 59</a> |

### 7.13.1 Bridge Tied Load (BTL) Configuration Curves

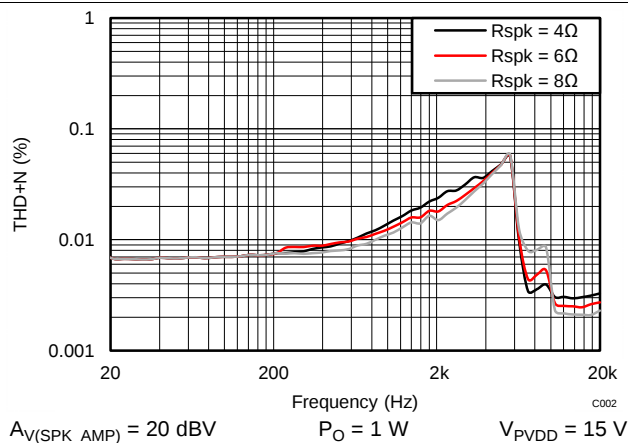
Return to [Quick Reference Table](#).



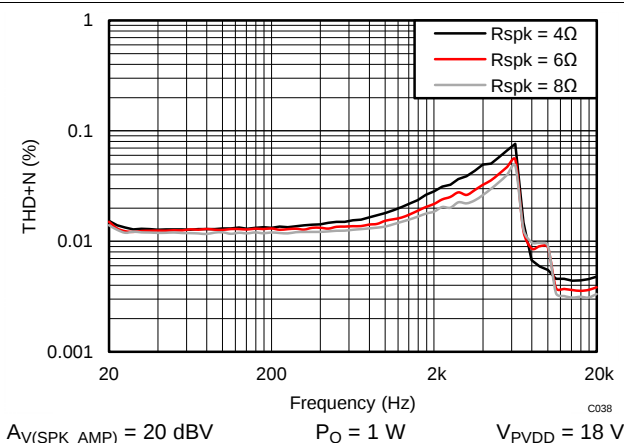
**Figure 23. Output Power vs PVDD – BTL**



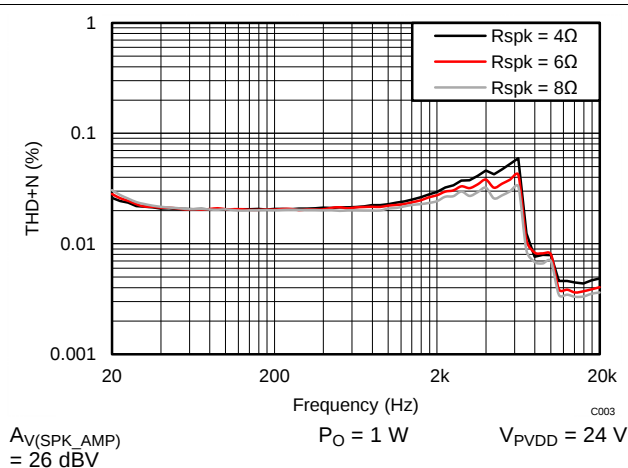
**Figure 24. THD+N vs Frequency – BTL**



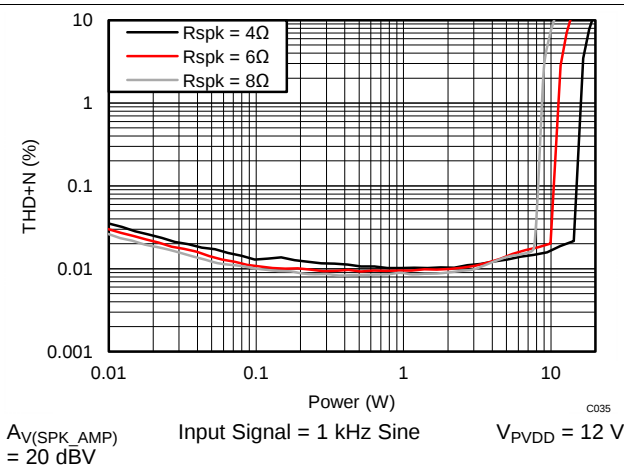
**Figure 25. THD+N vs Frequency – BTL**



**Figure 26. THD+N vs Frequency – BTL**



**Figure 27. THD+N vs Frequency – BTL**

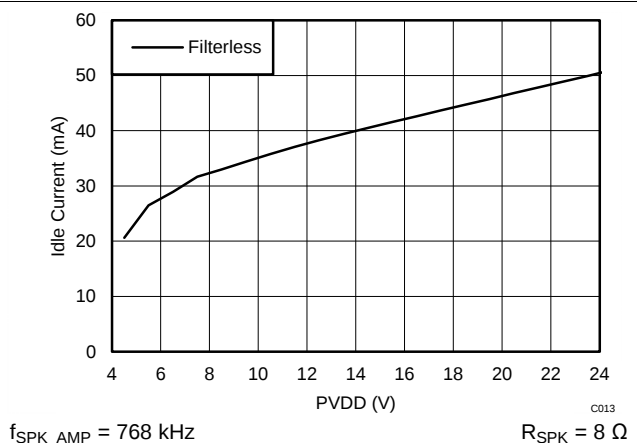
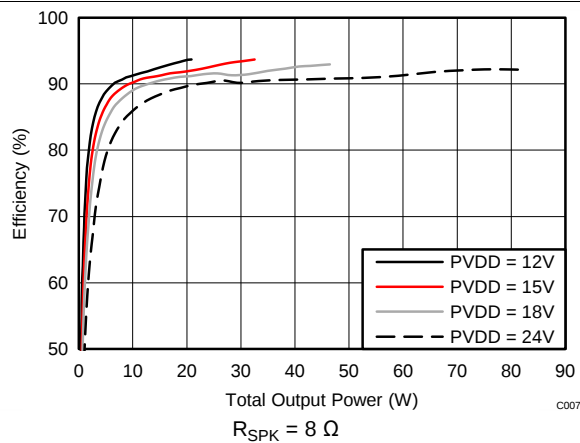
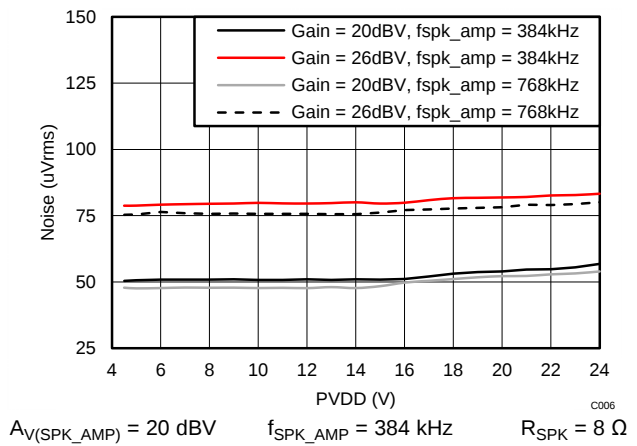
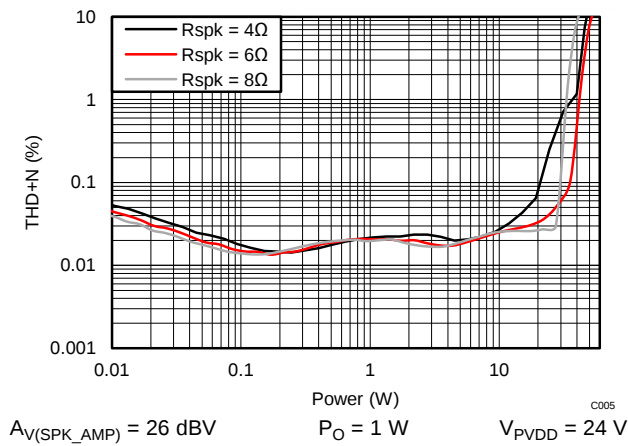
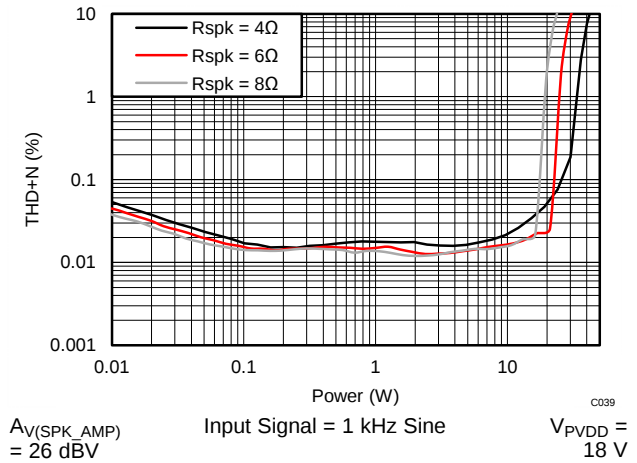
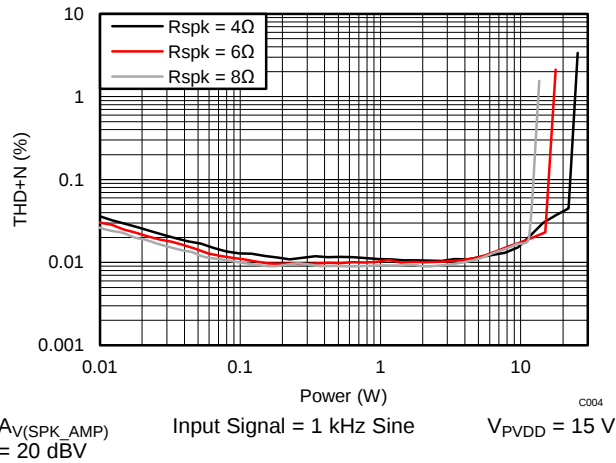


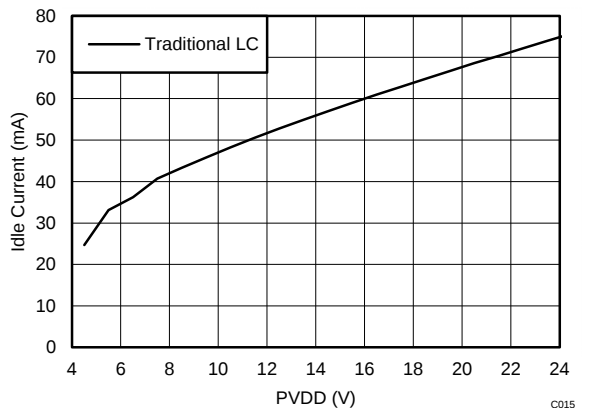
**Figure 28. THD + N vs Power – BTL**

# TAS5756M

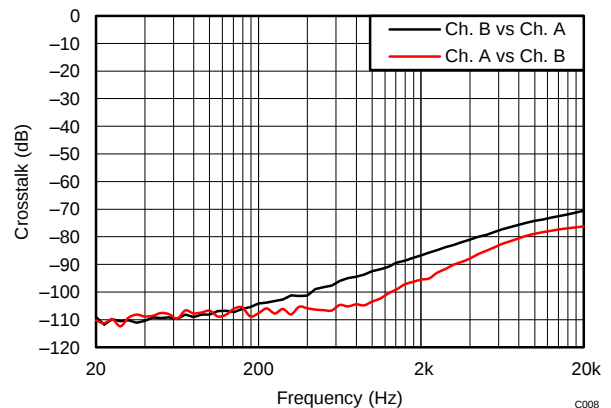
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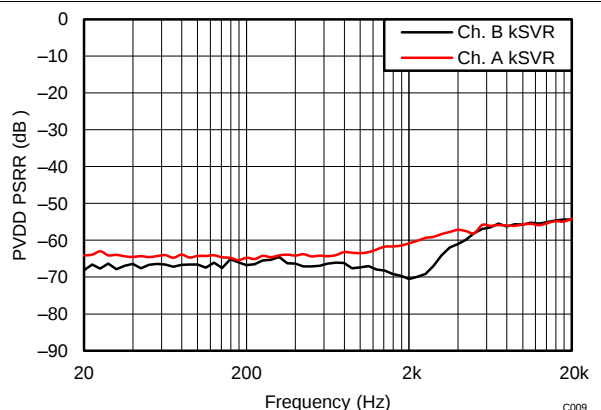




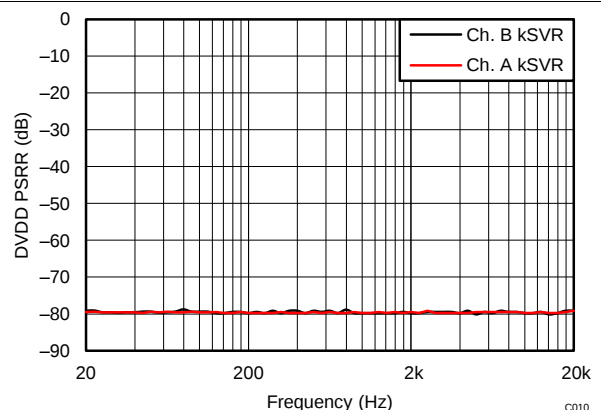
**Figure 35. Idle Current Draw  
(Traditional LC Filter) vs PVDD – BTL**



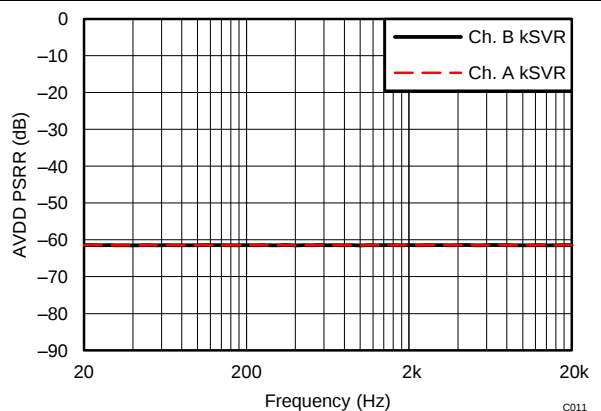
**Figure 36. Crosstalk vs Frequency – BTL**



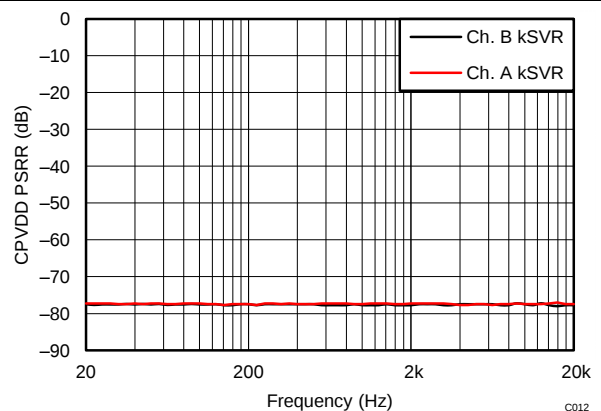
**Figure 37. PVDD PSRR vs Frequency – BTL**



**Figure 38. DVDD PSRR vs Frequency – BTL**



**Figure 39. AVDD PSRR vs Frequency – BTL**

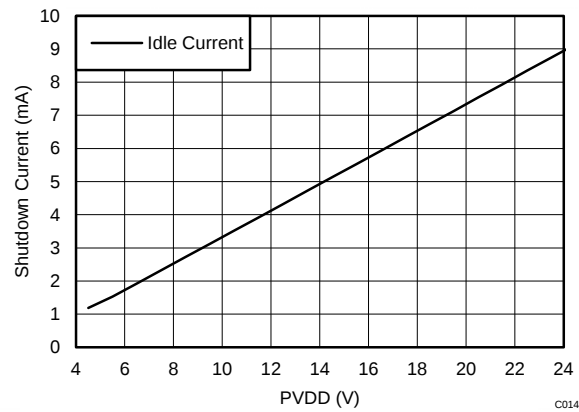


**Figure 40. CPVDD PSRR vs Frequency – BTL**

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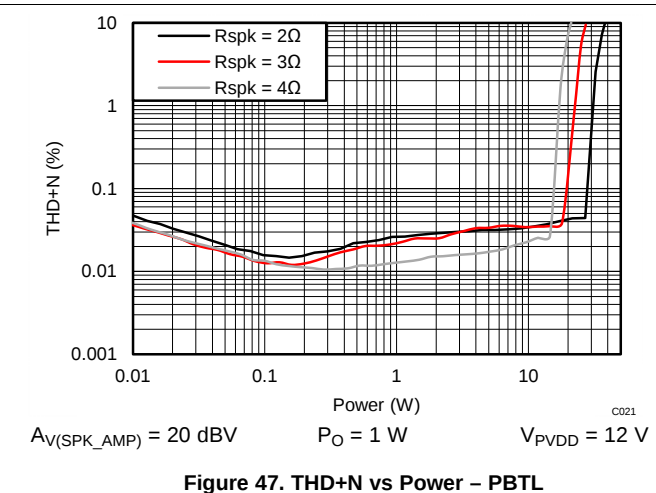
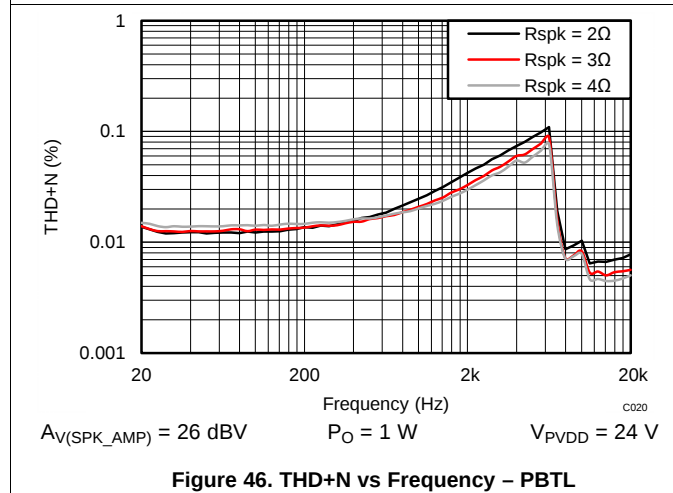
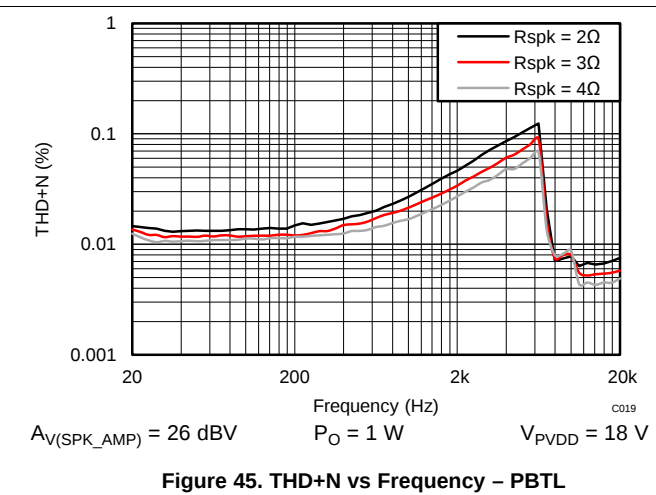
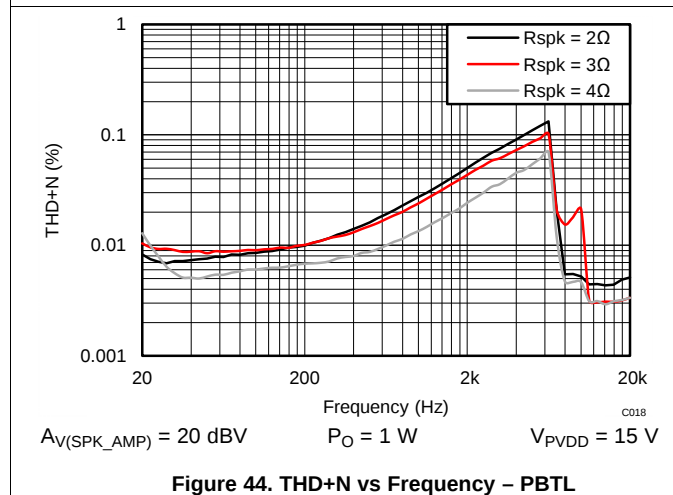
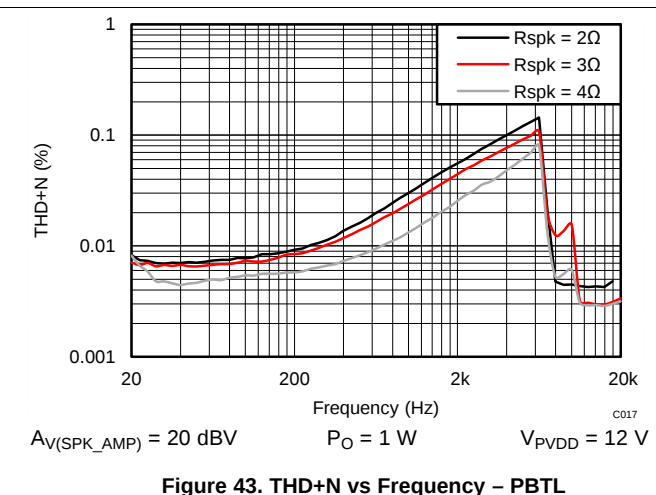
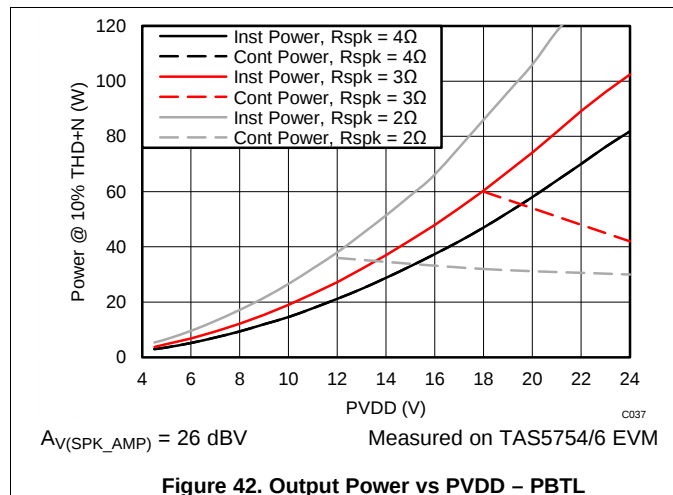
$A_{V(SP\_AMP)} = 26 \text{ dBV}$

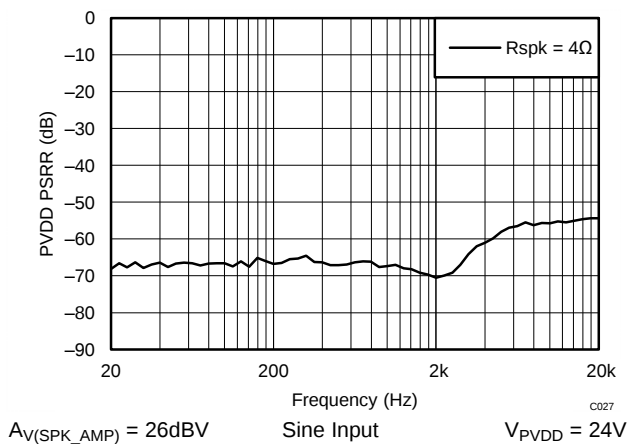
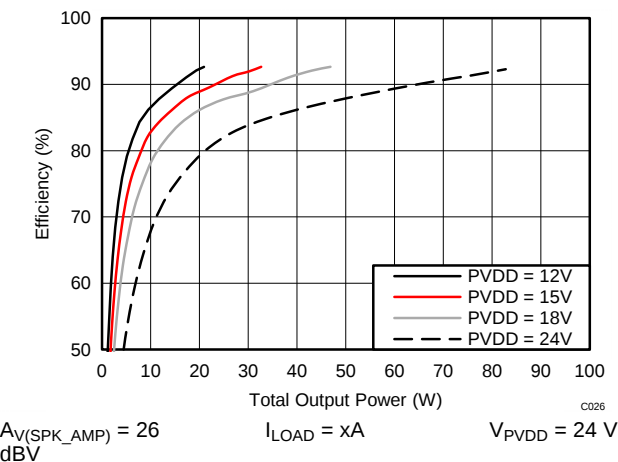
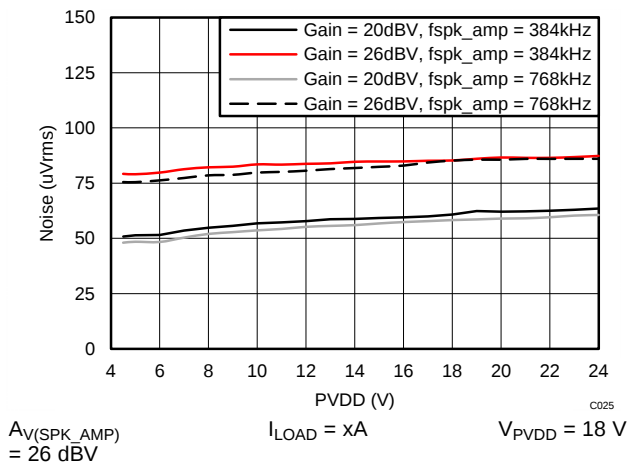
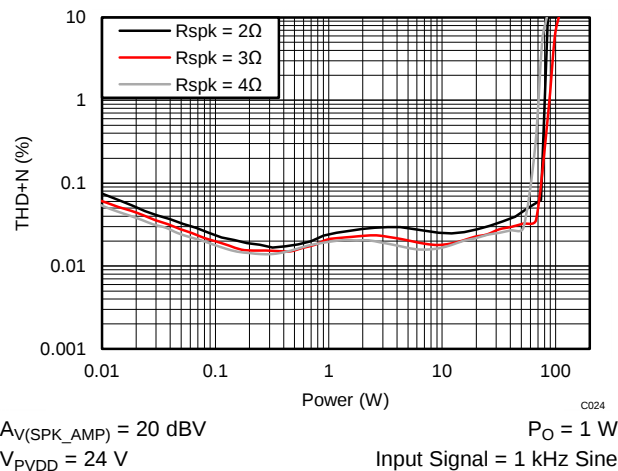
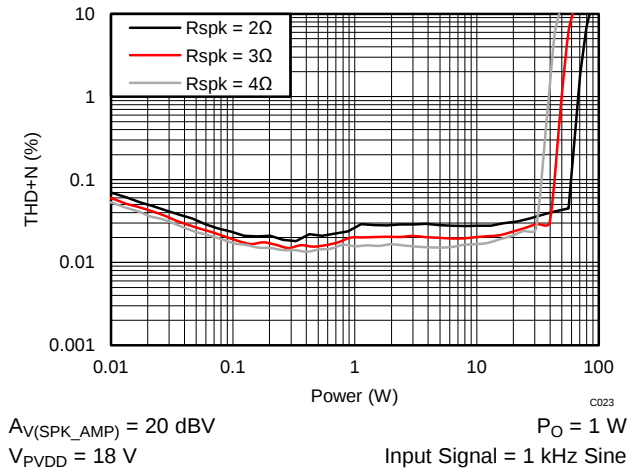
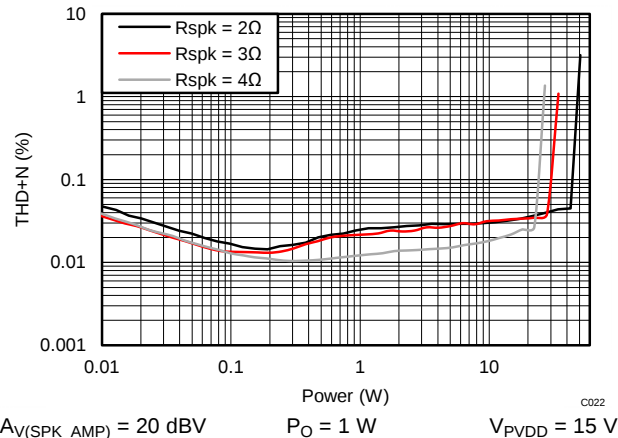
$f_{SP\_AMP} = 786 \text{ kHz}$

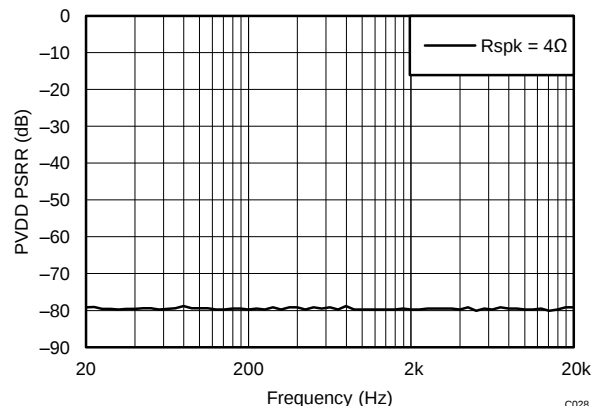
**Figure 41. Powerdown Current Draw vs PVDD – BTL**

### 7.13.2 Parallel Bridge Tied Load (PBTL) Configuration

Return to [Quick Reference Table](#).

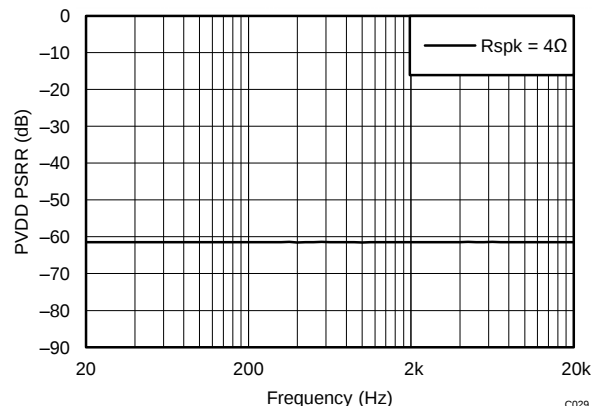






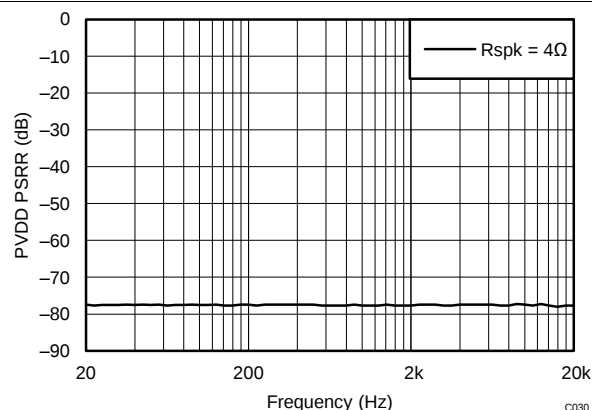
$A_{V(SP\_K\_AMP)} = 26 \text{ dBV}$   
 $V_{PVDD} = 24 \text{ V}$   
 $R_{SPK} = 8 \Omega$   
 Supply Noise = 250 mV

**Figure 54. DVDD PSRR vs Frequency – PBTL**



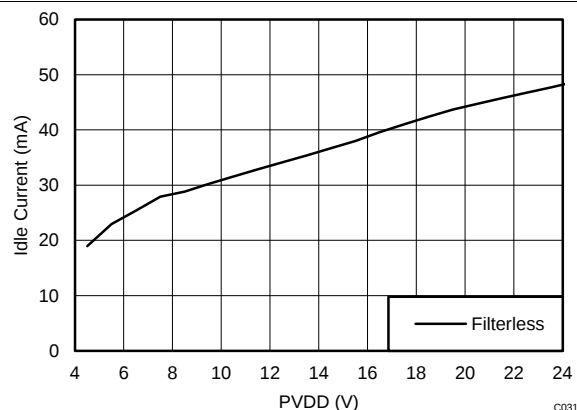
$A_{V(SP\_K\_AMP)} = 26 \text{ dBV}$   
 $V_{PVDD} = 24 \text{ V}$   
 $R_{SPK} = 8 \Omega$   
 Supply Noise = 250 mV

**Figure 55. AVDD PSRR vs Frequency – PBTL**

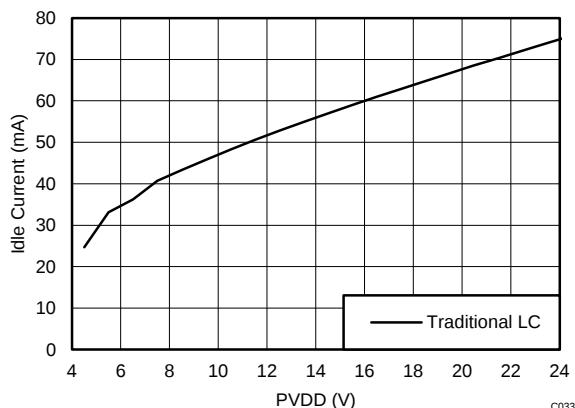


$A_{V(SP\_K\_AMP)} = 26 \text{ dBV}$   
 $V_{PVDD} = 24 \text{ V}$   
 Sine Input  
 Supply Noise = 250 mV

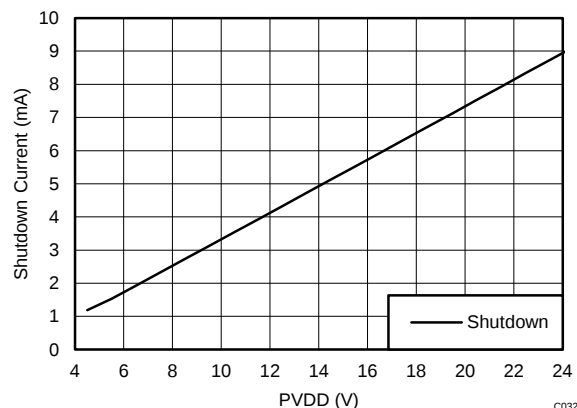
**Figure 56. CPVDD PSRR vs Frequency – PBTL**



**Figure 57. Idle Current Draw (Filterless) vs PVDD – PBTL**



**Figure 58. Idle Current Draw  
(Traditional LC filter) vs PVDD – PBTL**



$A_{V(SP\_K\_AMP)} = 26 \text{ dBV}$   
 $f_{SPK\_AMP} = 786 \text{ kHz}$

**Figure 59. Powerdown Current Draw vs PVDD – PBTL**

## 8 Detailed Description

### 8.1 Overview

The TAS5756M device integrates 4 main building blocks together into a single cohesive device that maximizes sound quality, flexibility, and ease of use. The 4 main building blocks are listed as follows:

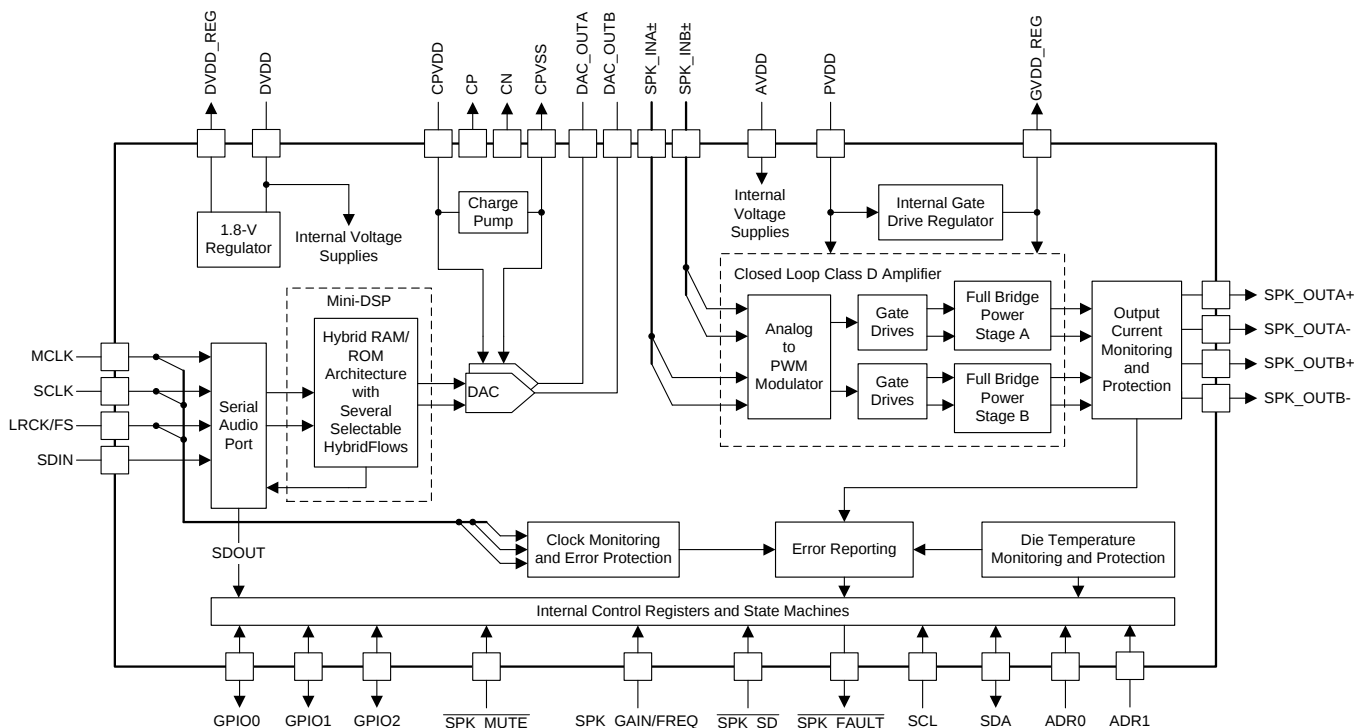
- A stereo audio DAC, boasting a strong Burr-Brown heritage with a highly flexible serial audio port.
- A miniDSP audio processing core with HybridFlow architecture, which provides an increase in flexibility over a fixed-function ROM device with faster download time than a fully programmable device
- A flexible closed-loop amplifier capable of operating in stereo or mono, at several different switching frequencies, and with a variety of output voltages and loads.
- An I<sup>2</sup>C control port for communication with the device

The device requires only two power supplies for proper operation. A DVDD supply is needed to power the low-voltage digital and analog circuitry. Another supply, called PVDD, is needed to provide power to the output stage of the audio amplifier. The operating range for these supplies is shown in the [Recommended Operating Conditions](#) table.

Communication with the device is accomplished through the I<sup>2</sup>C control port. A speaker amplifier fault line is also provided to notify a system controller of the occurrence of an overtemperature, overcurrent, overvoltage, undervoltage, or DC error in the speaker amplifier. There are three digital GPIO pins that are available for use by the HybridFlows. One popular use of the GPIO lines is to provide a Serial Audio Output from the device (SDOUT). HybridFlows which provide an SDOUT customarily present that signal on GPIO2, although this configuration can be changed via the I<sup>2</sup>C control port. The register space in the control port spans several pages to accommodate some static controls which maintain their functionality across HybridFlows, as well as controls that are determined by the HybridFlow used.

The MiniDSP audio processing core, featuring a HybridFlow architecture, allows the selection of a configurable DSP program called a *HybridFlow* from a list of available HybridFlows. A hybrid flow combines audio processing blocks, many of which are built in the ROM portion of the device, together in a single payload. The PurePath™ Console GUI provides a means by which to select the HybridFlow and manipulate the controls associated with that HybridFlow.

## 8.2 Functional Block Diagram



## 8.3 Feature Description

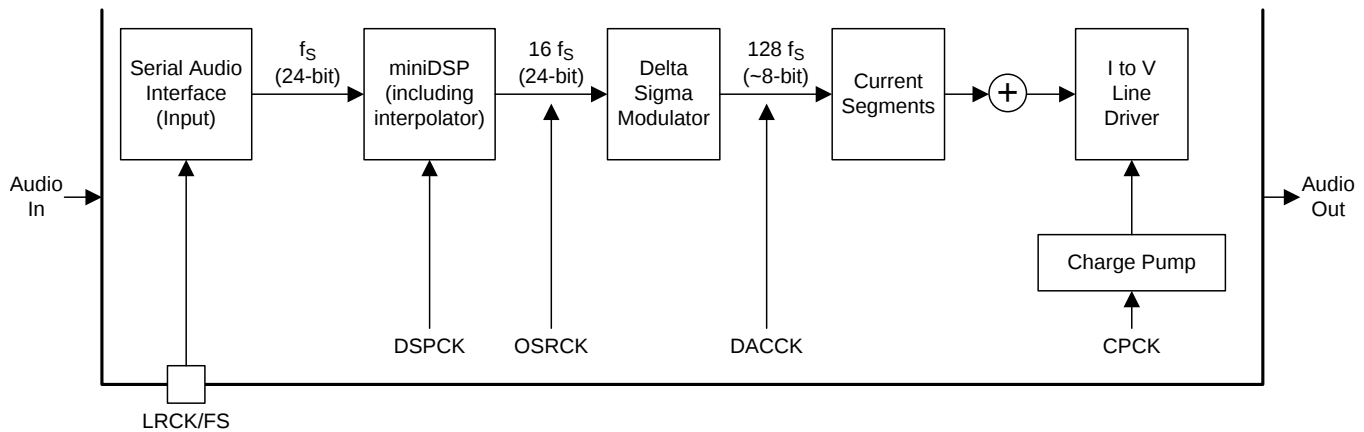
### 8.3.1 Power-on-Reset (POR) Function

The TAS5756M device has a power-on reset function. This feature resets all of the registers to their default configuration as the device is powering up. When the low-voltage power supply used to power DVDD, AVDD, and CPVDD exceeds the POR threshold, the device holds sets all of the internal registers to their default values and holds them there until it receives valid MCLK, SCLK, and LRCK/FS toggling for a period of approximately 4 ms. After the toggling period has passed, the internal reset of the registers is removed and the registers can be programmed via the I<sup>2</sup>C Control Port.

### 8.3.2 Device Clocking

The TAS5756M devices have flexible systems for clocking. Internally, the device requires a number of clocks, mostly at related clock rates to function correctly. All of these clocks can be derived from the Serial Audio Interface in one form or another.

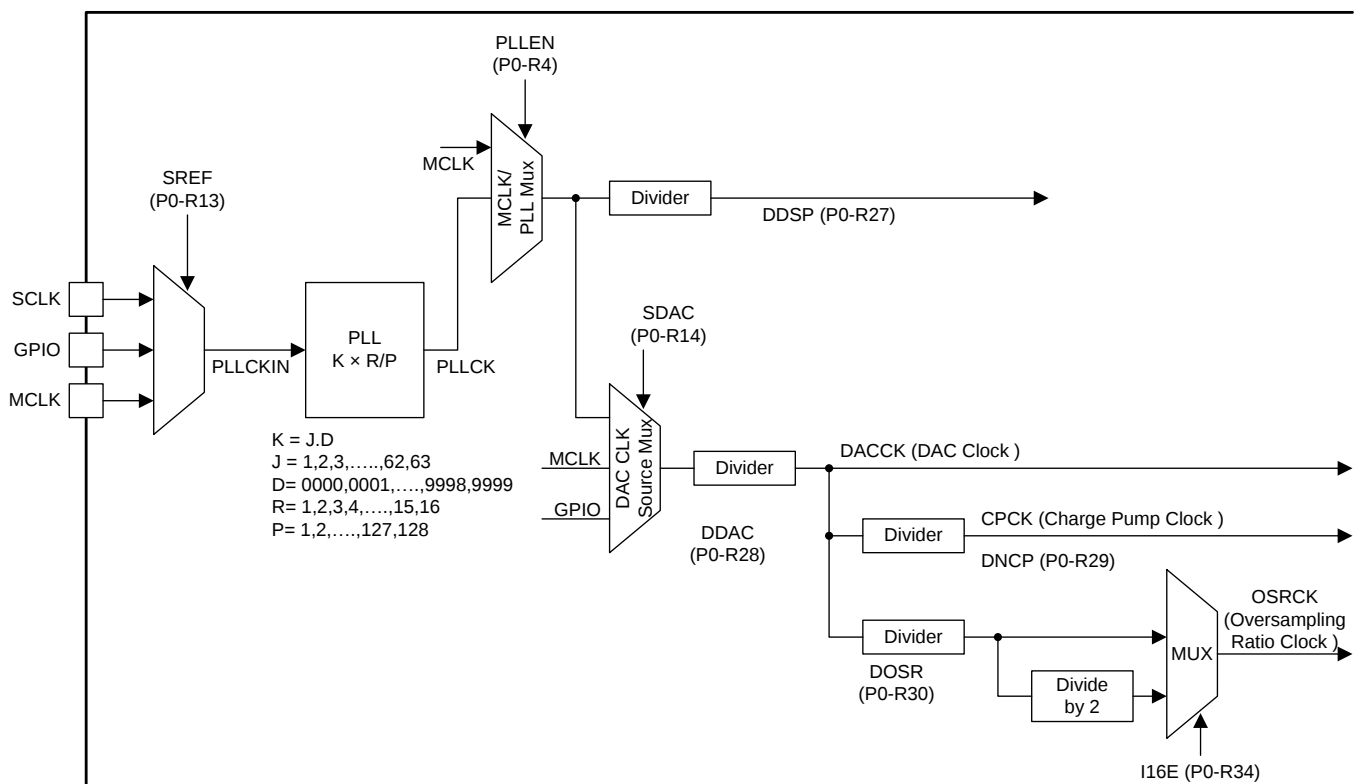
## Feature Description (continued)



**Figure 60. Audio Flow with Respective Clocks**

Figure 60 shows the basic data flow at basic sample rate ( $f_s$ ). When the data is brought into the serial audio interface, it is processed, interpolated and modulated to  $128 \times f_s$  before arriving at the current segments for the final digital to analog conversion.

Figure 61 shows the clock tree.



**Figure 61. TAS5756M Clock Distribution Tree**

The Serial Audio Interface typically has 4 connection pins which are listed as follows:

- MCLK (System Master Clock)
- SCLK (Bit Clock)
- LRCK/FS (Left Right Word Clock and Frame Sync)

## Feature Description (continued)

- SDIN (Input Data. The output date, SDOOUT, is presented on one of the GPIO pins. See the [Serial Data Output](#) section)

The device has an internal PLL that is used to take either MCLK or SCLK and create the higher rate clocks required by the and the DAC clock.

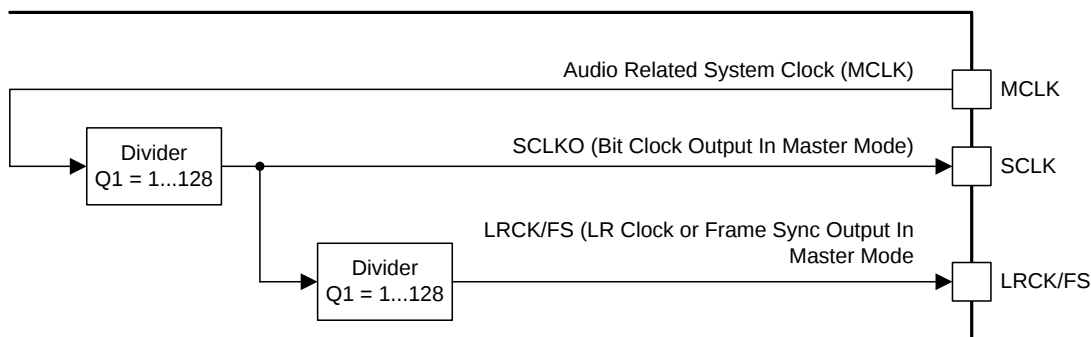
In situations where the highest audio performance is required, bringing MCLK to the device along with SCLK and LRCK/FS is recommended. The device should be configured so that the PLL is only providing a clock source to the DSP. All other clocks are then a division of the incoming MCLK. To enable the MCLK as the main source clock, with all others being created as divisions of the incoming MCLK, set the DAC CLK source Mux (SDAC in [Figure 61](#)) to use MCLK as a source, rather than the output of the MCLK/PLL Mux.

### 8.3.3 Serial Audio Port

#### 8.3.3.1 Clock Master Mode from Audio Rate Master Clock

In Master Mode, the device generates bit clock and left-right and frame sync clock and outputs them on the appropriate pins. To configure the device in this mode, first put the device into reset, then use registers SLCKO and LRKO (P0-R9). Then reset the LRCK/FS and SCLK divider counters using bits RSLCK and RLRK (P0-R12). Finally, exit reset.

[Figure 62](#) shows a simplified serial port clock tree for the device in master mode.



**Figure 62. Simplified Clock Tree for MCLK Sourced Master Mode**

In master mode, MCLK is an input and SCLK and LRCK/FS are outputs. SCLK and LRCK/FS are integer divisions of MCLK. Master mode with a non-audio rate master clock source requires external GPIO's to use the PLL in standalone mode. The PLL needs to be configured to ensure that the on-chip processor can be driven at its maximum clock rate. This mode of operation is described in the [Clock Master from a Non-Audio Rate Master Clock](#) section.

When used with audio rate master clocks, the register changes that need to be done include switching the device into master mode, and setting the divider ratio. An example of this mode of operations is using 24.576 MCLK as a master clock source and driving the SCLK and LRCK/FS with integer dividers to create 48 kHz. In this mode, the DAC section of the device is also running from the PLL output. The TAS5756M device is able to meet the specified audio performance while using the internal PLL. However, using the MCLK CMOS oscillator source will have less jitter than the PLL.

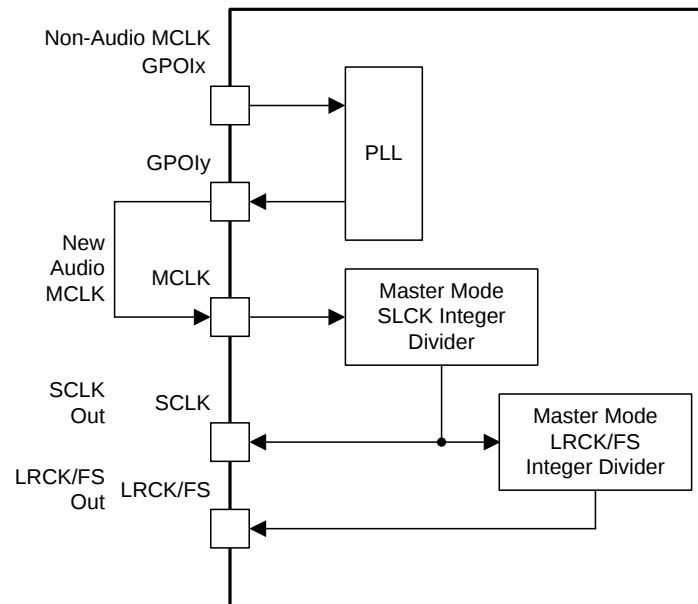
To switch the DAC clocks (SDAC in the [Figure 61](#)) the following registers should be modified

- Clock Tree Flex Mode (P253-R63 and P253-R64)
- DAC and OSR Source Clock Register (P0-R14). Set to 0x30 (MCLK input, and OSR is set to whatever the DAC source is)
- The DAC clock divider should be  $16f_s$ .
  - $16 \times 48 \text{ kHz} = 768 \text{ kHz}$
  - $24.576 \text{ MHz (MCLK in)} / 768 \text{ kHz} = 32$
  - Therefore, the divide ratio for register DDAC (P0-R28) should be set to 32. The register mapping gives  $0x00 = 1$ , so 32 must be converted to 0x1F (31dec).

## Feature Description (continued)

### 8.3.3.2 Clock Master from a Non-Audio Rate Master Clock

The classic example here is running 12-MHz Master clock for a 48-kHz sampling system. Given the clock tree for the device (shown in [Figure 61](#)), a non-audio clock rate cannot be brought into the MLCK to the PLL in master mode. Therefore, the PLL source must be configured to be a GPIO pin, and the output brought back into another GPIO pin.



**Figure 63. Generating Audio Clocks Using Non-Audio Clock Sources**

The clock flow through the system is shown in [Figure 63](#). The newly generated MLCK must be brought out of the device on a GPIO pin, then brought into the MLCK pin for integer division to create SCLK and LRCK/FS outputs.

#### NOTE

Pullup resistors should be used on SCLK and LRCK/FS in this mode to ensure the device remains out of sleep mode.

### 8.3.3.3 Clock Slave Mode with 4-Wire Operation (SCLK, MCLK, LRCK/FS, SDIN)

The TAS5756M device requires a system clock to operate the digital interpolation filters and advanced segment DAC modulators. The system clock is applied at the MLCK input and supports up to 50 MHz. The TAS5756M device system-clock detection circuit automatically senses the system-clock frequency. Common audio sampling frequencies in the bands of 8 kHz, 16 kHz, (32 kHz – 44.1 kHz – 48kHz), (88.2 kHz – 96 kHz), and (176.4 kHz – 192 kHz) are supported.

#### NOTE

Values in the parentheses are grouped when detected, for example, 88.2 kHz and 96 kHz are detected as *double rate*, 32 kHz, 44.1 kHz and 48 kHz are detected as *single rate* and so on.

In the presence of a valid bit MCLK, SCLK and LRCK/FS, the device automatically configures the clock tree and PLL to drive the miniDSP as required.

The sampling frequency detector sets the clock for the digital filter, Delta Sigma Modulator (DSM) and the Negative Charge Pump (NCP) automatically. [Table 2](#) shows examples of system clock frequencies for common audio sampling rates.

## Feature Description (continued)

MLCK rates that are not common to standard audio clocks, between 1 MHz and 50 MHz, are supported by configuring various PLL and clock-divider registers directly. In this mode, auto clock mode should be disabled using P0-R37. Additionally, it may be necessary to ignore clock error detection if external clocks are not-available for some time during configuration or if the clocks presented on the pins of the device or are invalid. This extended programmability allows the device to operate in an advanced mode in which it becomes a clock master and drive the host serial port with LRCK/FS and SLCK, from a non-audio related clock (for example, using a setting of 12 MHz to generate 44.1 kHz [LRCK/FS] and 2.8224 MHz [SLCK]).

Table 2 shows the timing requirements for the system clock input. For optimal performance, use a clock source with low phase jitter and noise. For MCLK timing requirements, refer to the [Serial Audio Port Timing – Master Mode](#) section.

**Table 2. System Master Clock Inputs for Audio Related Clocks**

| SAMPLING<br>FREQUENCY | SYSTEM CLOCK FREQUENCY ( $f_{\text{MLCK}}$ ) (MHz) |                        |                       |           |                    |                    |
|-----------------------|----------------------------------------------------|------------------------|-----------------------|-----------|--------------------|--------------------|
|                       | 64 $f_s$                                           | 128 $f_s$              | 192 $f_s$             | 256 $f_s$ | 384 $f_s$          | 512 $f_s$          |
| 8 kHz                 | See <sup>(1)</sup>                                 | 1.024 <sup>(2)</sup>   | 1.536 <sup>(2)</sup>  | 2.048     | 3.072              | 4.096              |
| 16 kHz                |                                                    | 2.048 <sup>(2)</sup>   | 3.072 <sup>(2)</sup>  | 4.096     | 6.144              | 8.192              |
| 32 kHz                |                                                    | 4.096 <sup>(2)</sup>   | 6.144 <sup>(2)</sup>  | 8.192     | 12.288             | 16.384             |
| 44.1 kHz              |                                                    | 5.6488 <sup>(2)</sup>  | 8.4672 <sup>(2)</sup> | 11.2896   | 16.9344            | 22.5792            |
| 48 kHz                |                                                    | 6.144 <sup>(2)</sup>   | 9.216 <sup>(2)</sup>  | 12.288    | 18.432             | 24.576             |
| 88.2 kHz              |                                                    | 11.2896 <sup>(2)</sup> | 16.9344               | 22.5792   | 33.8688            | 45.1584            |
| 96 kHz                |                                                    | 12.288 <sup>(2)</sup>  | 18.432                | 24.576    | 36.864             | 49.152             |
| 176.4 kHz             |                                                    | 22.5792                | 33.8688               | 45.1584   | See <sup>(1)</sup> | See <sup>(1)</sup> |
| 192 kHz               |                                                    | 24.576                 | 36.864                | 49.152    |                    |                    |

(1) This system clock rate is not supported for the given sampling frequency.

(2) This system clock rate is supported by PLL mode.

### 8.3.3.4 Clock Slave Mode with SLCK PLL to Generate Internal Clocks (3-Wire PCM)

#### 8.3.3.4.1 Clock Generation using the PLL

The TAS5756M device supports a wide range of options to generate the required clocks as shown in [Figure 61](#).

The clocks for the PLL require a source reference clock. This clock is sourced as the incoming SLCK or MLCK, a GPIO can also be used.

The source reference clock for the PLL reference clock is selected by programming the SRCREF value on P0-R13, B[6:4]. The TAS5756M device provides several programmable clock dividers to achieve a variety of sampling rates. See [Figure 61](#).

If PLL functionality is not required, set the PLLEN value on P0-R4, B[0] to 0. In this situation, an external master clock is required.

**Table 3. PLL Configuration Registers**

| CLOCK MULTIPLEXER |                      |                |
|-------------------|----------------------|----------------|
| REGISTER          | FUNCTION             | BITS           |
| SREF              | PLL Reference        | P0-R13, B[6:4] |
| DDSP              | clock divider        | P0-R27, B[6:0] |
| DSLCK             | External SLCK Div    | P0-R32, B[6:0] |
| DLRK              | External LRCK/FS Div | P0-R33, B[7:0] |

### 8.3.3.4.2 PLL Calculation

The TAS5756M device has an on-chip PLL with fractional multiplication to generate the clock frequency needed by the Digital Signal Processing blocks. The programmability of the PLL allows operation from a wide variety of clocks that may be available in the system. The PLL input (PLLCKIN) supports clock frequencies from 1 MHz to 50 MHz and is register programmable to enable generation of required sampling rates with fine precision.

The PLL is enabled by default. The PLL can be enabled by writing to P0-R4, B[0]. When the PLL is enabled, the PLL output clock PLLCK is given by [Equation 1](#):

$$\text{PLLCK} = \frac{\text{PLLCKIN} \times R \times J.D}{P} \quad \text{or} \quad \text{PLLCK} = \frac{\text{PLLCKIN} \times R \times K}{P}$$

where

- R = 1, 2, 3, 4, ... , 15, 16
  - J = 4, 5, 6, ... 63, and D = 0000, 0001, 0002, ... 9999
  - K = [J value].[D value]
  - P = 1, 2, 3, ... 15
- (1)

R, J, D, and P are programmable. J is the integer portion of K (the numbers to the left of the decimal point), while D is the fractional portion of K (the numbers to the right of the decimal point, assuming four digits of precision).

#### 8.3.3.4.2.1 Examples:

- If K = 8.5, then J = 8, D = 5000
- If K = 7.12, then J = 7, D = 1200
- If K = 14.03, then J = 14, D = 0300
- If K = 6.0004, then J = 6, D = 0004

When the PLL is enabled and D = 0000, **the following conditions must be satisfied:**

- 1 MHz ≤ ( PLLCKIN / P ) ≤ 20 MHz
- 64 MHz ≤ (PLLCKIN x K x R / P ) ≤ 100 MHz
- 1 ≤ J ≤ 63

When the PLL is enabled and D ≠ 0000, **the following conditions must be satisfied:**

- 6.667 MHz ≤ PLLCKIN / P ≤ 20 MHz
- 64 MHz ≤ (PLLCKIN x K x R / P ) ≤ 100 MHz
- 4 ≤ J ≤ 11
- R = 1

When the PLL is enabled,

- $f_s = (\text{PLLCKIN} \times K \times R) / (2048 \times P)$
- The value of N is selected so that  $f_s \times N = \text{PLLCKIN} \times K \times R / P$  is in the allowable range.

**Example:** MCLK = 12 MHz and  $f_s = 44.1$  kHz, (N=2048)

Select P = 1, R = 1, K = 7.5264, which results in J = 7, D = 5264

**Example:** MCLK = 12 MHz and  $f_s = 48.0$  kHz, (N=2048)

Select P = 1, R = 1, K = 8.192, which results in J = 8, D = 1920

Values are written to the registers in [Table 4](#).

**Table 4. PLL Registers**

| DIVIDER | FUNCTION   | BITS           |
|---------|------------|----------------|
| PLLE    | PLL enable | P0-R4, B[0]    |
| PPDV    | PLL P      | P0-R20, B[3:0] |
| PJDV    | PLL J      | P0-R21, B[5:0] |
| PDDV    | PLL D      | P0-R22, B[5:0] |
|         |            | P0-R23, B[7:0] |
| PRDV    | PLL R      | P0-R24, B[3:0] |

**Table 5. PLL Configuration Recommendations**

| EQUATIONS        | DESCRIPTION                                                                                                                                                                                                                                                                                                             |
|------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| $f_s$ (kHz)      | Sampling frequency                                                                                                                                                                                                                                                                                                      |
| $R_{MLCK}$       | Ratio between sampling frequency and MLCK frequency (MLCK frequency = $R_{MLCK} \times$ sampling frequency)                                                                                                                                                                                                             |
| MLCK (MHz)       | System master clock frequency at MLCK input (pin 20)                                                                                                                                                                                                                                                                    |
| PLL VCO (MHz)    | PLL VCO frequency as PLLCK in <a href="#">Figure 61</a>                                                                                                                                                                                                                                                                 |
| P                | One of the PLL coefficients in <a href="#">Equation 1</a>                                                                                                                                                                                                                                                               |
| PLL REF (MHz)    | Internal reference clock frequency which is produced by $MLCK / P$                                                                                                                                                                                                                                                      |
| $M = K \times R$ | The final PLL multiplication factor computed from K and R as described in <a href="#">Equation 1</a>                                                                                                                                                                                                                    |
| $K = J.D$        | One of the PLL coefficients in <a href="#">Equation 1</a>                                                                                                                                                                                                                                                               |
| R                | One of the PLL coefficients in <a href="#">Equation 1</a>                                                                                                                                                                                                                                                               |
| PLL $f_s$        | Ratio between $f_s$ and PLL VCO frequency ( $PLL\ VCO / f_s$ )                                                                                                                                                                                                                                                          |
| DSP $f_s$        | Ratio between operating clock rate and $f_s$ ( $PLL\ f_s / NMAC$ )                                                                                                                                                                                                                                                      |
| NMAC             | The clock divider value in <a href="#">Table 3</a>                                                                                                                                                                                                                                                                      |
| DSP CLK (MHz)    | The operating frequency as DSPCK in <a href="#">Figure 61</a>                                                                                                                                                                                                                                                           |
| MOD $f_s$        | Ratio between DAC operating clock frequency and $f_s$ ( $PLL\ f_s / NDAC$ )                                                                                                                                                                                                                                             |
| MOD f (kHz)      | DAC operating frequency as DACCK in                                                                                                                                                                                                                                                                                     |
| NDAC             | DAC clock divider value in <a href="#">Table 3</a>                                                                                                                                                                                                                                                                      |
| DOSR             | OSR clock divider value in <a href="#">Table 3</a> for generating OSRCK in <a href="#">Figure 61</a> . DOSR must be chosen so that $MOD\ f_s / DOSR = 16$ for correct operation.                                                                                                                                        |
| NCP              | NCP (negative charge pump) clock divider value in <a href="#">Table 3</a>                                                                                                                                                                                                                                               |
| CP f             | Negative charge pump clock frequency ( $f_s \times MOD\ f_s / NCP$ )                                                                                                                                                                                                                                                    |
| % Error          | Percentage of error between PLL VCO / PLL $f_s$ and $f_s$ (mismatch error). <ul style="list-style-type: none"> <li>This value is typically zero but can be non-zero especially when K is not an integer (D is not zero).</li> <li>This value may be non-zero only when the TAS5756M device acts as a master.</li> </ul> |

The previous equations explain how to calculate all necessary coefficients and controls to configure the PLL. [Table 6](#) provides for easy reference to the recommended clock divider settings for the PLL as a Master Clock.

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**Table 6. Recommended Clock Divider Settings for PLL as Master Clock**

| $f_s$<br>(kHz) | $R_{MCLK}$ | MCLK<br>(MHz) | PLL VCO<br>(MHz) | P | PLL REF<br>(MHz) | M = K×R | K = J×D | R | PLL $f_s$ | DSP $f_s$ | NMAC | DSP CLK<br>(MHz) | MOD $f_s$ | MOD f<br>(kHz) | NDAC | DOSR | % ERROR | NCP | CP f<br>(kHz) |
|----------------|------------|---------------|------------------|---|------------------|---------|---------|---|-----------|-----------|------|------------------|-----------|----------------|------|------|---------|-----|---------------|
| 8              | 128        | 1.024         | 98.304           | 1 | 1.024            | 96      | 48      | 2 | 12288     | 1024      | 12   | 8.192            | 768       | 6144           | 16   | 48   | 0       | 4   | 1536          |
|                | 192        | 1.536         | 98.304           | 1 | 1.536            | 64      | 32      | 2 | 12288     | 1024      | 12   | 8.192            | 768       | 6144           | 16   | 48   | 0       | 4   | 1536          |
|                | 256        | 2.048         | 98.304           | 1 | 2.048            | 48      | 48      | 1 | 12288     | 1024      | 12   | 8.192            | 768       | 6144           | 16   | 48   | 0       | 4   | 1536          |
|                | 384        | 3.072         | 98.304           | 3 | 1.024            | 96      | 48      | 2 | 12288     | 1024      | 12   | 8.192            | 768       | 6144           | 16   | 48   | 0       | 4   | 1536          |
|                | 512        | 4.096         | 98.304           | 3 | 1.365            | 72      | 36      | 2 | 12288     | 1024      | 12   | 8.192            | 768       | 6144           | 16   | 48   | 0       | 4   | 1536          |
|                | 768        | 6.144         | 98.304           | 3 | 2.048            | 48      | 48      | 1 | 12288     | 1024      | 12   | 8.192            | 768       | 6144           | 16   | 48   | 0       | 4   | 1536          |
|                | 1024       | 8.192         | 98.304           | 3 | 2.731            | 36      | 36      | 1 | 12288     | 1024      | 12   | 8.192            | 768       | 6144           | 16   | 48   | 0       | 4   | 1536          |
|                | 1152       | 9.216         | 98.304           | 9 | 1.024            | 96      | 48      | 2 | 12288     | 1024      | 12   | 8.192            | 768       | 6144           | 16   | 48   | 0       | 4   | 1536          |
|                | 1536       | 12.288        | 98.304           | 9 | 1.365            | 72      | 36      | 2 | 12288     | 1024      | 12   | 8.192            | 768       | 6144           | 16   | 48   | 0       | 4   | 1536          |
|                | 2048       | 16.384        | 98.304           | 9 | 1.82             | 54      | 54      | 1 | 12288     | 1024      | 12   | 8.192            | 768       | 6144           | 16   | 48   | 0       | 4   | 1536          |
| 11.025         | 3072       | 24.576        | 98.304           | 9 | 2.731            | 36      | 36      | 1 | 12288     | 1024      | 12   | 8.192            | 768       | 6144           | 16   | 48   | 0       | 4   | 1536          |
|                | 128        | 1.4112        | 90.3168          | 1 | 1.411            | 64      | 32      | 2 | 8192      | 1024      | 8    | 11.2896          | 512       | 5644.8         | 16   | 32   | 0       | 4   | 1411.2        |
|                | 192        | 2.1168        | 90.3168          | 3 | 0.706            | 128     | 32      | 4 | 8192      | 1024      | 8    | 11.2896          | 512       | 5644.8         | 16   | 32   | 0       | 4   | 1411.2        |
|                | 256        | 2.8224        | 90.3168          | 1 | 2.822            | 32      | 32      | 1 | 8192      | 1024      | 8    | 11.2896          | 512       | 5644.8         | 16   | 32   | 0       | 4   | 1411.2        |
|                | 384        | 4.2336        | 90.3168          | 3 | 1.411            | 64      | 32      | 2 | 8192      | 1024      | 8    | 11.2896          | 512       | 5644.8         | 16   | 32   | 0       | 4   | 1411.2        |
|                | 512        | 5.6448        | 90.3168          | 3 | 1.882            | 48      | 48      | 1 | 8192      | 1024      | 8    | 11.2896          | 512       | 5644.8         | 16   | 32   | 0       | 4   | 1411.2        |
|                | 768        | 8.4672        | 90.3168          | 3 | 2.822            | 32      | 32      | 1 | 8192      | 1024      | 8    | 11.2896          | 512       | 5644.8         | 16   | 32   | 0       | 4   | 1411.2        |
|                | 1024       | 11.2896       | 90.3168          | 3 | 3.763            | 24      | 24      | 1 | 8192      | 1024      | 8    | 11.2896          | 512       | 5644.8         | 16   | 32   | 0       | 4   | 1411.2        |
|                | 1152       | 12.7008       | 90.3168          | 9 | 1.411            | 64      | 32      | 2 | 8192      | 1024      | 8    | 11.2896          | 512       | 5644.8         | 16   | 32   | 0       | 4   | 1411.2        |
|                | 1536       | 16.9344       | 90.3168          | 9 | 1.882            | 48      | 48      | 1 | 8192      | 1024      | 8    | 11.2896          | 512       | 5644.8         | 16   | 32   | 0       | 4   | 1411.2        |
| 16             | 2048       | 22.5792       | 90.3168          | 9 | 2.509            | 36      | 36      | 1 | 8192      | 1024      | 8    | 11.2896          | 512       | 5644.8         | 16   | 32   | 0       | 4   | 1411.2        |
|                | 3072       | 33.8688       | 90.3168          | 9 | 3.763            | 24      | 24      | 1 | 8192      | 1024      | 8    | 11.2896          | 512       | 5644.8         | 16   | 32   | 0       | 4   | 1411.2        |
|                | 64         | 1.024         | 98.304           | 1 | 1.024            | 96      | 48      | 2 | 6144      | 1024      | 6    | 16.384           | 384       | 6144           | 16   | 24   | 0       | 4   | 1536          |
|                | 128        | 2.048         | 98.304           | 1 | 2.048            | 48      | 48      | 1 | 6144      | 1024      | 6    | 16.384           | 384       | 6144           | 16   | 24   | 0       | 4   | 1536          |
|                | 192        | 3.072         | 98.304           | 1 | 3.072            | 32      | 32      | 1 | 6144      | 1024      | 6    | 16.384           | 384       | 6144           | 16   | 24   | 0       | 4   | 1536          |
|                | 256        | 4.096         | 98.304           | 1 | 4.096            | 24      | 24      | 1 | 6144      | 1024      | 6    | 16.384           | 384       | 6144           | 16   | 24   | 0       | 4   | 1536          |
|                | 384        | 6.144         | 98.304           | 3 | 2.048            | 48      | 48      | 1 | 6144      | 1024      | 6    | 16.384           | 384       | 6144           | 16   | 24   | 0       | 4   | 1536          |
|                | 512        | 8.192         | 98.304           | 3 | 2.731            | 36      | 36      | 1 | 6144      | 1024      | 6    | 16.384           | 384       | 6144           | 16   | 24   | 0       | 4   | 1536          |
|                | 768        | 12.288        | 98.304           | 3 | 4.096            | 24      | 24      | 1 | 6144      | 1024      | 6    | 16.384           | 384       | 6144           | 16   | 24   | 0       | 4   | 1536          |
|                | 1024       | 16.384        | 98.304           | 3 | 5.461            | 18      | 18      | 1 | 6144      | 1024      | 6    | 16.384           | 384       | 6144           | 16   | 24   | 0       | 4   | 1536          |
|                | 1152       | 18.432        | 98.304           | 3 | 6.144            | 16      | 16      | 1 | 6144      | 1024      | 6    | 16.384           | 384       | 6144           | 16   | 24   | 0       | 4   | 1536          |
|                | 1536       | 24.576        | 98.304           | 9 | 2.731            | 36      | 36      | 1 | 6144      | 1024      | 6    | 16.384           | 384       | 6144           | 16   | 24   | 0       | 4   | 1536          |
|                | 2048       | 32.768        | 98.304           | 9 | 3.641            | 27      | 27      | 1 | 6144      | 1024      | 6    | 16.384           | 384       | 6144           | 16   | 24   | 0       | 4   | 1536          |
|                | 3072       | 49.152        | 98.304           | 9 | 5.461            | 18      | 18      | 1 | 6144      | 1024      | 6    | 16.384           | 384       | 6144           | 16   | 24   | 0       | 4   | 1536          |

**Table 6. Recommended Clock Divider Settings for PLL as Master Clock (continued)**

| $f_s$<br>(kHz) | $R_{MCLK}$ | MCLK<br>(MHz) | PLL VCO<br>(MHz) | P | PLL REF<br>(MHz) | $M = K \times R$ | $K = J \times D$ | R | PLL $f_s$ | DSP $f_s$ | NMAC | DSP CLK<br>(MHz) | MOD $f_s$ | MOD $f$<br>(kHz) | NDAC | DOSR | % ERROR | NCP | CP $f$<br>(kHz) |
|----------------|------------|---------------|------------------|---|------------------|------------------|------------------|---|-----------|-----------|------|------------------|-----------|------------------|------|------|---------|-----|-----------------|
| 22.05          | 64         | 1.4112        | 90.3168          | 1 | 1.411            | 64               | 32               | 2 | 4096      | 1024      | 4    | 22.5792          | 256       | 5644.8           | 16   | 16   | 0       | 4   | 1411.2          |
|                | 128        | 2.8224        | 90.3168          | 1 | 2.822            | 32               | 32               | 1 | 4096      | 1024      | 4    | 22.5792          | 256       | 5644.8           | 16   | 16   | 0       | 4   | 1411.2          |
|                | 192        | 4.2336        | 90.3168          | 3 | 1.411            | 64               | 32               | 2 | 4096      | 1024      | 4    | 22.5792          | 256       | 5644.8           | 16   | 16   | 0       | 4   | 1411.2          |
|                | 256        | 5.6448        | 90.3168          | 1 | 5.645            | 16               | 16               | 1 | 4096      | 1024      | 4    | 22.5792          | 256       | 5644.8           | 16   | 16   | 0       | 4   | 1411.2          |
|                | 384        | 8.4672        | 90.3168          | 3 | 2.822            | 32               | 32               | 1 | 4096      | 1024      | 4    | 22.5792          | 256       | 5644.8           | 16   | 16   | 0       | 4   | 1411.2          |
|                | 512        | 11.2896       | 90.3168          | 3 | 3.763            | 24               | 24               | 1 | 4096      | 1024      | 4    | 22.5792          | 256       | 5644.8           | 16   | 16   | 0       | 4   | 1411.2          |
|                | 768        | 16.9344       | 90.3168          | 3 | 5.645            | 16               | 16               | 1 | 4096      | 1024      | 4    | 22.5792          | 256       | 5644.8           | 16   | 16   | 0       | 4   | 1411.2          |
|                | 1024       | 22.5792       | 90.3168          | 3 | 7.526            | 12               | 12               | 1 | 4096      | 1024      | 4    | 22.5792          | 256       | 5644.8           | 16   | 16   | 0       | 4   | 1411.2          |
|                | 1152       | 25.4016       | 90.3168          | 9 | 2.822            | 32               | 32               | 1 | 4096      | 1024      | 4    | 22.5792          | 256       | 5644.8           | 16   | 16   | 0       | 4   | 1411.2          |
|                | 1536       | 33.8688       | 90.3168          | 9 | 3.763            | 24               | 24               | 1 | 4096      | 1024      | 4    | 22.5792          | 256       | 5644.8           | 16   | 16   | 0       | 4   | 1411.2          |
| 32             | 2048       | 45.1584       | 90.3168          | 9 | 5.018            | 18               | 18               | 1 | 4096      | 1024      | 4    | 22.5792          | 256       | 5644.8           | 16   | 16   | 0       | 4   | 1411.2          |
|                | 32         | 1.024         | 98.304           | 1 | 1.024            | 96               | 48               | 2 | 3072      | 1024      | 3    | 32.768           | 192       | 6144             | 16   | 12   | 0       | 4   | 1536            |
|                | 48         | 1.536         | 98.304           | 1 | 1.536            | 64               | 16               | 4 | 3072      | 1024      | 3    | 32.768           | 192       | 6144             | 16   | 12   | 0       | 4   | 1536            |
|                | 64         | 2.048         | 98.304           | 1 | 2.048            | 48               | 24               | 2 | 3072      | 1024      | 3    | 32.768           | 192       | 6144             | 16   | 12   | 0       | 4   | 1536            |
|                | 128        | 4.096         | 98.304           | 1 | 4.096            | 24               | 24               | 1 | 3072      | 1024      | 3    | 32.768           | 192       | 6144             | 16   | 12   | 0       | 4   | 1536            |
|                | 192        | 6.144         | 98.304           | 3 | 2.048            | 48               | 48               | 1 | 3072      | 1024      | 3    | 32.768           | 192       | 6144             | 16   | 12   | 0       | 4   | 1536            |
|                | 256        | 8.192         | 98.304           | 2 | 4.096            | 24               | 24               | 1 | 3072      | 1024      | 3    | 32.768           | 192       | 6144             | 16   | 12   | 0       | 4   | 1536            |
|                | 384        | 12.288        | 98.304           | 3 | 4.096            | 24               | 24               | 1 | 3072      | 1024      | 3    | 32.768           | 192       | 6144             | 16   | 12   | 0       | 4   | 1536            |
|                | 512        | 16.384        | 98.304           | 3 | 5.461            | 18               | 18               | 1 | 3072      | 1024      | 3    | 32.768           | 192       | 6144             | 16   | 12   | 0       | 4   | 1536            |
|                | 768        | 24.576        | 98.304           | 3 | 8.192            | 12               | 12               | 1 | 3072      | 1024      | 3    | 32.768           | 192       | 6144             | 16   | 12   | 0       | 4   | 1536            |
|                | 1024       | 32.768        | 98.304           | 3 | 10.923           | 9                | 9                | 1 | 3072      | 1024      | 3    | 32.768           | 192       | 6144             | 16   | 12   | 0       | 4   | 1536            |
|                | 1152       | 36.864        | 98.304           | 9 | 4.096            | 24               | 24               | 1 | 3072      | 1024      | 3    | 32.768           | 192       | 6144             | 16   | 12   | 0       | 4   | 1536            |
|                | 1536       | 49.152        | 98.304           | 6 | 8.192            | 12               | 12               | 1 | 3072      | 1024      | 3    | 32.768           | 192       | 6144             | 16   | 12   | 0       | 4   | 1536            |
| 44.1           | 32         | 1.4112        | 90.3168          | 1 | 1.411            | 64               | 32               | 2 | 2048      | 1024      | 2    | 45.1584          | 128       | 5644.8           | 16   | 8    | 0       | 4   | 1411.2          |
|                | 64         | 2.8224        | 90.3168          | 1 | 2.822            | 32               | 16               | 2 | 2048      | 1024      | 2    | 45.1584          | 128       | 5644.8           | 16   | 8    | 0       | 4   | 1411.2          |
|                | 128        | 5.6448        | 90.3168          | 1 | 5.645            | 16               | 16               | 1 | 2048      | 1024      | 2    | 45.1584          | 128       | 5644.8           | 16   | 8    | 0       | 4   | 1411.2          |
|                | 192        | 8.4672        | 90.3168          | 3 | 2.822            | 32               | 32               | 1 | 2048      | 1024      | 2    | 45.1584          | 128       | 5644.8           | 16   | 8    | 0       | 4   | 1411.2          |
|                | 256        | 11.2896       | 90.3168          | 2 | 5.645            | 16               | 16               | 1 | 2048      | 1024      | 2    | 45.1584          | 128       | 5644.8           | 16   | 8    | 0       | 4   | 1411.2          |
|                | 384        | 16.9344       | 90.3168          | 3 | 5.645            | 16               | 16               | 1 | 2048      | 1024      | 2    | 45.1584          | 128       | 5644.8           | 16   | 8    | 0       | 4   | 1411.2          |
|                | 512        | 22.5792       | 90.3168          | 3 | 7.526            | 12               | 12               | 1 | 2048      | 1024      | 2    | 45.1584          | 128       | 5644.8           | 16   | 8    | 0       | 4   | 1411.2          |
|                | 768        | 33.8688       | 90.3168          | 3 | 11.29            | 8                | 8                | 1 | 2048      | 1024      | 2    | 45.1584          | 128       | 5644.8           | 16   | 8    | 0       | 4   | 1411.2          |
|                | 1024       | 45.1584       | 90.3168          | 3 | 15.053           | 6                | 6                | 1 | 2048      | 1024      | 2    | 45.1584          | 128       | 5644.8           | 16   | 8    | 0       | 4   | 1411.2          |

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**Table 6. Recommended Clock Divider Settings for PLL as Master Clock (continued)**

| $f_s$<br>(kHz) | $R_{MCLK}$ | MCLK<br>(MHz) | PLL VCO<br>(MHz) | P | PLL REF<br>(MHz) | $M = K \times R$ | $K = J \times D$ | R | PLL $f_s$ | DSP $f_s$ | NMAC | DSP CLK<br>(MHz) | MOD $f_s$ | MOD $f$<br>(kHz) | NDAC | DOSR | % ERROR | NCP | CP $f$<br>(kHz) |
|----------------|------------|---------------|------------------|---|------------------|------------------|------------------|---|-----------|-----------|------|------------------|-----------|------------------|------|------|---------|-----|-----------------|
| 48             | 32         | 1.536         | 98.304           | 1 | 1.536            | 64               | 32               | 2 | 2048      | 1024      | 2    | 49.152           | 128       | 6144             | 16   | 8    | 0       | 4   | 1536            |
|                | 64         | 3.072         | 98.304           | 1 | 3.072            | 32               | 16               | 2 | 2048      | 1024      | 2    | 49.152           | 128       | 6144             | 16   | 8    | 0       | 4   | 1536            |
|                | 128        | 6.144         | 98.304           | 1 | 6.144            | 16               | 16               | 1 | 2048      | 1024      | 2    | 49.152           | 128       | 6144             | 16   | 8    | 0       | 4   | 1536            |
|                | 192        | 9.216         | 98.304           | 3 | 3.072            | 32               | 32               | 1 | 2048      | 1024      | 2    | 49.152           | 128       | 6144             | 16   | 8    | 0       | 4   | 1536            |
|                | 256        | 12.288        | 98.304           | 2 | 6.144            | 16               | 16               | 1 | 2048      | 1024      | 2    | 49.152           | 128       | 6144             | 16   | 8    | 0       | 4   | 1536            |
|                | 384        | 18.432        | 98.304           | 3 | 6.144            | 16               | 16               | 1 | 2048      | 1024      | 2    | 49.152           | 128       | 6144             | 16   | 8    | 0       | 4   | 1536            |
|                | 512        | 24.576        | 98.304           | 3 | 8.192            | 12               | 12               | 1 | 2048      | 1024      | 2    | 49.152           | 128       | 6144             | 16   | 8    | 0       | 4   | 1536            |
|                | 768        | 36.864        | 98.304           | 3 | 12.288           | 8                | 8                | 1 | 2048      | 1024      | 2    | 49.152           | 128       | 6144             | 16   | 8    | 0       | 4   | 1536            |
| 96             | 1024       | 49.152        | 98.304           | 3 | 16.384           | 6                | 6                | 1 | 2048      | 1024      | 2    | 49.152           | 128       | 6144             | 16   | 8    | 0       | 4   | 1536            |
|                | 32         | 3.072         | 98.304           | 1 | 3.072            | 32               | 16               | 2 | 1024      | 512       | 2    | 49.152           | 64        | 6144             | 16   | 4    | 0       | 4   | 1536            |
|                | 48         | 4.608         | 98.304           | 3 | 1.536            | 64               | 32               | 2 | 1024      | 512       | 2    | 49.152           | 64        | 6144             | 16   | 4    | 0       | 4   | 1536            |
|                | 64         | 6.144         | 98.304           | 1 | 6.144            | 16               | 8                | 2 | 1024      | 512       | 2    | 49.152           | 64        | 6144             | 16   | 4    | 0       | 4   | 1536            |
|                | 128        | 12.288        | 98.304           | 2 | 6.144            | 16               | 16               | 1 | 1024      | 512       | 2    | 49.152           | 64        | 6144             | 16   | 4    | 0       | 4   | 1536            |
|                | 192        | 18.432        | 98.304           | 3 | 6.144            | 16               | 16               | 1 | 1024      | 512       | 2    | 49.152           | 64        | 6144             | 16   | 4    | 0       | 4   | 1536            |
|                | 256        | 24.576        | 98.304           | 4 | 6.144            | 16               | 16               | 1 | 1024      | 512       | 2    | 49.152           | 64        | 6144             | 16   | 4    | 0       | 4   | 1536            |
|                | 384        | 36.864        | 98.304           | 6 | 6.144            | 16               | 16               | 1 | 1024      | 512       | 2    | 49.152           | 64        | 6144             | 16   | 4    | 0       | 4   | 1536            |
| 192            | 512        | 49.152        | 98.304           | 8 | 6.144            | 16               | 16               | 1 | 1024      | 512       | 2    | 49.152           | 64        | 6144             | 16   | 4    | 0       | 4   | 1536            |
|                | 32         | 6.144         | 98.304           | 1 | 6.144            | 16               | 8                | 2 | 512       | 256       | 2    | 49.152           | 32        | 6144             | 16   | 2    | 0       | 4   | 1536            |
|                | 48         | 9.216         | 98.304           | 3 | 3.072            | 32               | 16               | 2 | 512       | 256       | 2    | 49.152           | 32        | 6144             | 16   | 2    | 0       | 4   | 1536            |
|                | 64         | 12.288        | 98.304           | 1 | 12.288           | 8                | 4                | 2 | 512       | 256       | 2    | 49.152           | 32        | 6144             | 16   | 2    | 0       | 4   | 1536            |
|                | 128        | 24.576        | 98.304           | 2 | 12.288           | 8                | 8                | 1 | 512       | 256       | 2    | 49.152           | 32        | 6144             | 16   | 2    | 0       | 4   | 1536            |
|                | 192        | 36.864        | 98.304           | 3 | 12.288           | 8                | 8                | 1 | 512       | 256       | 2    | 49.152           | 32        | 6144             | 16   | 2    | 0       | 4   | 1536            |

### 8.3.3.5 Serial Audio Port – Data Formats and Bit Depths

The serial audio interface port is a 3-wire serial port with the signals LRCK/FS (pin 25), SCLK (pin 23), and SDIN (pin 24). SCLK is the serial audio bit clock, used to clock the serial data present on SDIN into the serial shift register of the audio interface. Serial data is clocked into the TAS5756M device on the rising edge of SCLK. The LRCK/FS pin is the serial audio left/right word clock or frame sync when the device is operated in TDM Mode.

**Table 7. TAS5756M device Audio Data Formats, Bit Depths and Clock Rates**

| FORMAT                 | DATA BITS      | MAXIMUM LRCK/FS FREQUENCY (kHz) | MCLK RATE (f <sub>s</sub> ) | SCLK RATE (f <sub>s</sub> ) |
|------------------------|----------------|---------------------------------|-----------------------------|-----------------------------|
| I <sup>2</sup> S/LJ/RJ | 32, 24, 20, 16 | Up to 192                       | 128 to 3072 (≤ 50 MHz)      | 64, 48, 32                  |
| TDM/DSP                | 32, 24, 20, 16 | Up to 48                        | 128 to 3072                 | 125, 256                    |
|                        |                | 96                              | 128 to 512                  | 125, 256                    |
|                        |                | 192                             | 128, 192, 256               | 128                         |

The TAS5756M device requires the synchronization of LRCK/FS and system clock, but does not need a specific phase relation between LRCK/FS and system clock.

If the relationship between LRCK/FS and system clock changes more than ±5 MCLK, internal operation is initialized within one sample period and analog outputs are forced to the bipolar zero level until re-synchronization between LRCK/FS and system clock is completed.

If the relationship between LRCK/FS and SCLK are invalid more than 4 LRCK/FS periods, internal operation is initialized within one sample period and analog outputs are forced to the bipolar zero level until re-synchronization between LRCK/FS and SCLK is completed.

#### 8.3.3.5.1 Data Formats and Master/Slave Modes of Operation

The TAS5756M device supports industry-standard audio data formats, including standard I<sup>2</sup>S and left-justified. Data formats are selected via Register (P0-R40). All formats require binary two's complement, MSB-first audio data; up to 32-bit audio data is accepted. The data formats are detailed in [Figure 64](#) through [Figure 69](#).

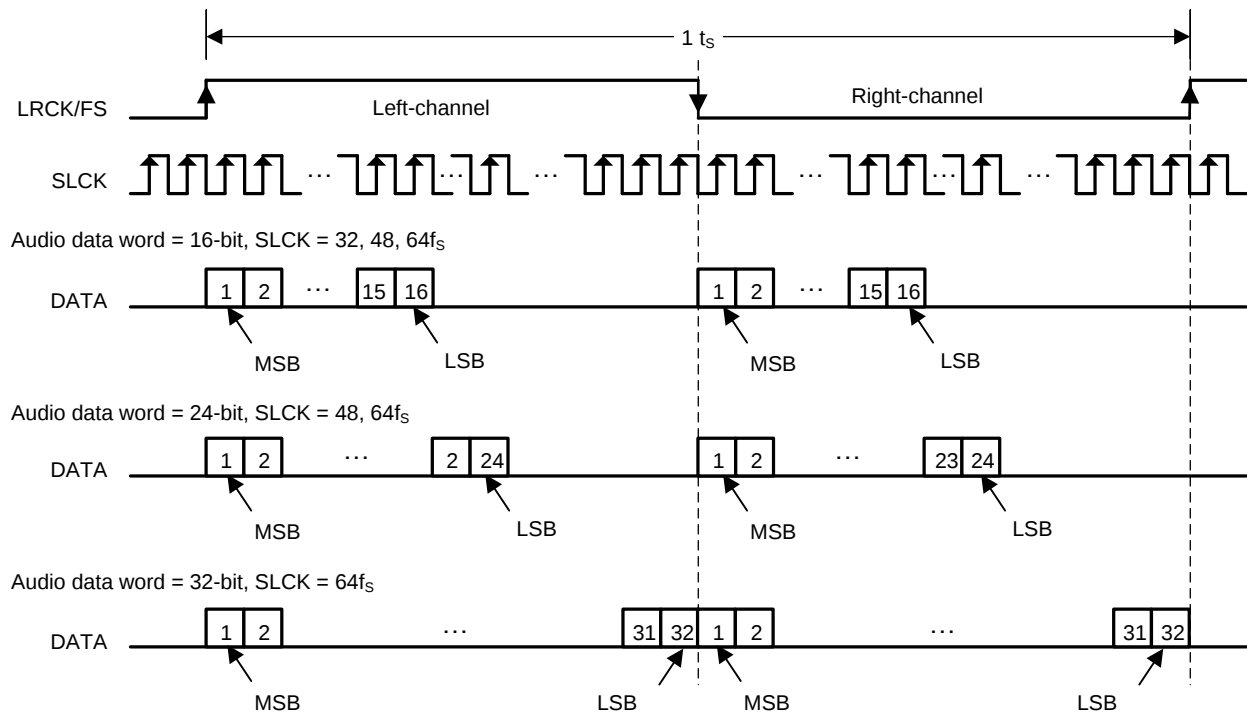
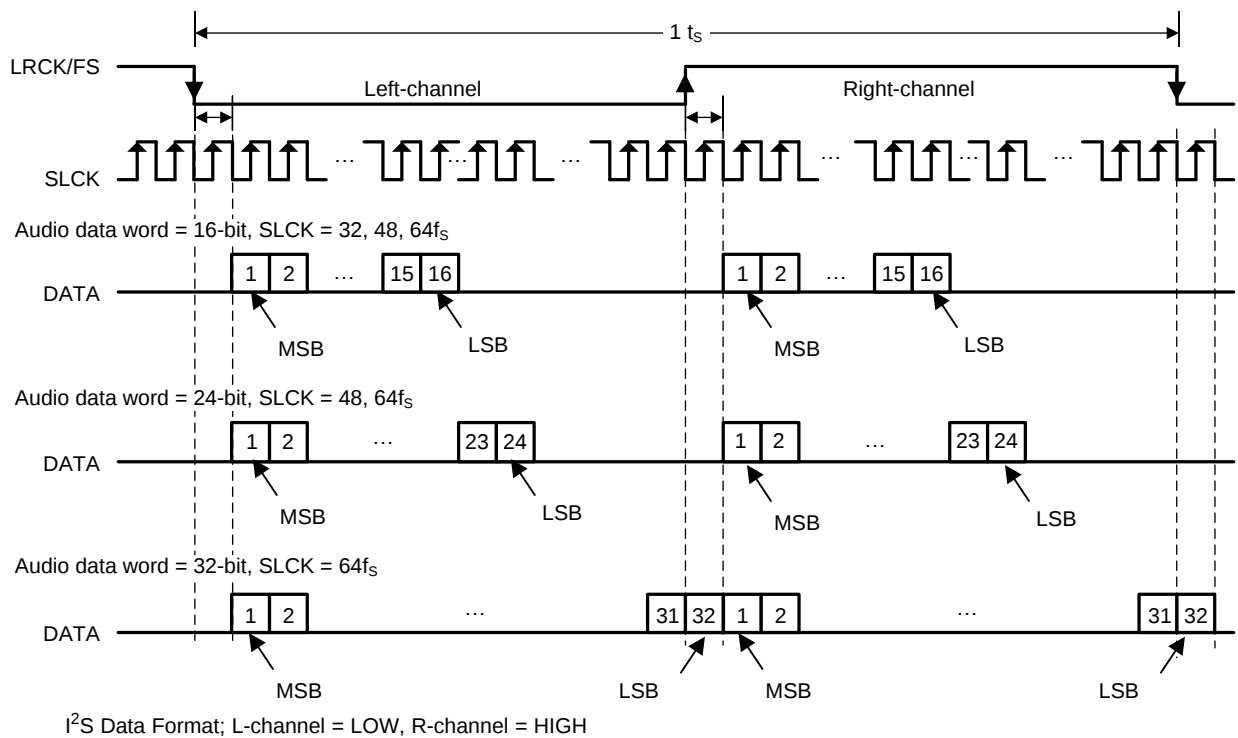
The TAS5756M device also supports right-justified and TDM/DSP data. I<sup>2</sup>S, LJ, RJ, and TDM/DSP are selected using Register (P0-R40). All formats require binary 2s complement, MSB-first audio data. Up to 32 bits are accepted. Default setting is I<sup>2</sup>S and 24 bit word length. The I<sup>2</sup>S slave timing is shown in .

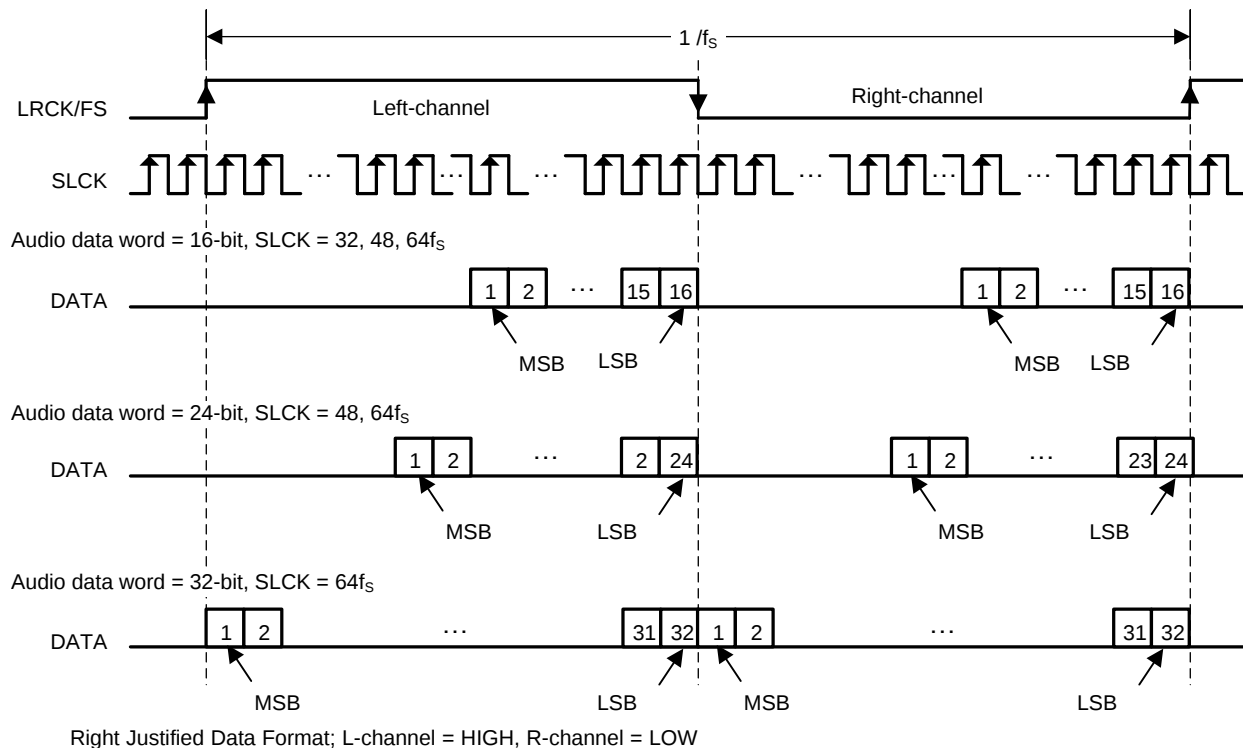
shows a detailed timing diagram for the serial audio interface.

In addition to acting as a I<sup>2</sup>S slave, the TAS5756M device can act as an I<sup>2</sup>S master, by generating SCLK and LRCK/FS as outputs from the MCLK input. [Table 8](#) lists the registers used to place the device into Master or Slave mode. Please refer to the [Serial Audio Port Timing – Master Mode](#) section for serial audio Interface timing requirements in Master Mode. For Slave Mode timing, please refer to to the [Serial Audio Port Timing – Slave Mode](#) section.

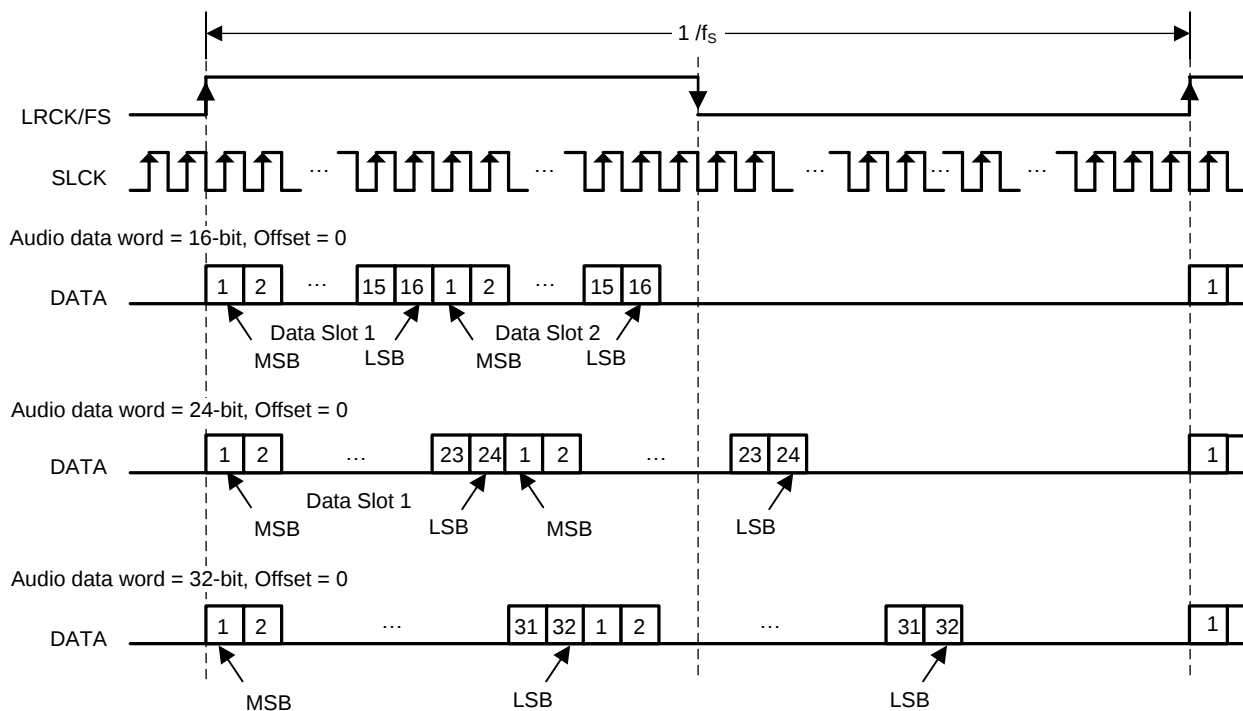
**Table 8. I<sup>2</sup>S Master Mode Registers**

| REGISTER             | FUNCTION                            |
|----------------------|-------------------------------------|
| P0-R9-B0, B4, and B5 | I <sup>2</sup> S Master mode select |
| P0-R32-B[6:0]        | SCLK divider and LRCK/FS divider    |
| P0-R33-B[7:0]        |                                     |


**Figure 64. Left Justified Audio Data Format**

**Figure 65. I<sup>2</sup>S Audio Data Format**



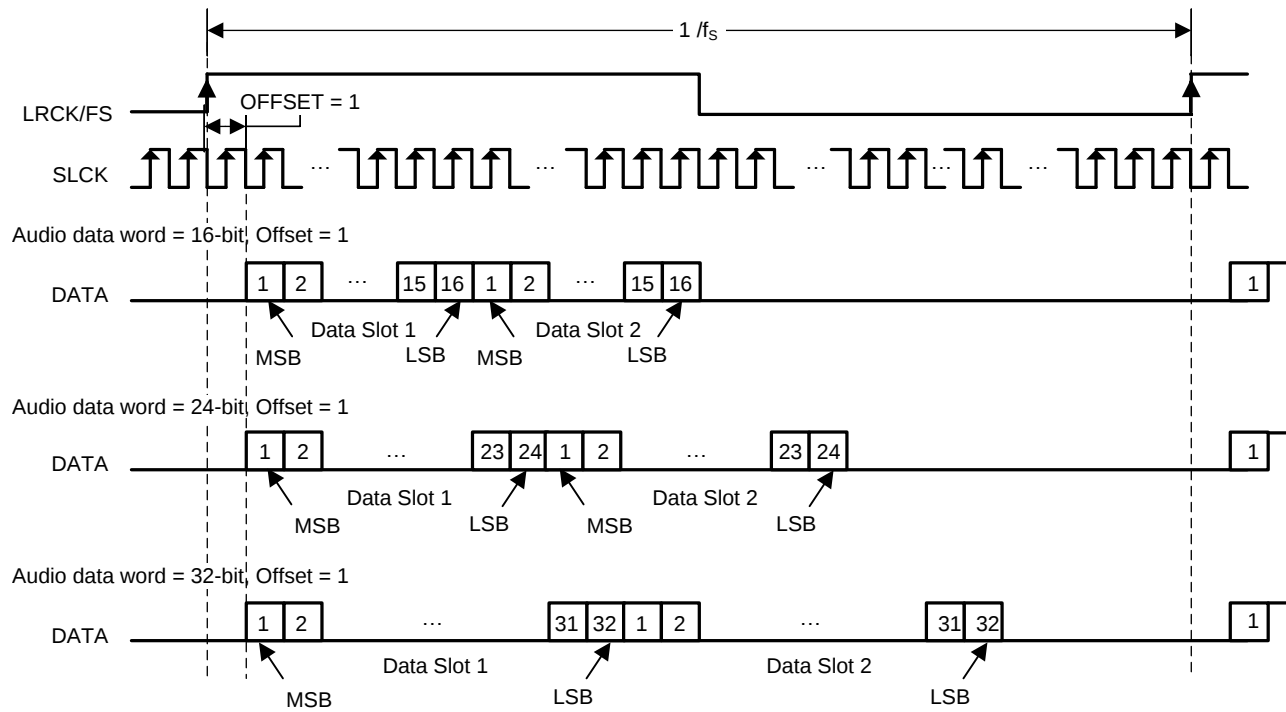
**Figure 66. Right Justified Audio Data Format**



TDM/DSP Data Format with OFFSET = 0

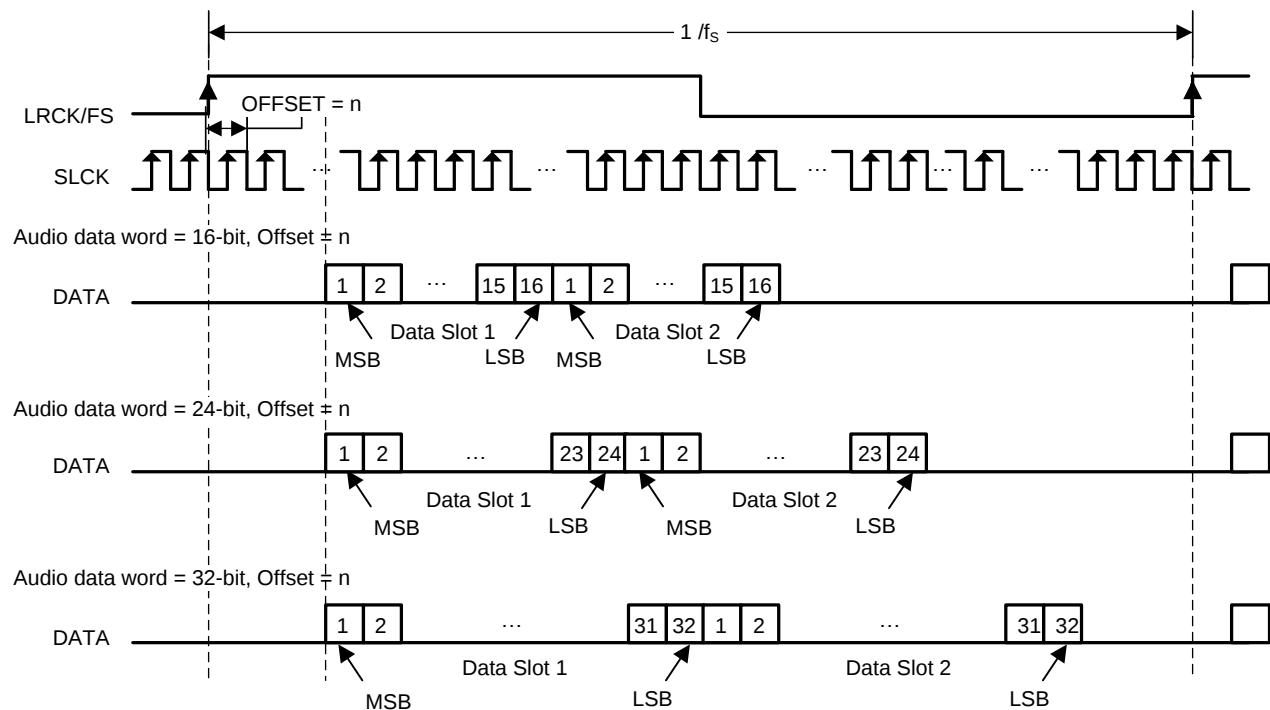
In TDM Modes, Duty Cycle of LRCK/FS should be 1x SCLK at minimum. Rising edge is considered frame start.

**Figure 67. TDM/DSP 1 Audio Data Format**



TDM/DSP Data Format with OFFSET = 1

In TDM Modes, Duty Cycle of LRCK/FS should be 1x SCLK at minimum. Rising edge is considered frame start.

**Figure 68. TDM/DSP 2 Audio Data Format**


TDM/DSP Data Format with OFFSET = N

In TDM Modes, Duty Cycle of LRCK/FS should be 1x SCLK at minimum. Rising edge is considered frame start.

**Figure 69. TDM/DSP 3 Audio Data Format**

### 8.3.3.6 Input Signal Sensing (Power-Save Mode)

The TAS5756M device has a zero-detect function. This function can be applied to both channels of data as an AND function or an OR function, via controls provided in the control port in P0-R65-B[2:1]. Continuous Zero data cycles are counted by LRCK/FS, and the threshold of decision for analog mute can be set by P0-R59, B[6:4] for the data which is clocked in on the left frame of an I<sup>2</sup>S signal or Slot 1 of a TDM signal and P0-R59, B[2:0] for the data which is clocked in on the right frame of an I<sup>2</sup>S signal or Slot 2 of a TDM signal as shown in [Table 10](#). Default values are 0 for both channels.

**Table 9. Zero Detection Mode**

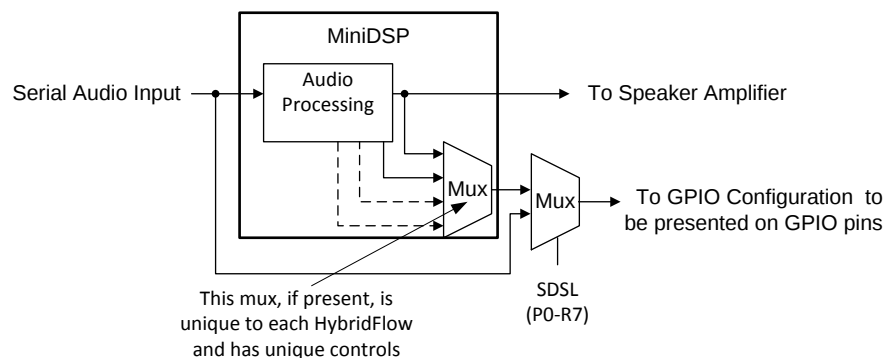
| ATMUTECTL | VALUE       | FUNCTION                                                                                                                                        |
|-----------|-------------|-------------------------------------------------------------------------------------------------------------------------------------------------|
| Bit : 2   | 0           | Zero data triggers for the two channels for zero detection are ORed together.                                                                   |
|           | 1 (Default) | Zero data triggers for the two channels for zero detection are ANDed together.                                                                  |
| Bit : 1   | 0           | Zero detection and analog mute are disabled for the data clocked in on the right frame of an I <sup>2</sup> S signal or Slot 2 of a TDM signal. |
|           | 1 (Default) | Zero detection analog mute are enabled for the data clocked in on the right frame of an I <sup>2</sup> S signal or Slot 2 of a TDM signal.      |
| Bit : 0   | 0           | Zero detection analog mute are disabled for the data clocked in on the left frame of an I <sup>2</sup> S signal or Slot 1 of a TDM signal.      |
|           | 1 (Default) | Zero detection analog mute are enabled for the data clocked in on the left frame of an I <sup>2</sup> S signal or Slot 1 of a TDM signal.       |

**Table 10. Zero Data Detection Time**

| ATMUTETIML OR ATMA | NUMBER OF LRCK/FS CYCLES | TIME at 48 kHz |
|--------------------|--------------------------|----------------|
| 0 0 0              | 1024                     | 21 ms          |
| 0 0 1              | 5120                     | 106 ms         |
| 0 1 0              | 10240                    | 213 ms         |
| 0 1 1              | 25600                    | 533 ms         |
| 1 0 0              | 51200                    | 1.066 secs     |
| 1 0 1              | 102400                   | 2.133 secs     |
| 1 1 0              | 256000                   | 5.333 secs     |
| 1 1 1              | 512000                   | 10.66 secs     |

### 8.3.3.7 Serial Data Output

If it is supported by the HybridFlow in use, the TAS5756M device can present serial data on one of the three available hardware pins, GPIO0, GPIO1, or GPIO2. In a HybridFlow which supports serial data out, the serial data out origin can always be configured to come before the mini-DSP, by clearing the SDSL bit in P0-R7. This feature is used as a *loop-back* to check the integrity of the data transmission from the source to the TAS5756M device. In addition to the default loop-back mode, HybridFlows allows the SDOUT signal to originate from either a point after the processing or from some intermediary point within the HybridFlow. This option is accomplished by setting the SDSL bit in P0-R7. [Figure 70](#) shows how to configure the origin of the serial data output signal.

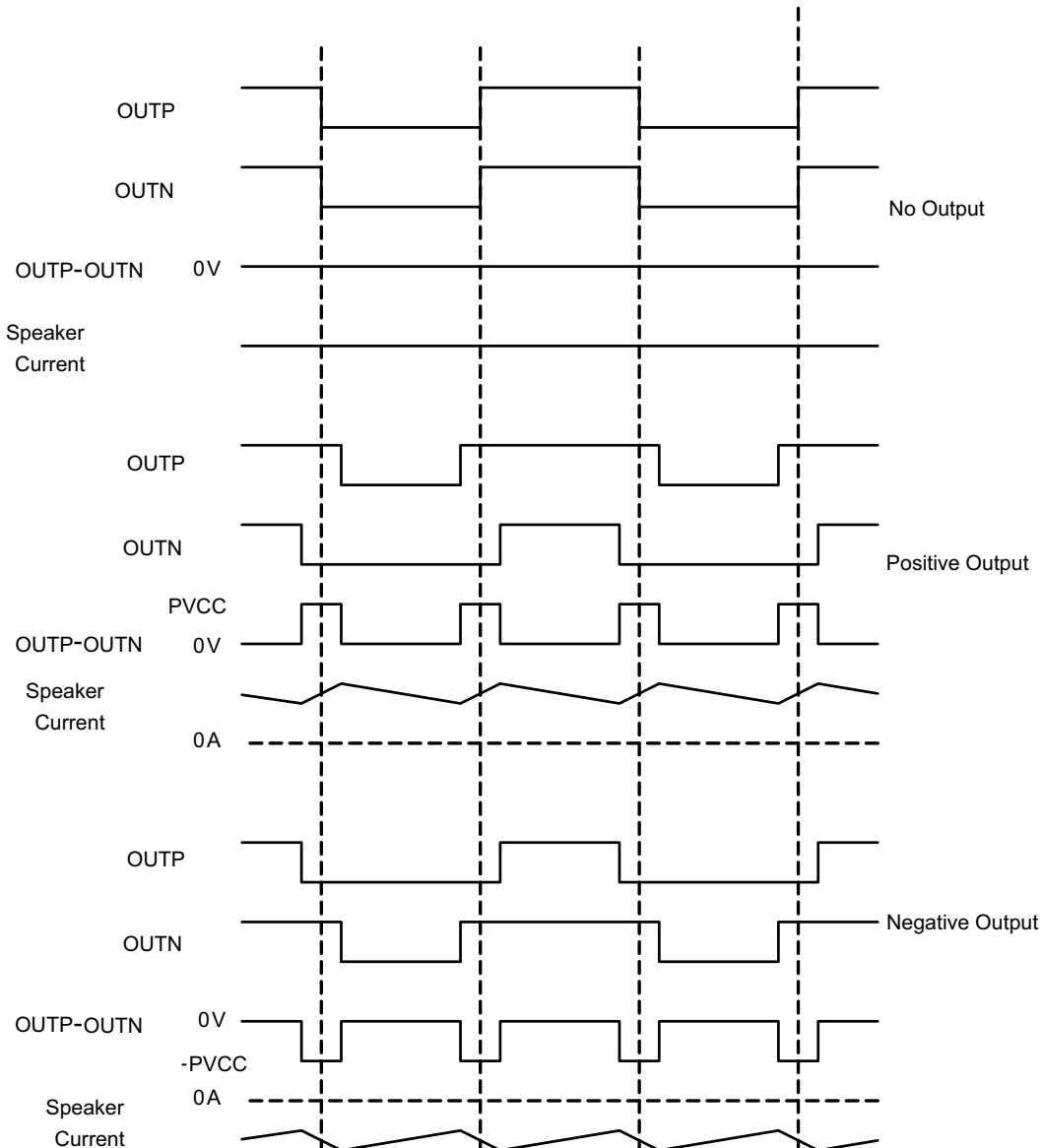

**Figure 70. Serial Data Output Signal**

Choosing the origin to be after all processing has been applied to the signal (i.e. before it is sent to the amplifier) is popular for sending a monitor signal back to a voice processing or echo-cancelling device elsewhere in the system. Other origins may configure the signal to originate after a subwoofer generation block, which sums in the inputs and applies a low-pass filter to create a mono, low-frequency signal. Please refer to the target HybridFlows for details regarding the options for the serial data output.

### 8.3.4 Modulation Scheme

#### 8.3.4.1 BD-Modulation

The TAS5756M uses BD modulation. This modulation scheme allows operation without the classic LC output filter when the amp is driving an inductive load with short speaker wires. Each output is switching from 0 volts to the supply voltage PVDD. The SPK\_OUTx+ and SPK\_OUTx- are in phase with each other with no input signal so that there is little or no current in the speaker. The duty cycle of SPK\_OUTx+ is greater than 50% and SPK\_OUTx- is less than 50% for positive output voltages. The duty cycle of SPK\_OUTx+ is less than 50% and SPK\_OUTx- is greater than 50% for negative output voltages. The voltage across the load remains at 0 V throughout most of the switching period, reducing the switching current, which reduces any  $I^2R$  losses in the load.



**Figure 71. BD-Modulation**

### 8.3.5 miniDSP Audio Processing Engine

The TAS5756M device integrates a highly efficient processing engine called a miniDSP. The miniDSP in the TAS5756M device uses a Hybrid architecture in which some processing blocks are built in ROM and other processing blocks are created in RAM via the PurePath™ Control Console GUI. This approach allows the flexibility of a fully-programmable device to be combined with the ease of use and rapid download time of a hard-coded ROM device.

#### 8.3.5.1 HybridFlow Architecture

The Hybrid RAM and ROM Architecture allows the device to be highly flexible, but also easy to use. Unlike a device where all digital processing blocks are hard-coded in ROM, the hybrid RAM and ROM architecture allows a variety of processing blocks to be used in various combinations with various connectivity. These combinations of processing blocks are called *HybridFlows*.

HybridFlows are generated by combining a collection of processing blocks together in a targeted manner so that the device is well suited for a particular application or use case. Some HybridFlows are targeted for stereo applications, while others are targeted for mono, 1.1 (Bi-Amped), or 2.1 configurations.

It is important to note that the amount of processing which can be combined together into a given process flow is highly dependent on the sample rate of the audio signal which is being processed. For instance, an audio signal at 48 kHz can have much more processing applied than the same signal presented to the TAS5756M device at 192 kHz sample rate. For this reason, a HybridFlow which supports only up to 48 kHz sample rate cannot be used with a 192 kHz input signal.

#### 8.3.5.2 Volume Control

##### 8.3.5.2.1 Digital Volume Control

A basic digital volume control with range between 24 dB and 103 dB and mute is available on each channels by P0-R61-B[7:0] for SPK\_OUTB± and P0-R62-B[7:0] for SPK\_OUTA±. These volume controls all have 0.5 dB step programmability over most gain and attenuation ranges. [Table 11](#) lists the detailed gain versus programmed setting for this basic volume control. Volume can be changed for both SPK\_OUTB± and SPK\_OUTA± at the same time or independently by P0-R61-B[1:0]. When B[1:0] set 00 (default), independent control is selected. When B[1:0] set 01, SPK\_OUTA± accords with SPK\_OUTB± volume. When B[1:0] set 10, SPK\_OUTA± volume controls the volume for both channels. To set B[1:0] to 11 is prohibited.

**Table 11. Digital Volume Control Settings**

| GAIN SETTING | BINARY DATA | GAIN (dB) | COMMENTS                 |
|--------------|-------------|-----------|--------------------------|
| 0            | 0000-0000   | 24.0      | Positive maximum         |
| 1            | 0000-0001   | 23.5      |                          |
| ·            | ·           | ·         |                          |
| ·            | ·           | ·         |                          |
| ·            | ·           | ·         |                          |
| 46           | 0010-1110   | 1.0       |                          |
| 47           | 0010-1111   | 0.5       |                          |
| 48           | 0011-0000   | 0.0       | No attenuation (default) |
| 49           | 0011-0001   | –0.5      |                          |
| 50           | 0011-0010   | –1.0      |                          |
| 51           | 0011-0011   | –1.5      |                          |
| ·            | ·           | ·         |                          |
| ·            | ·           | ·         |                          |
| ·            | ·           | ·         |                          |
| 253          | 1111-1101   | –102.5    |                          |
| 254          | 1111-1110   | –103      | Negative maximum         |
| 255          | 1111-1111   | –∞        | Negative infinite (Mute) |

Ramp-up frequency and ramp-down frequency can be controlled by P0-R63, B[7:6] and B[3:2] as shown in Table 12. Also ramp-up step and ramp-down step can be controlled by P0-R63, B[5:4] and B[1:0] as shown in Table 13.

**Table 12. Ramp Up or Down Frequency**

| RAMP UP SPEED | EVERY N $f_s$ | COMMENTS | RAMP DOWN FREQUENCY | EVERY N $f_s$ | COMMENTS |
|---------------|---------------|----------|---------------------|---------------|----------|
| 00            | 1             | Default  | 00                  | 1             | Default  |
| 01            | 2             |          | 01                  | 2             |          |
| 10            | 4             |          | 10                  | 4             |          |
| 11            | Direct change |          | 11                  | Direct change |          |

**Table 13. Ramp Up or Down Step**

| RAMP UP STEP | STEP dB | COMMENTS | RAMP DOWN STEP | STEP dB | COMMENTS |
|--------------|---------|----------|----------------|---------|----------|
| 00           | 4.0     |          | 00             | –4.0    |          |
| 01           | 2.0     |          | 01             | –2.0    |          |
| 10           | 1.0     | Default  | 10             | –1.0    | Default  |
| 11           | 0.5     |          | 11             | –0.5    |          |

#### 8.3.5.2.1.1 Emergency Volume Ramp Down

Emergency ramp down of the volume by is provided for situations such as I<sup>2</sup>S clock error and power supply failure. Ramp-down speed is controlled by P0-R64-B[7:6]. Ramp-down step can be controlled by P0-R64-B[5:4]. Default is ramp-down by every  $f_s$  cycle with –4dB step.

### 8.3.6 Adjustable Amplifier Gain and Switching Frequency Selection

The voltage divider between the GVDD\_REG pin a the SPK\_GAIN/FREQ pin is used to set the gain and switching frequency of the amplifier. Upon start-up of the device, the voltage presented on the SPK\_GAIN/FREQ pin is digitized and then decoded into a 3-bit word which is interpreted inside the TAS5756M device to correspond to a given gain and switching frequency. In order to change the SPK\_GAIN or switching frequency of the amplifier, the device must first be powered down, and then powered back back, with the new voltage level presented to the device on the SPK\_GAIN/FREQ pin.

Because the amplifier adds gain to both the signal and the noise present in the audio signal, the lowest gain setting that can meet voltage-limited output power targets should be used. This ensures that the power target can be reached while minimizing the idle channel noise of the system. The switching frequency selection affects three important operating characteristics of the device. These are the power dissipation in the device, the power dissipation in the inductor, and the target output filter for the application.

Higher switching frequencies typically result in slightly higher power dissipation in the TAS5756M device and lower dissipation in the inductor in the system, due to decreased ripple current through the inductor and increased charging and discharging current in device and parasitic capacitances. Switching at the higher of the two available switching frequencies will result in lower overall dissipation in the system and lower operating temperature of the inductors. However, the thermally limited power output of the device may be decreased in this situation, because some of the TAS5756M device thermal headroom will be absorbed by the higher switching frequency. Conversely inductor heating can be reduced by using the higher switching frequency to reduce the ripple current.

Another advantage of increasing the switching frequency is that the higher frequency carrier signal can be filtered by an L-C filter with a higher corner frequency, leading to physically smaller components. Use the highest switching frequency that continues to meet the thermally limited power targets for the application. If thermal constraints require heat reduction in the TAS5756M device, use a lower switching rate.

The switching frequency of the speaker amplifier is dependent on an internal synchronizing signal, ( $f_{\text{SYNC}}$ ), which is synchronous with the sample rate. The rate of the synchronizing signal is also dependent on the sample rate. Refer to Table 14 below for details regarding how the sample rates correlate to the synchronizing signal.

**Table 14. Sample Rates vs Synchronization Signal**

| SAMPLE RATE<br>[kHz] | f <sub>SYNC</sub><br>[kHz] |
|----------------------|----------------------------|
| 8                    | 96                         |
| 16                   |                            |
| 32                   |                            |
| 48                   |                            |
| 96                   |                            |
| 192                  |                            |
| 11.025               | 88.2                       |
| 22.05                |                            |
| 44.1                 |                            |
| 88.2                 |                            |

Table 15 summarizes the de-code of the voltage presented to the SPK\_GAIN/FREQ pin. The voltage presented to the SPK\_GAIN/FREQ pin is latched in upon startup of the device. Subsequent changes require power cycling the device. A gain setting of 20 dBV is recommended for nominal supply voltages of 13 V and lower, while a gain of 26 dBV is recommended for supply voltages up to 26.4 V. Table 15 shows the voltage required at the SPK\_GAIN/FREQ pin for various gain and switching scenarios as well some example resistor values for meeting the voltage range requirements.

**Table 15. Amplifier Switching Mode vs. SPK\_GAIN/FREQ Voltage**

| V <sub>SPK_GAIN/FREQ</sub> (V) |      | RESISTOR EXAMPLES                                                | GAIN MODE | AMPLIFIER<br>SWITCHING<br>FREQUENCY MODE |
|--------------------------------|------|------------------------------------------------------------------|-----------|------------------------------------------|
| MIN                            | MAX  | R100 (kΩ): RESISTOR TO GROUND<br>R101 (kΩ): RESISTOR TO GVDD_REG |           |                                          |
| 6.61                           | 7    | Reserved                                                         | Reserved  | Reserved                                 |
| 5.44                           | 6.6  | R100 = 750<br>R101 = 150                                         | 26dBV     | 8 × f <sub>SYNC</sub>                    |
| 4.67                           | 5.43 | R100 = 390<br>R101 = 150                                         |           | 6 × f <sub>SYNC</sub>                    |
| 3.89                           | 4.66 | R100 = 220<br>R101 = 150                                         |           | 5 × f <sub>SYNC</sub>                    |
| 3.11                           | 3.88 | R100 = 150<br>R101 = 150                                         |           | 4 × f <sub>SYNC</sub>                    |
| 2.33                           | 3.1  | R100 = 100<br>R101 = 150                                         | 20dBV     | 8 × f <sub>SYNC</sub>                    |
| 1.56                           | 2.32 | R100 = 56<br>R101 = 150                                          |           | 6 × f <sub>SYNC</sub>                    |
| 0.78                           | 1.55 | R100 = 33<br>R101 = 150                                          |           | 5 × f <sub>SYNC</sub>                    |
| 0                              | 0.77 | R100 = 8.2<br>R101 = 150                                         |           | 4 × f <sub>SYNC</sub>                    |

### 8.3.7 Error Handling and Protection Suite

#### 8.3.7.1 Device Overtemperature Protection

The TAS5756M device continuously monitors die temperature to ensure it does not exceed the OTE<sub>THRES</sub> level specified in the [Recommended Operating Conditions](#) table. If an OTE event occurs, the SPK\_FAULT line is pulled low and out the SPK\_OUTxx outputs transition to high impedance, signifying a fault. This is a non-latched error and will attempt to self clear after OTE<sub>CLRTIME</sub> has passed.

### 8.3.7.2 SPK\_OUTxx Overcurrent Protection

The TAS5756M device continuously monitors the output current of each amplifier output to ensure it does not exceed the  $OCE_{THRES}$  level specified in the [Recommended Operating Conditions](#) table. If an OCE event occurs, the SPK\_FAULT line is pulled low and the SPK\_OUTxx outputs transition to high impedance, signifying a fault. This is a non-latched error and will attempt to self clear after  $OCE_{CLRTIME}$  has passed.

### 8.3.7.3 DC Offset Protection

If the TAS5756M device measures a DC offset in the output voltage, the  $\overline{SPK\_FAULT}$  line is pulled low and the SPK\_OUTxx outputs transition to high impedance, signifying a fault. This latched error requires the SPK\_MUTE line to toggle to reset the error. Alternatively, pulling the MCLK, SCLK, or LRCK low causes a clock error, which also resets the device. Normal operation resumes by re-starting the stopped clock.

### 8.3.7.4 Internal $V_{AVDD}$ Undervoltage-Error Protection

The TAS5756M device internally monitors the AVDD net to protect against the AVDD supply dropping unexpectedly. To enable this feature, P1-R5-B0 is used.

### 8.3.7.5 Internal $V_{PVDD}$ Undervoltage-Error Protection

If the voltage presented on the PVDD supply drops below the  $UVE_{THRES(PVDD)}$  value listed in the [Recommended Operating Conditions](#) table, the SPK\_OUTxx outputs transition to high impedance. This is a self-clearing error, which means that once the PVDD level drops below the level listed in the [Recommended Operating Conditions](#) table, the device resumes normal operation.

### 8.3.7.6 Internal $V_{PVDD}$ Overvoltage-Error Protection

If the voltage presented on the PVDD supply exceeds the  $OVE_{THRES(PVDD)}$  value listed in the [Recommended Operating Conditions](#) table, the SPK\_OUTxx outputs will transition to high impedance. This is a self-clearing error, which means that once the PVDD level drops below the level listed in the [Recommended Operating Conditions](#) table, the device will resume normal operation. It is important to note that this voltage only protects up to the level described in the [Recommended Operating Conditions](#) table for the PVDD voltage. Exceeding this absolute maximum rating causes damage and possible device failure, because the levels exceed that which can be protected against by the OVE protection circuit.

### 8.3.7.7 External Undervoltage-Error Protection

The  $\overline{SPK\_MUTE}$  pin can also be used to monitor a system voltage, such as a LCD TV backlight, a battery pack in portable device, by using a voltage divider created with two resistors (see [Figure 72](#)).

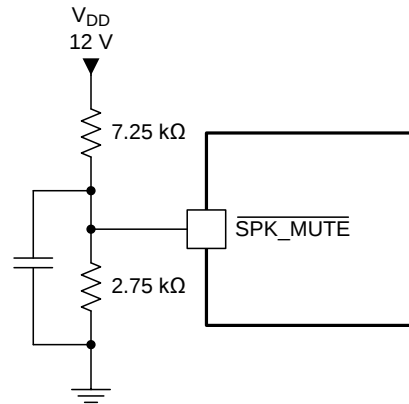
- If the  $\overline{SPK\_MUTE}$  pin makes a transition from 1 to 0 over 6 ms or more, the device switches into external undervoltage protection mode. This mode uses two trigger levels.
- When the  $\overline{SPK\_MUTE}$  pin level reaches 2 V, soft mute process begins.
- When the  $\overline{SPK\_MUTE}$  pin level reaches 1.2 V, analog output mute engages, regardless of digital audio level, and analog output shutdown begins.

[Figure 73](#) shows a timing diagram for external undervoltage error protection.

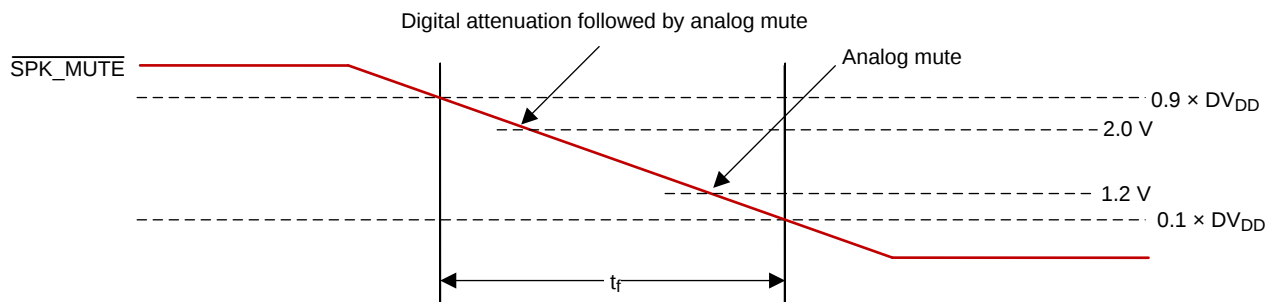
#### NOTE

The  $\overline{SPK\_MUTE}$  input pin voltage range is provided in the [Recommended Operating Conditions](#) table. The ratio of external resistors must produce a voltage within this input range. Any increase in power supply (such as power supply positive noise or ripple) can pull the  $\overline{SPK\_MUTE}$  pin higher than that the level specified in the [Recommended Operating Conditions](#) table, potentially causing damage to or failure of the device. Therefore, it is imperative that any monitored voltage (including all ripple, power supply variation, resistor divider variation, transient spikes, and others) is scaled by the resistor divider network to never drive the voltage on the  $\overline{SPK\_MUTE}$  pin higher than the maximum level specified in the [Recommended Operating Conditions](#) table.

When the divider is set correctly, any DC voltage can be monitored. [Figure 72](#) shows a 12-V example of how the  $\overline{SPK\_MUTE}$  is used for external undervoltage error protection.



**Figure 72. SPK\_MUTE Used in External Undervoltage Error Protection**

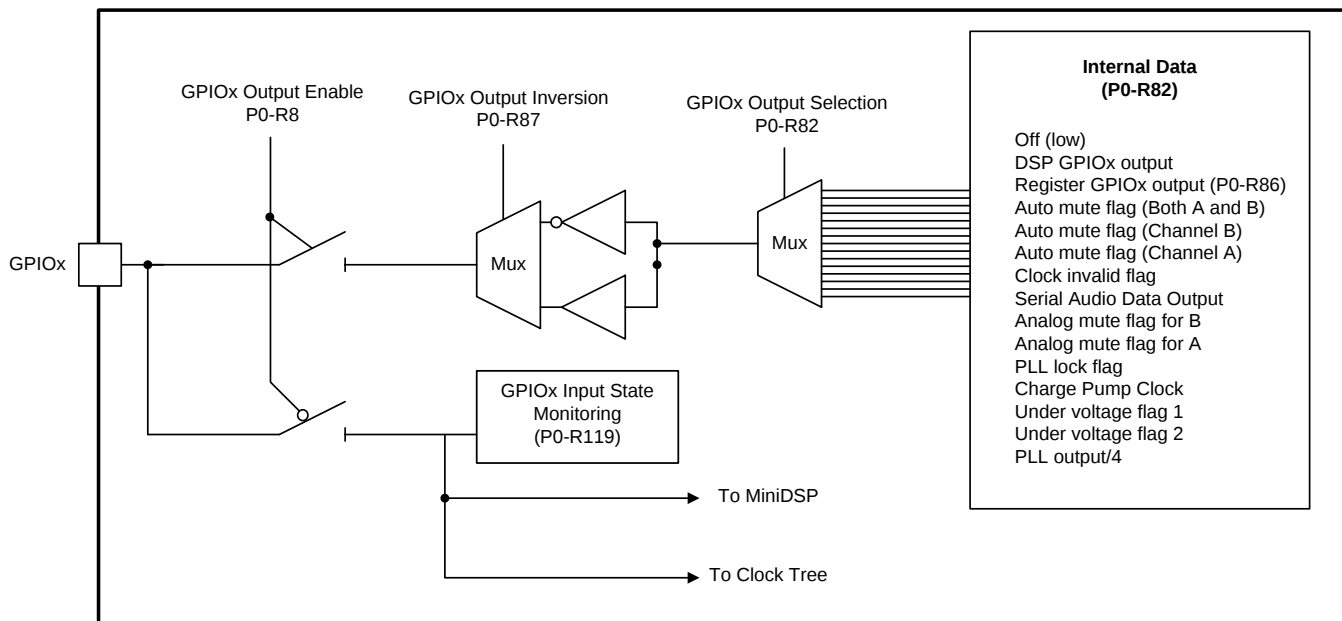


**Figure 73. SPK\_MUTE Timing for External Undervoltage Error Protection**

#### 8.3.7.8 Internal Clock Error Notification (CLKE)

#### 8.3.8 GPIO Port and Hardware Control Pins

The TAS5756M device includes a versatile GPIO port, allowing signals to be passed from the system to the device or sent out of the device to the system. There are three GPIO pins available for use. These pins can be used for advanced clocking features, to pass internal signals to the system or accept signals from the system for use inside the device by a HybridFlow, or simply to monitor the status of an external signal via I<sup>2</sup>C. The GPIO port requires some configuration in the control port. This configuration is detailed in [Figure 74](#).



**Figure 74. GPIO Port**

In addition to the dynamic controls which can be implemented with the GPIO port, each HybridFlow uses the GPIO port as required. In some HybridFlows, a GPIO is used to present an internal serial audio data signal to a system controller. In others, the status of a GPIO pin is monitored and the status of that pin is used to adjust the audio processing applied to the signal. Refer to each HybridFlow for specifics regarding how the GPIO port is used. GPIOs which have been allocated to a function in a HybridFlow can be reassigned using the same controls as those listed in [Figure 74](#). However, they no longer serve the purpose intended by the design of the HybridFlow.

### 8.3.9 I<sup>2</sup>C Communication Port

The TAS5756M device supports the I<sup>2</sup>C serial bus and the data transmission protocol for standard and fast mode as a slave device. Because the TAS5756M register map spans several pages, it is necessary to change from page to page before writing individual register bits or bytes. This is accomplished via register 0 on each page. This register value selects the register page, from 0 to 255.

#### 8.3.9.1 Slave Address

**Table 16. I<sup>2</sup>C Slave Address**

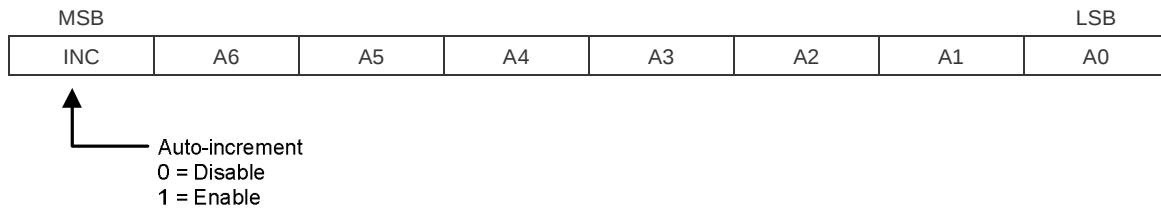
| MSB |   |   |   |   |      |      | LSB               |
|-----|---|---|---|---|------|------|-------------------|
| 1   | 0 | 0 | 1 | 1 | ADR2 | ADR1 | R/ $\overline{W}$ |

The TAS5756M device has 7 bits for its own slave address. The first five bits (MSBs) of the slave address are factory preset to 10011 (0x9x). The next two bits of the address byte are the device select bits which can be user-defined by the ADR1 and ADR0 terminals. A maximum of four devices can be connected on the same bus at one time. This gives a range of 0x98, 0x9A, 0x9C and 0x9E, as detailed below. Each TAS5756M device responds when it receives its own slave address.

**Table 17. I<sup>2</sup>C Address Configuration via ADR0 and ADR1 Pins**

| ADR1 | ADR0 | I <sup>2</sup> C SLAVE ADDRESS [R/ $\overline{W}$ ] |
|------|------|-----------------------------------------------------|
| 0    | 0    | 0x99/0x98                                           |
| 0    | 1    | 0x9B/0x9A                                           |
| 1    | 0    | 0x9D/0x9C                                           |
| 1    | 1    | 0x9F/0x9E                                           |

### 8.3.9.2 Register Address Auto-Increment Mode

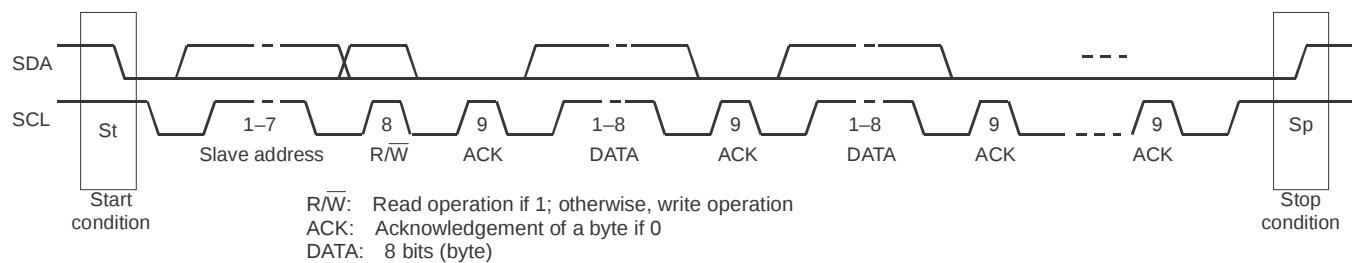


**Figure 75. Auto Increment Mode**

Auto-increment mode allows multiple sequential register locations to be written to or read back in a single operation, and is especially useful for block write and read operations.

### 8.3.9.3 Packet Protocol

A master device must control packet protocol, which consists of start condition, slave address, read/write bit, data if write or acknowledge if read, and stop condition. The TAS5756M device supports only slave receivers and slave transmitters.



**Figure 76. Packet Protocol**

**Table 18. Write Operation - Basic I<sup>2</sup>C Framework**

|             |    |               |    |     |      |     |      |     |  |     |    |
|-------------|----|---------------|----|-----|------|-----|------|-----|--|-----|----|
| Transmitter | M  | M             | M  | S   | M    | S   | M    | S   |  | S   | M  |
| Data Type   | St | slave address | R/ | ACK | DATA | ACK | DATA | ACK |  | ACK | Sp |

**Table 19. Read Operation - Basic I<sup>2</sup>C Framework**

|             |    |               |    |     |      |     |      |     |  |      |    |
|-------------|----|---------------|----|-----|------|-----|------|-----|--|------|----|
| Transmitter | M  | M             | M  | S   | S    | M   | S    | M   |  | M    | M  |
| Data Type   | St | slave address | R/ | ACK | DATA | ACK | DATA | ACK |  | NACK | Sp |

M = Master Device; S = Slave Device; St = Start Condition Sp = Stop Condition

### 8.3.9.4 Write Register

A master can write to any TAS5756M device registers using single or multiple accesses. The master sends a TAS5756M device slave address with a write bit, a register address with auto-increment bit, and the data. If auto-increment is enabled, the address is that of the starting register, followed by the data to be transferred. When the data is received properly, the index register is incremented by 1 automatically. When the index register reaches 0x7F, the next value is 0x0. [Table 20](#) shows the write operation.

**Table 20. Write Operation**

|             |    |            |   |     |     |          |     |              |     |              |     |  |     |    |
|-------------|----|------------|---|-----|-----|----------|-----|--------------|-----|--------------|-----|--|-----|----|
| Transmitter | M  | M          | M | S   | M   |          | S   | M            | S   | M            | S   |  | S   | M  |
| Data Type   | St | slave addr | W | ACK | inc | reg addr | ACK | write data 1 | ACK | write data 2 | ACK |  | ACK | Sp |

M = Master Device; S = Slave Device; St = Start Condition Sp = Stop Condition; W = Write; ACK = Acknowledge

### 8.3.9.5 Read Register

A master can read the TAS5756M device register. The value of the register address is stored in an indirect index register in advance. The master sends a TAS5756M device slave address with a read bit after storing the register address. Then the TAS5756M device transfers the data which the index register points to. When auto-increment is enabled, the index register is incremented by 1 automatically. When the index register reaches 0x7F, the next value is 0x0. [Table 21](#) lists the read operation.

**Table 21. Read Operation**

|             |    |            |   |     |     |          |     |    |            |   |     |      |     |  |      |    |
|-------------|----|------------|---|-----|-----|----------|-----|----|------------|---|-----|------|-----|--|------|----|
| Transmitter | M  | M          | M | S   | M   |          | S   | M  | M          | M | S   | S    | M   |  | M    | M  |
| Data Type   | St | slave addr | W | ACK | inc | reg addr | ACK | Sr | slave addr | R | ACK | data | ACK |  | NACK | Sp |

M = Master Device; S = Slave Device; St = Start Condition; Sr = Repeated start condition; Sp = Stop Condition; W = Write; R = Read; NACK = Not acknowledge

## 8.4 Device Functional Modes

Because the TAS5756M device is a highly configurable device, numerous modes of operation can exist for the device. For the sake of succinct documentation, these modes are divided into two modes:

- Fundamental operating modes
- Secondary usage modes

Fundamental operating modes are the primary modes of operation that affect the major operational characteristics of the device. These are the most basic configurations that are chosen to ensure compatibility with the intended application or the other components that interact with the device in the final system. Some examples of these are the communication protocol used by the control port, the output configuration of the amplifier, or the Master/Slave clocking configuration.

The fundamental operating modes are described starting in the [Serial Audio Port Operating Modes](#) section.

Secondary usage modes are best described as modes of operation that are used after the fundamental operating modes are chosen to fine tune how the device operates within a given system. These secondary usage modes may include selecting between left justified and right justified Serial Audio Port data formats, or enabling some slight gain/attenuation within the DAC path. Secondary usage modes are accomplished through manipulation of the registers and controls in the I<sup>2</sup>C control port. Those modes of operation are described in their respective register/bit descriptions and, to avoid redundancy, are not included in this section.

### 8.4.1 Serial Audio Port Operating Modes

The serial audio port in the TAS5756M device supports industry-standard audio data formats, including I<sup>2</sup>S, Time Division Multiplexing (TDM), Left-Justified (LJ), and Right-Justified (RJ) formats. To select the data format that will be used with the device, controls are provided on P0-R40. The timing diagrams for the serial audio port are shown in the [Serial Audio Port Timing – Slave Mode](#) section, and the data formats are shown in the [Serial Audio Port – Data Formats and Bit Depths](#) section.

### 8.4.2 Communication Port Operating Modes

The TAS5756M device is configured via an I<sup>2</sup>C communication port. The device does not support a hardware only mode of operation, nor Serial Peripheral Interface (SPI) communication. The I<sup>2</sup>C Communication Protocol is detailed in the [I<sup>2</sup>C Communication Port](#) section. The I<sup>2</sup>C timing requirements are described in the [I<sup>2</sup>C Bus Timing – Standard](#) and [I<sup>2</sup>C Bus Timing – Fast](#) sections.

### 8.4.3 Audio Processing Modes via HybridFlow Audio Processing

The TAS5756M device can be configured to include several different audio processing features through the use of pre-defined DSP loads called HybridFlows. These HybridFlows have been created and tested to be application focused. This approach results in a device which offers the flexibility of a programmable device with the ease-of-use and fast download time of a fixed function device. The HybridFlows are selected and downloaded using the PurePath™ ControlConsole software. .

## Device Functional Modes (continued)

### 8.4.4 Speaker Amplifier Operating Modes

The TAS5756M device can be used in three different amplifier configurations:

- Stereo Mode
- Mono Mode
- Bi-Amp Mode

#### 8.4.4.1 Stereo Mode

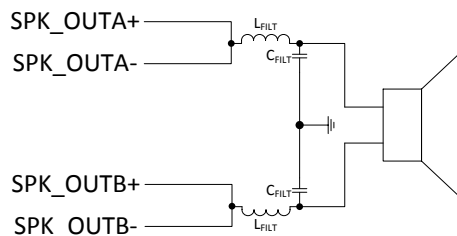
The familiar stereo mode of operation uses the TAS5756M device to amplify two independent signals, which represent the left and right portions of a stereo signal. These amplified left and right audio signals are presented on differential output pairs shown as SPK\_OUTA± and SPK\_OUTB±. The routing of the audio data which is presented on the SPK\_OUTxx outputs can be changed according to the HybridFlow which is used and the configuration of registers P0-R42-B[5:4] and P0-R42-B[1:0]. This mode of operation is shown in [Figure 79](#).

By default, the TAS5756M device is configured to output the Right frame of a I<sup>2</sup>S input on the Channel A output and the left frame on the Channel B output.

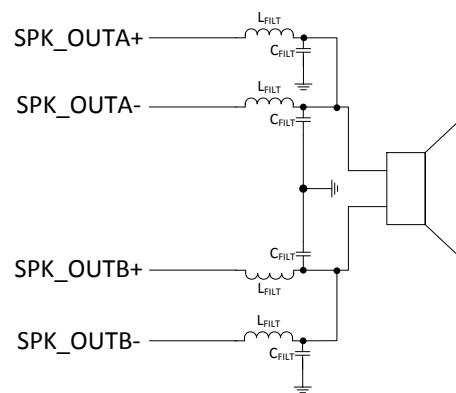
#### 8.4.4.2 Mono Mode

This mode of operation is used to describe operation in which the two outputs of the device are placed in parallel with one another to increase the power sourcing capabilities of the device.

On the output side of the TAS5756M device, the summation of the devices can be done before the filter in a configuration called *Pre-Filter Parallel Bridge Tied Load (PBTTL)*. However, it is sometimes preferable to merge the two outputs together after the inductor portion of the output filter. Doing so does require two additional inductors, but allows smaller, less expensive inductors to be used because the current is divided between the two inductors. This is called *Post-Filter PBTTL*. Both variants of mono operation are shown in [Figure 77](#) and [Figure 78](#).



**Figure 77. Pre-Filter PBTTL**



**Figure 78. Post-Filter PBTTL**

On the input side of the TAS5756M device, the input signal to the mono amplifier can be selected from the any slot in a TDM stream or the left or right frame from an I<sup>2</sup>S, LJ, or RJ signal. It can also be configured to amplify some mixture of two signals, as in the case of a subwoofer channel which mixes the left and right channel together and sends it through a low-pass filter to create a mono, low-frequency signal.

This mode of operation is shown in the [Mono \(PBTTL\) Systems](#) section.

#### 8.4.4.3 Bi-Amp Mode

Bi-Amp mode, sometimes also referred to as *1.1 Mode* uses a two channel device (such as the TAS5756M device ) to amplify two different frequency regions of the same signal for a two-way speaker. This is most often used in a single active speaker, where one channel of the amplifier is use to drive the high frequency transducer and one channel is used to drive the low-frequency transducer. To operate in *Bi-Amped Mode* or *1.1 Mode*, an appropriate HybridFlow must be selected, because the frequency separation and audio processing must occur in the DSP. This mode of operation is shown in the [1.1 \(Dual BTL, Bi-Amped\) Systems](#) section.

## Device Functional Modes (continued)

### 8.4.4.4 Master and Slave Mode Clocking for Digital Serial Audio Port

The digital audio serial port in the TAS5756M device can be configured to receive its clocks from another device as a serial audio slave device. This mode of operation is described in the [Clock Slave Mode with SLCK PLL to Generate Internal Clocks \(3-Wire PCM\)](#) section. If there no system processor available to provide the audio clocks, the TAS5756M device can be placed into Master Mode. In this mode, the TAS5756M device provides the clocks to the other audio devices in the system. For more details regarding the Master and Slave mode operation within the TAS5756M device, see the [Serial Audio Port Operating Modes](#) section.

## 9 Application and Implementation

### NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

### 9.1 Application Information

One of the most significant benefits of the TAS5756M device is the ability to be used in a variety of applications and with an assortment of signal processing options. This section details the information required to configure the device for several popular configurations and provides guidance on integrating the TAS5756M device into the larger system.

#### 9.1.1 External Component Selection Criteria

The *Supporting Component Requirements* table in each application description section lists the details of the supporting required components in each of the *System Application Schematics*.

Where possible, the supporting component requirements have been consolidated to minimize the number of unique components which are used in the design. Component list consolidation is a method to reduce the number of unique part numbers in a design, to ease inventory management, and reduce the manufacturing steps during board assembly. For this reason, some capacitors are specified at a higher voltage than what would normally be required. An example of this is a 50-V capacitor may be used for decoupling of a 3.3-V power supply net.

In this example, a higher voltage capacitor can be used even on the lower voltage net to consolidate all caps of that value into a single component type. Similarly, a several unique resistors, having all the same size and value but with different power ratings can be consolidated by using the highest rated power resistor for each instance of that resistor value.

While this consolidation may seem excessive, the benefits of having fewer components in the design may far outweigh the trivial cost of a higher voltage capacitor. If lower voltage capacitors are already available elsewhere in the design, they can be used instead of the higher voltage capacitors. In all situations, the voltage rating of the capacitors must be at least 1.45 times the voltage of the voltage which appears across them. The power rating of the capacitors should be 1.5 times to 1.75 times the power dissipated in it during normal use case.

#### 9.1.2 Component Selection Impact on Board Layout, Component Placement, and Trace Routing

Because the layout is important to the overall performance of the circuit, the package size of the components shown in the component list were intentionally chosen to allow for proper board layout, component placement, and trace routing. In some cases, traces are passed in between two surface mount pads or ground plane extends from the TAS5756M device between two pads of a surface mount component and into to the surrounding copper for increased heat-sinking of the device. While components may be offered in smaller or larger package sizes, it is highly recommended that the package size remain identical to that used in the application circuit as shown. This consistency ensures that the layout and routing can be matched very closely, optimizing thermal, electromagnetic, and audio performance of the TAS5756M device in circuit in the final system.

#### 9.1.3 Amplifier Output Filtering

The TAS5756M device is often used with a low-pass filter, which is used to filter out the carrier frequency of the PWM modulated output. This filter is frequently referred to as the *L-C Filter*, due to the presence of an inductive element *L* and a capacitive element *C* to make up the 2-pole filter.

## Application Information (continued)

The L-C filter removes the carrier frequency, reducing electromagnetic emissions and smoothing the current waveform which is drawn from the power supply. The presence and size of the L-C filter is determined by several system level constraints. In some low-power use cases that have no other circuits which are sensitive to EMI, a simple ferrite bead or ferrite bead and capacitor can replace the traditional large inductor and capacitor that are commonly used. In other high-power applications, large toroid inductors are required for maximum power and film capacitors may be preferred due to audio characteristics. Refer to the application report [SLOA119](#) for a detailed description on proper component selection and design of an L-C filter based upon the desired load and response.

### 9.1.4 Programming the TAS5756M

The device includes an I<sup>2</sup>C compatible control port to configure the internal registers of the TAS5756M. The Control Console software provided by TI is required to configure the device for operation with the various HybridFlows. More details regarding programming steps, and a few important notes are available below and also in the design examples that follow.

#### 9.1.4.1 Resetting the TAS5756M registers and modules

The TAS5756M device has several methods by which it can reset the register, interpolation filters, and DAC modules. The registers offer the flexibility to do these in or out of shutdown as well as in or out of standby. However, there can be issues if the reset bits are toggled in certain illegal operation modes.

Any of the following routines can be used with no issue:

- Reset Routine 1
  - Place device in Standby
  - Reset modules
- Reset Routine 2
  - Place device in Standby + Power Down
  - Reset registers
- Reset Routine 3
  - Place device in Power Down
  - Reset registers
- Reset Routine 4
  - Place device in Standby
  - Reset registers
- Reset Routine 5
  - Place device in Standby + Power Down
  - Reset modules + Reset registers
- Reset Routine 6
  - Place device in Power Down
  - Reset modules + Reset registers
- Reset Routine 7
  - Place device in Standby
  - Reset modules + Reset registers

There are two reset routines which are not support and should be avoided. If used, they can cause the device to become unresponsive. These unsupported routines are shown below.

- Unsupported Reset Routine 1 (do not use)
  - Place device in Standby + Power Down
  - Reset modules
- Unsupported Reset Routine 2 (do not use)
  - Place device in Power Down
  - Reset modules

## Application Information (continued)

### 9.1.4.2 Adaptive Mode and using CRAM buffers

The TAS5756M device has the ability to operate in a mode called "adaptive mode". In this mode, coefficients used the configuration of DSP blocks can be switched "on-the-fly", which means changed while the DSP is running and not muted or placed into shutdown. When adaptive buffering is enabled the configuration file generated by the Control Console software will initialize the coefficients in buffer A and the coefficients in buffer B with identical values. For example, if there is a mixing component in the HybridFlow which has been enabled to change while the DSP is running, the coefficient corresponding to the mixer coefficient is presented in both coefficient buffer A and B when the user clicks on the "run" button in the GUI. If the coefficient is to be changed "on-the-fly", there is a bit called "Switch Active CRAM" at location P44-R1-B0 that instructs the miniDSP to swap buffers A and B when this bit is set. When the user needs to change the value of the coefficient stored in the CRAM buffer, the host processor should do the following:

1. Write the new value of the coefficient to buffer A
2. Set the buffer-swap bit (P44-R1-B0).
3. Check the state of the Active CRAM Selection bit (P44-R1-B2) to ensure that the proper CRAM buffer is being used.
4. Write the new value of the unused buffer to make sure that both buffers remain in sync.
5. Repeat, if necessary, for each subsequent changing of this coefficient, switching between buffer A and buffer B.

At the end of each frame, the miniDSP sees if this bit is set. If it is, it swaps the buffer from A to B or vice versa. At the same time, it clears the bit that was set by host.

## 9.2 Typical Applications

### 9.2.1 2.0 (Stereo BTL) System

For the stereo (BTL) PCB layout, see [Figure 86](#).

A 2.0 system generally refers to a system in which there are two full range speakers without a separate amplifier path for the speakers which reproduce the low-frequency content. In this system, two channels are presented to the amplifier via the digital input signal. These two channels are amplified and then sent to two separate speakers. In some cases, the amplified signal is further separated based upon frequency by a passive crossover network after the L-C filter. Even so, the application is considered 2.0.

Most commonly, the two channels are a pair of signals called a *stereo pair*, with one channel containing the audio for the left channel and the other channel containing the audio for the right channel. While certainly the two channels can contain any two audio channels, such as two surround channels of a multi-channel speaker system, the most popular occurrence in two channels systems is a stereo pair.

It is important to note that the HybridFlows which have been developed for specifically for stereo applications will frequently apply the same equalizer curves to the left channel and the right channel. This maximizes the processing capabilities of each HybridFlow by minimizing the cycles required by the BiQuad filters.

When two signals that are not two separate signals, but instead are derived from a single signal which is separated into low frequency and high frequency by the signal processor, the application is commonly referred to as 1.1 or *Bi-Amped* systems. [Figure 79](#) shows the 2.0 (Stereo BTL) system application.

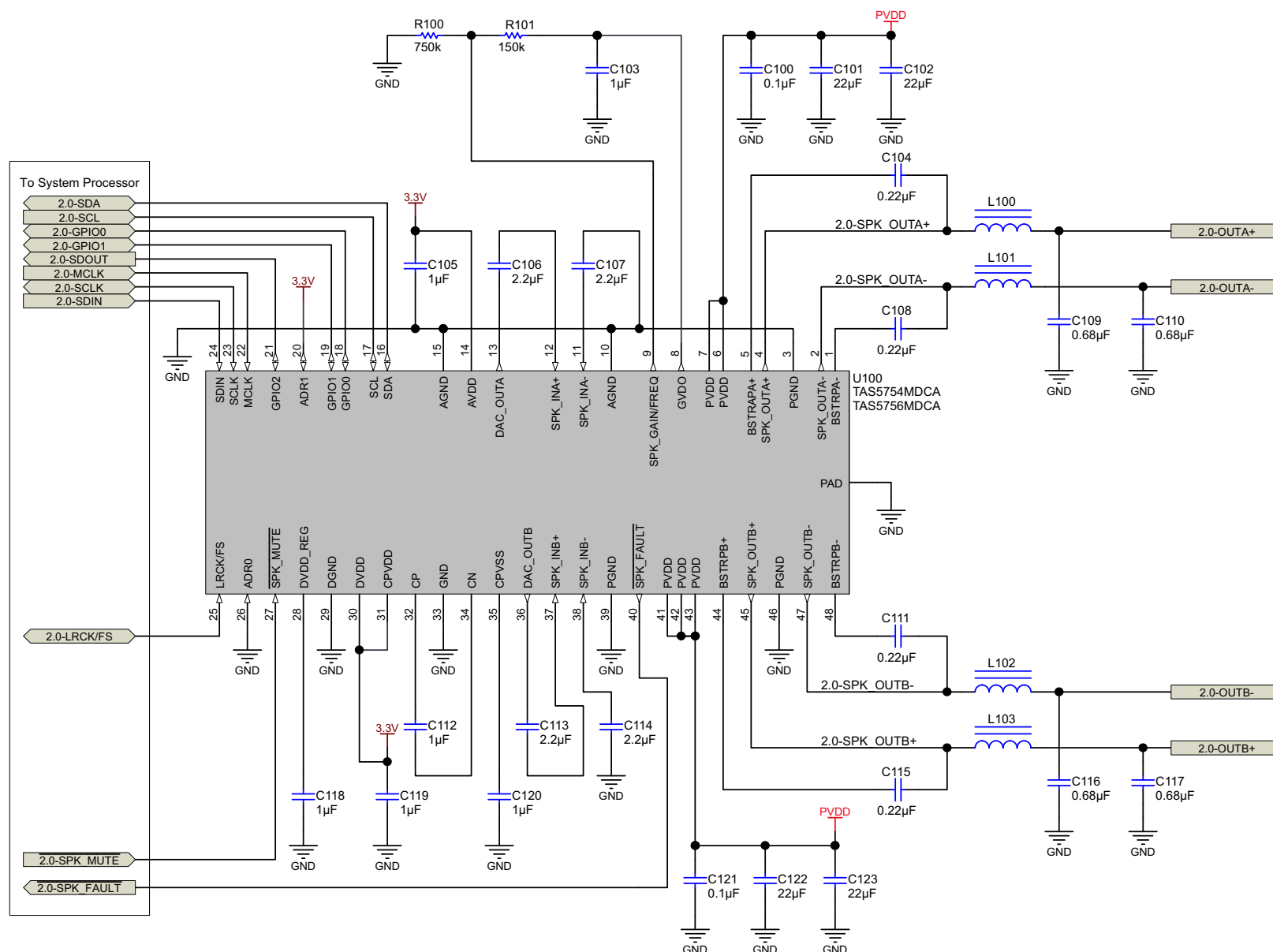


Figure 79. 2.0 (Stereo BTL) System Application Schematic

### 9.2.1.1 Design Requirements

- Power supplies:
  - 3.3-V supply
  - 5-V to 24-V supply
- Communication: host processor serving as I<sup>2</sup>C compliant master
- External memory (such as EEPROM and flash) used for coefficients and RAM portions of HybridFlow < 5 kB

The requirements for the supporting components for the TAS5756M device in a Stereo 2.0 (BTL) system is provided in [Table 22](#).

**Table 22. Supporting Component Requirements for Stereo 2.0 (BTL) Systems**

| REFERENCE DESIGNATOR   | VALUE                                                                                   | SIZE                                                    | DETAILED DESCRIPTION                                                                                                                                                                                                                                   |
|------------------------|-----------------------------------------------------------------------------------------|---------------------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| U100                   | TAS5756M                                                                                | 48 Pin TSSOP                                            | Digital-input, closed-loop class-D amplifier with HybridFlow processing                                                                                                                                                                                |
| R100                   | See <a href="#">Adjustable Amplifier Gain and Switching Frequency Selection</a> section | 0402                                                    | 1%, 0.063 W                                                                                                                                                                                                                                            |
| R101                   |                                                                                         | 0402                                                    | 1%, 0.063 W                                                                                                                                                                                                                                            |
| L100, L101, L102, L103 | See <a href="#">Amplifier Output Filtering</a> section                                  |                                                         |                                                                                                                                                                                                                                                        |
| C100, C121             | 0.1 $\mu$ F                                                                             | 0402                                                    | Ceramic, 0.1 $\mu$ F, $\pm$ 10%, X7R<br>Voltage rating must be > $1.45 \times V_{PVDD}$                                                                                                                                                                |
| C104, C108, C111, C115 | 0.22 $\mu$ F                                                                            | 0603                                                    | Ceramic, 0.22 $\mu$ F, $\pm$ 10%, X7R<br>Voltage rating must be > $1.45 \times V_{PVDD}$                                                                                                                                                               |
| C109, C110, C116, C117 | 0.68 $\mu$ F                                                                            | 0805                                                    | Ceramic, 0.68 $\mu$ F, $\pm$ 10%, X7R<br>Voltage rating must be > $1.8 \times V_{PVDD}$                                                                                                                                                                |
| C103                   | 1 $\mu$ F                                                                               | 0603<br>(this body size chosen to aid in trace routing) | Ceramic, 1 $\mu$ F, $\pm$ 10%, X7R<br>Voltage rating must be > 16 V                                                                                                                                                                                    |
| C105, C118, C119, C120 | 1 $\mu$ F                                                                               | 0402                                                    | Ceramic, 1 $\mu$ F, 6.3V, $\pm$ 10%, X5R                                                                                                                                                                                                               |
| C106, C107, C113, C114 | 2.2 $\mu$ F                                                                             | 0402                                                    | Ceramic, 2.2 $\mu$ F, $\pm$ 10%, X5R<br>At a minimum, voltage rating must be > 10V, however higher voltage caps have been shown to have better stability under DC bias please follow the guidance provided in the TAS5756MDCAEVM for suggested values. |
| C101, C102, C122, C123 | 22 $\mu$ F                                                                              | 0805                                                    | Ceramic, 22 $\mu$ F, $\pm$ 20%, X5R<br>Voltage rating must be > $1.45 \times V_{PVDD}$                                                                                                                                                                 |

### 9.2.1.2 Detailed Design Procedure

#### 9.2.1.2.1 Step One: Hardware Integration

- Using the *Typical Application Schematic* as a guide, integrate the hardware into the system schematic.
- Following the recommended component placement, board layout and routing give in the example layout above, integrate the device and its supporting components into the system PCB file.
  - The most critical section of the circuit is the power supply inputs, the amplifier output signals, and the high-frequency signals which go to the serial audio port. Constructing these signals to ensure they are given precedent as design trade-offs are made is recommended.
  - For questions and support go to the E2E forums ([e2e.ti.com](#)). If deviating from the recommended layout is necessary, go to the E2E forum to request a layout review.

#### 9.2.1.2.2 Step Two: HybridFlow Selection and System Level Tuning

- Use the *TAS5754/6M HybridFlow Processor User Guide and HybridFlow Documentation* ([SLAU577](#)) to select the HybridFlow that meets the needs of the target application.
- Use the TAS5754\_56MEVM evaluation module and the [PurePath ControlConsole](#) (PPC) software, to load the appropriate HybridFlow. Tune the end equipment by following the instructions in the [SLAU577](#).

### 9.2.1.2.3 Step Three: Software Integration

- Use the *Register Dump* feature of the PPC software to generate a baseline configuration file.
- Generate additional configuration files based upon operating modes of the end-equipment and integrate static configuration information into initialization files.
- Integrate dynamic controls (such as volume controls, mute commands, and mode-based EQ curves) into the main system program.

### 9.2.1.3 Application Curves

Table 23 shows the application specific performance plots for Stereo 2.0 (BTL) systems.

**Table 23. Relevant Performance Plots**

| PLOT TITLE                                        | FIGURE NUMBER             |
|---------------------------------------------------|---------------------------|
| Output Power vs PVDD                              | <a href="#">Figure 23</a> |
| THD+N vs Frequency, $V_{PVDD} = 12\text{ V}$      | <a href="#">Figure 24</a> |
| THD+N vs Frequency, $V_{PVDD} = 15\text{ V}$      | <a href="#">Figure 25</a> |
| THD+N vs Frequency, $V_{PVDD} = 18\text{ V}$      | <a href="#">Figure 26</a> |
| THD+N vs Frequency, $V_{PVDD} = 24\text{ V}$      | <a href="#">Figure 27</a> |
| THD+N vs Power, $V_{PVDD} = 12\text{ V}$          | <a href="#">Figure 28</a> |
| THD+N vs Power, $V_{PVDD} = 15\text{ V}$          | <a href="#">Figure 29</a> |
| THD+N vs Power, $V_{PVDD} = 18\text{ V}$          | <a href="#">Figure 30</a> |
| THD+N vs Power, $V_{PVDD} = 24\text{ V}$          | <a href="#">Figure 31</a> |
| Idle Channel Noise vs PVDD                        | <a href="#">Figure 32</a> |
| Efficiency vs Output Power                        | <a href="#">Figure 33</a> |
| Idle Current Draw (Filterless) vs PVDD            | <a href="#">Figure 34</a> |
| Idle Current Draw (Traditional LC Filter) vs PVDD | <a href="#">Figure 35</a> |
| DVDD PSRR vs. Frequency                           | <a href="#">Figure 38</a> |
| AVDD PSRR vs. Frequency                           | <a href="#">Figure 39</a> |
| $C_{PVDD}$ PSRR vs. Frequency                     | <a href="#">Figure 40</a> |
| Powerdown Current Draw vs. PVDD                   | <a href="#">Figure 41</a> |

### 9.2.2 Mono (PBTL) Systems

For the mono (PBTL) PCB layout, see [Figure 88](#).

A mono system refers to a system in which the amplifier is used to drive a single loudspeaker. Parallel Bridge Tied Load (PBTL) indicates that the two full-bridge channels of the device are placed in parallel and drive the loudspeaker simultaneously using an identical audio signal. The primary benefit of operating the TAS5756M device in PBTL operation is to reduce the power dissipation and increase the current sourcing capabilities of the amplifier output. In this mode of operation, the current limit of the audio amplifier is approximately doubled while the on-resistance is approximately halved.

The loudspeaker can be a full-range transducer or one that only reproduces the low-frequency content of an audio signal, as in the case of a powered subwoofer. Often in this use case, two stereo signals are mixed together and sent through a low-pass filter to create a single audio signal which contains the low frequency information of the two channels. Conversely, advanced digital signal processing can create a low-frequency signal for a multichannel system, with audio processing which is specifically targeted on low-frequency effects.

Although any of the HybridFlows can be made to work with a mono speaker, it is strongly recommended that HybridFlows which have been created specifically for mono applications be used. These HybridFlows contain the mixing and filtering required to generate the mono signal. They also include processing which is targeted at improving the low-frequency performance of an audio system- a feature that, while targeted at subwoofers, can also be used to enhance the low-frequency performance of a full-range speaker.

Because low-frequency signals are not perceived as having a direction (at least to the extent of high-frequency signals) it is common to reproduce the low-frequency content of a stereo signal that is sent to two separate channels. This configuration pairs one device in Mono PBTL configuration and another device in Stereo BTL configuration in a single system called a 2.1 system. The Mono PBTL configuration is detailed in the [2.1 \(Stereo BTL + External Mono Amplifier\) Systems](#) section.

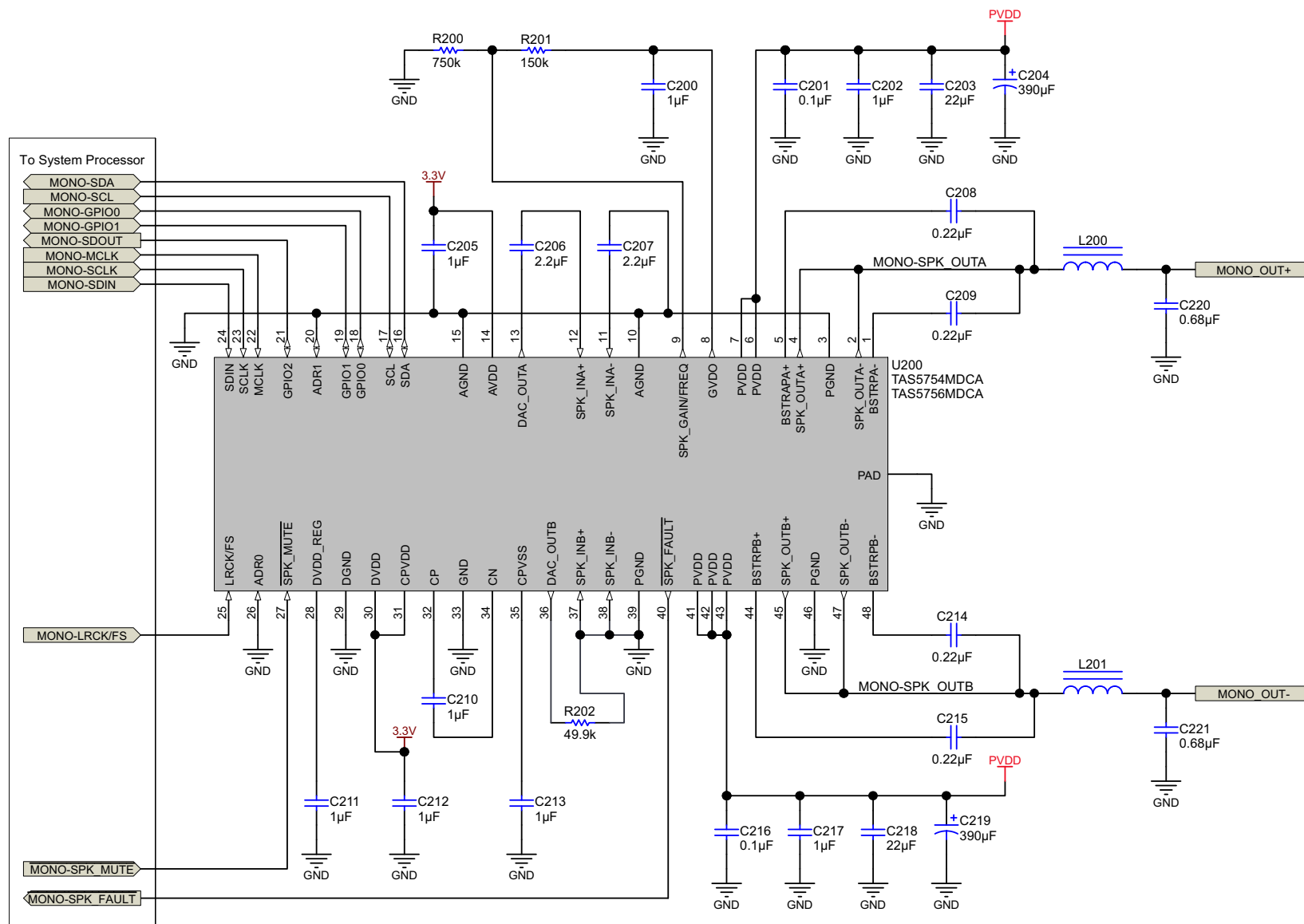


Figure 80. Mono (PBTl) System Application Schematic

### 9.2.2.1 Design Requirements

- Power supplies:
  - 3.3-V supply
  - 5-V to 24-V supply
- Communication: Host processor serving as I<sup>2</sup>C compliant master
- External memory (EEPROM, flash, and others) used for coefficients and RAM portions of HybridFlow < 5 kB

The requirements for the supporting components for the TAS5756M device in a Mono (PBTL) system is provided in [Table 24](#).

**Table 24. Supporting Component Requirements for Mono (PBTL) Systems**

| REFERENCE DESIGNATOR   | VALUE                                                                                   | SIZE                                                    | DETAILED DESCRIPTION                                                                                                                                                                                                                                                                                                                                                                                                                                        |
|------------------------|-----------------------------------------------------------------------------------------|---------------------------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| U200                   | TAS5756M                                                                                | 48 Pin TSSOP                                            | Digital-input, closed-loop class-D amplifier with HybridFlow processing                                                                                                                                                                                                                                                                                                                                                                                     |
| R200                   | See <a href="#">Adjustable Amplifier Gain and Switching Frequency Selection</a> section | 0402                                                    | 1%, 0.063 W                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
| R201                   |                                                                                         | 0402                                                    | 1%, 0.063 W                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
| R202                   |                                                                                         | 0402                                                    | 1%, 0.063 W                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
| L200, L201             | See <a href="#">Amplifier Output Filtering</a> section                                  |                                                         |                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| C216, C201             | 0.1 $\mu$ F                                                                             | 0402                                                    | Ceramic, 0.1 $\mu$ F, $\pm$ 10%, X7R<br>Voltage rating must be $> 1.45 \times V_{PVDD}$                                                                                                                                                                                                                                                                                                                                                                     |
| C208, C209, C214, C215 | 0.22 $\mu$ F                                                                            | 0603                                                    | Ceramic, 0.22 $\mu$ F, $\pm$ 10%, X7R<br>Voltage rating must be $> 1.45 \times V_{PVDD}$                                                                                                                                                                                                                                                                                                                                                                    |
| C220, C221             | 0.68 $\mu$ F                                                                            | 0805                                                    | Ceramic, 0.68 $\mu$ F, $\pm$ 10%, X7R<br>Voltage rating must be $> 1.8 \times V_{PVDD}$                                                                                                                                                                                                                                                                                                                                                                     |
| C200                   | 1 $\mu$ F                                                                               | 0603<br>(this body size chosen to aid in trace routing) | Ceramic, 1 $\mu$ F, $\pm$ 10%, X7R<br>Voltage rating must be $> 16$ V                                                                                                                                                                                                                                                                                                                                                                                       |
| C205, C211, C213, C212 | 1 $\mu$ F                                                                               | 0402                                                    | Ceramic, 1 $\mu$ F, 6.3 V, $\pm$ 10%, X5R                                                                                                                                                                                                                                                                                                                                                                                                                   |
| C202, C217, C352, C367 | 1 $\mu$ F                                                                               | 0805<br>(this body size chosen to aid in trace routing) | Ceramic, 1 $\mu$ F, $\pm$ 10%, X5R<br>Voltage rating must be $> 1.45 \times V_{PVDD}$                                                                                                                                                                                                                                                                                                                                                                       |
| C206, C207             | 2.2 $\mu$ F                                                                             | 0402                                                    | Ceramic, 2.2 $\mu$ F, $\pm$ 10%, X5R<br>At a minimum, voltage rating must be $> 10$ V, however higher voltage caps have been shown to have better stability under DC bias please follow the guidance provided in the TAS5756MDCAEVM for suggested values.                                                                                                                                                                                                   |
| C203, C218             | 22 $\mu$ F                                                                              | 0805                                                    | Ceramic, 22 $\mu$ F, $\pm$ 20%, X5R<br>Voltage rating must be $> 1.45 \times V_{PVDD}$                                                                                                                                                                                                                                                                                                                                                                      |
| C204, C219             | 390 $\mu$ F                                                                             | 10 $\times$ 10                                          | Aluminum, 390 $\mu$ F, $\pm$ 20%, 0.08- $\Omega$<br>Voltage rating must be $> 1.45 \times V_{PVDD}$ Anticipating that this application circuit would be followed for higher power subwoofer applications, these capacitors are added to provide local current sources for low-frequency content. These capacitors can be reduced or even removed based upon final system testing, including critical listening tests when evaluating low-frequency designs. |

### 9.2.2.2 Detailed Design Procedure

#### 9.2.2.2.1 Step One: Hardware Integration

- Using the *Typical Application Schematic* as a guide, integrate the hardware into the system schematic.
- Following the recommended component placement, board layout and routing give in the example layout above, integrate the device and its supporting components into the system PCB file.
  - The most critical section of the circuit is the power supply inputs, the amplifier output signals, and the high-frequency signals which go to the serial audio port. Constructing these signals to ensure they are given precedent as design trade-offs are made is recommended.

- For questions and support go to the E2E forums ([e2e.ti.com](http://e2e.ti.com)). If deviating from the recommended layout is necessary, go to the E2E forum to request a layout review.

#### 9.2.2.2.2 Step Two: HybridFlow Selection and System Level Tuning

- Use the *TAS5754/6M HybridFlow Processsor User Guide and HybridFlow Documentation* ([SLAU577](#)) to select the HybridFlow that meets the needs of the target application.
- Use the TAS5754\_56MEVM evaluation module and the [PurePath ControlConsole](#) (PPC) software, to load the appropriate HybridFlow. Tune the end equipment by following the instructions in the [SLAU577](#).

#### 9.2.2.2.3 Step Three: Software Integration

- Use the *Register Dump* feature of the PPC software to generate a baseline configuration file.
- Generate additional configuration files based upon operating modes of the end-equipment and integrate static configuration information into initialization files.
- Integrate dynamic controls (such as volume controls, mute commands, and mode-based EQ curves) into the main system program.

#### 9.2.2.3 Application Specific Performance Plots for Mono (PBTl) Systems

**Table 25. Relevant Performance Plots**

| PLOT TITLE                                        | FIGURE NUMBER             |
|---------------------------------------------------|---------------------------|
| Output Power vs PVDD                              | <a href="#">Figure 42</a> |
| THD+N vs Frequency, $V_{PVDD} = 12\text{ V}$      | <a href="#">Figure 43</a> |
| THD+N vs Frequency, $V_{PVDD} = 15\text{ V}$      | <a href="#">Figure 44</a> |
| THD+N vs Frequency, $V_{PVDD} = 18\text{ V}$      | <a href="#">Figure 45</a> |
| THD+N vs Frequency, $V_{PVDD} = 24\text{ V}$      | <a href="#">Figure 46</a> |
| THD+N vs Power, $V_{PVDD} = 12\text{ V}$          | <a href="#">Figure 47</a> |
| THD+N vs Power, $V_{PVDD} = 15\text{ V}$          | <a href="#">Figure 48</a> |
| THD+N vs Power, $V_{PVDD} = 18\text{ V}$          | <a href="#">Figure 49</a> |
| THD+N vs Power, $V_{PVDD} = 24\text{ V}$          | <a href="#">Figure 50</a> |
| Idle Channel Noise vs PVDD                        | <a href="#">Figure 51</a> |
| Efficiency vs Output Power                        | <a href="#">Figure 52</a> |
| Idle Current Draw (filterless) vs PVDD            | <a href="#">Figure 57</a> |
| Idle Current Draw (traditional LC filter) vs PVDD | <a href="#">Figure 58</a> |
| PVDD PSRR vs Frequency                            | <a href="#">Figure 53</a> |
| DVDD PSRR vs. Frequency                           | <a href="#">Figure 54</a> |
| AVDD PSRR vs. Frequency                           | <a href="#">Figure 55</a> |
| $C_{PVDD}$ PSRR vs. Frequency                     | <a href="#">Figure 56</a> |
| Powerdown Current Draw vs. PVDD                   | <a href="#">Figure 59</a> |

### 9.2.3 2.1 (Stereo BTL + External Mono Amplifier) Systems

Figure 90 shows the PCB Layout for the 2.1 System.

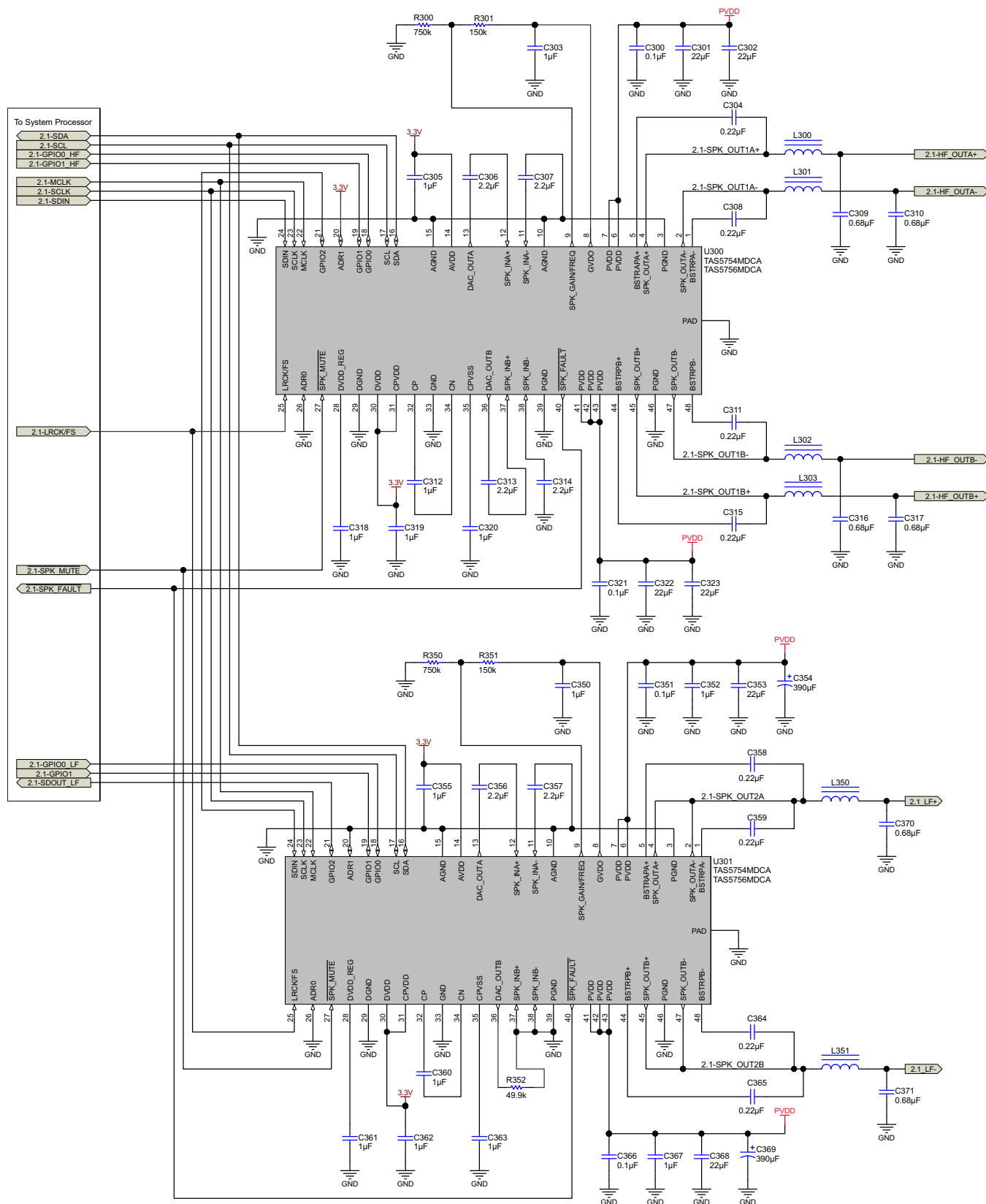
To increase the low-frequency output capabilities of an audio system, a single subwoofer can be added to the system. Because the spatial clues for audio are predominately higher frequency than that reproduced by the subwoofer, often a single subwoofer can be used to reproduce the low frequency content of several other channels in the system. This is frequently referred to as a *dot one* system. A stereo system with a subwoofer is referred to as a 2.1 (two-dot-one), a 3 channel system with subwoofer is referred to as a 3.1 (three-dot-one), a popular surround system with five speakers and one subwoofer is referred to as a 5.1, and so on.

#### 9.2.3.1 Basic 2.1 System (TAS5756M Device + Simple Digital Input Amplifier)

In the most basic 2.1 system, a subwoofer is added to a stereo left and right pair of speakers as discussed above. The audio amplifiers include one TAS5756M device for the high frequency channels and one simple digital input device without integrated audio processing for the subwoofer channel. A member of the popular TAS5760xx family of devices is a popular choice for the subwoofer amplifier. In this system, the subwoofer content is generated by summing the two channels of audio and sending them through a high-pass filter to filter out the high frequency content. This is then sent to the SDIN pin of the subwoofer amplifier, which is operating in PBTL, via the SDOUT line of the TAS5756M device. In the basic 2.1 system, only HybridFlows which included subwoofer signal generation can be used, because the subwoofer amplifier depends on the TAS5756M device to create its stereo low-frequency input signal.

#### 9.2.3.2 Advanced 2.1 System (Two TAS5756M devices)

In higher performance systems, the subwoofer output can be enhanced using digital audio processing as was done in the high-frequency channels. To accomplish this, two TAS5756M devices are used- one for the high frequency left and right speakers and one for the mono subwoofer speaker. In this system, the audio signal can be sent from the TAS5756M device through the SDOUT pin. Alternatively, the subwoofer amplifier can accept the same digital input as the stereo, which might come from a central systems processor. In advanced 2.1 systems, any HybridFlow can be used for the subwoofer, provided the sample rates for the two are the same. While any of the HybridFlows can be used, it is highly recommended that only mono HybridFlows are used for the subwoofer. Doing so streamlines development time and effort by minimizing confusion and complexity.



### 9.2.3.3 Design Requirements

- Power supplies:
  - 3.3-V supply
  - 5-V to 24-V supply
- Communication: Host processor serving as I<sup>2</sup>C compliant master
- External memory (EEPROM, flash, and others) used for coefficients and RAM portions of HybridFlow < 5 kB

The requirements for the supporting components for the TAS5756M device in a 2.1 (Stereo BTL + External Mono Amplifier) system is provided in [Table 26](#).

**Table 26. Supporting Component Requirements for 2.1 (Stereo BTL + External Mono Amplifier) Systems**

| REFERENCE DESIGNATOR                                 | VALUE                                                                                   | SIZE           | DETAILED DESCRIPTION                                                                               |
|------------------------------------------------------|-----------------------------------------------------------------------------------------|----------------|----------------------------------------------------------------------------------------------------|
| U300                                                 | TAS5756M                                                                                | 48 Pin TSSOP   | Digital-input, closed-loop class-D amplifier with HybridFlow processing                            |
| R300, R350                                           | See <a href="#">Adjustable Amplifier Gain and Switching Frequency Selection</a> section | 0402           | 1%, 0.063 W                                                                                        |
| R301, R351                                           |                                                                                         | 0402           | 1%, 0.063 W                                                                                        |
| R352                                                 |                                                                                         | 0402           | 1%, 0.063 W                                                                                        |
| L300, L301, L302, L303                               | See <a href="#">Amplifier Output Filtering</a> section                                  |                |                                                                                                    |
| L350, L351                                           |                                                                                         |                |                                                                                                    |
| C394, C395, C396, C397, C398, C399                   | 0.01 $\mu$ F                                                                            | 0603           | Ceramic, 0.01 $\mu$ F, 50 V, +/-10%, X7R                                                           |
| C300, C321, C351, C366                               | 0.1 $\mu$ F                                                                             | 0402           | Ceramic, 0.1 $\mu$ F, $\pm$ 10%, X7R<br>Voltage rating must be > $1.45 \times V_{PVDD}$            |
| C304, C308, C311, C315, C358, C359, C364, C365       | 0.22 $\mu$ F                                                                            | 0603           | Ceramic, 0.22 $\mu$ F, $\pm$ 10%, X7R<br>Voltage rating must be > $1.45 \times V_{PVDD}$           |
| C309, C310, C316, C317, C370, C371                   | 0.68 $\mu$ F                                                                            | 0805           | Ceramic, 0.68 $\mu$ F, $\pm$ 10%, X7R<br>Voltage rating must be > $1.8 \times V_{PVDD}$            |
| C303, C350, C312, C360                               | 1 $\mu$ F                                                                               | 0603           | Ceramic, 1 $\mu$ F, $\pm$ 10%, X7R<br>Voltage rating must be > $1.45 \times V_{PVDD}$              |
| C305, C318, C319, C320, C355, C361, C363, C312, C362 | 1 $\mu$ F                                                                               | 0402           | Ceramic, 1 $\mu$ F, 6.3V, $\pm$ 10%, X5R                                                           |
| C352, C367                                           | 1 $\mu$ F                                                                               | 0805           | Ceramic, 1 $\mu$ F, $\pm$ 10%, X7R<br>Voltage rating must be > $1.45 \times V_{PVDD}$              |
| C306, C307, C313, C314, C356, C357,                  | 2.2 $\mu$ F                                                                             | 0402           | Ceramic, 2.2 $\mu$ F, $\pm$ 10%, X5R<br>Voltage rating must be > $1.45 \times V_{PVDD}$            |
| C301, C302, C322, C323, C353, C368                   | 22 $\mu$ F                                                                              | 0805           | Ceramic, 22 $\mu$ F, $\pm$ 20%, X5R<br>Voltage rating must be > $1.45 \times V_{PVDD}$             |
| C354, C369                                           | 390 $\mu$ F                                                                             | 10 $\times$ 10 | Aluminum, 390 $\mu$ F, $\pm$ 20%, 0.08 $\Omega$<br>Voltage rating must be > $1.45 \times V_{PVDD}$ |

### 9.2.3.4 Detailed Design Procedure

#### 9.2.3.4.1 Step One: Hardware Integration

- Using the *Typical Application Schematic* as a guide, integrate the hardware into the system schematic.
- Following the recommended component placement, board layout and routing give in the example layout above, integrate the device and its supporting components into the system PCB file.
  - The most critical section of the circuit is the power supply inputs, the amplifier output signals, and the high-frequency signals which go to the serial audio port. Constructing these signals to ensure they are given precedent as design trade-offs are made is recommended.
  - For questions and support go to the E2E forums ([e2e.ti.com](http://e2e.ti.com)). If deviating from the recommended layout is necessary, go to the E2E forum to request a layout review.

#### 9.2.3.4.2 Step Two: HybridFlow Selection and System Level Tuning

- Use the *TAS5754/6M HybridFlow Processor User Guide and HybridFlow Documentation* ([SLAU577](#)) to select the HybridFlow that meets the needs of the target application.
- Use the TAS5754\_56MEVM evaluation module and the [PurePath ControlConsole](#) (PPC) software, to load the appropriate HybridFlow. Tune the end equipment by following the instructions in the [SLAU577](#).

#### 9.2.3.4.3 Step Three: Software Integration

- Use the *Register Dump* feature of the PPC software to generate a baseline configuration file.
- Generate additional configuration files based upon operating modes of the end-equipment and integrate static configuration information into initialization files.
- Integrate dynamic controls (such as volume controls, mute commands, and mode-based EQ curves) into the main system program.

#### 9.2.3.5 Application Specific Performance Plots for 2.1 (Stereo BTL + External Mono Amplifier) Systems

**Table 27. Relevant Performance Plots**

| DEVICE        | PLOT TITLE                                        | FIGURE NUMBER             |
|---------------|---------------------------------------------------|---------------------------|
| U300          | Output Power vs PVDD                              | <a href="#">Figure 23</a> |
|               | THD+N vs Frequency, $V_{PVDD} = 12\text{ V}$      | <a href="#">Figure 24</a> |
|               | THD+N vs Frequency, $V_{PVDD} = 15\text{ V}$      | <a href="#">Figure 25</a> |
|               | THD+N vs Frequency, $V_{PVDD} = 18\text{ V}$      | <a href="#">Figure 26</a> |
|               | THD+N vs Frequency, $V_{PVDD} = 24\text{ V}$      | <a href="#">Figure 27</a> |
|               | THD+N vs Power, $V_{PVDD} = 12\text{ V}$          | <a href="#">Figure 28</a> |
|               | THD+N vs Power, $V_{PVDD} = 15\text{ V}$          | <a href="#">Figure 29</a> |
|               | THD+N vs Power, $V_{PVDD} = 18\text{ V}$          | <a href="#">Figure 30</a> |
|               | THD+N vs Power, $V_{PVDD} = 24\text{ V}$          | <a href="#">Figure 31</a> |
|               | Idle Channel Noise vs PVDD                        | <a href="#">Figure 32</a> |
|               | Efficiency vs Output Power                        | <a href="#">Figure 33</a> |
|               | Idle Current Draw (Filterless) vs PVDD            | <a href="#">Figure 34</a> |
|               | Idle Current Draw (Traditional LC Filter) vs PVDD | <a href="#">Figure 58</a> |
| U301          | Output Power vs PVDD                              | <a href="#">Figure 42</a> |
|               | THD+N vs Frequency, $V_{PVDD} = 12\text{ V}$      | <a href="#">Figure 43</a> |
|               | THD+N vs Frequency, $V_{PVDD} = 15\text{ V}$      | <a href="#">Figure 44</a> |
|               | THD+N vs Frequency, $V_{PVDD} = 18\text{ V}$      | <a href="#">Figure 45</a> |
|               | THD+N vs Frequency, $V_{PVDD} = 24\text{ V}$      | <a href="#">Figure 46</a> |
|               | THD+N vs Power, $V_{PVDD} = 12\text{ V}$          | <a href="#">Figure 47</a> |
|               | THD+N vs Power, $V_{PVDD} = 15\text{ V}$          | <a href="#">Figure 48</a> |
|               | THD+N vs Power, $V_{PVDD} = 18\text{ V}$          | <a href="#">Figure 49</a> |
|               | THD+N vs Power, $V_{PVDD} = 24\text{ V}$          | <a href="#">Figure 50</a> |
|               | Idle Channel Noise vs PVDD                        | <a href="#">Figure 51</a> |
|               | Efficiency vs Output Power                        | <a href="#">Figure 52</a> |
|               | Idle Current Draw (filterless) vs PVDD            | <a href="#">Figure 57</a> |
|               | Idle Current Draw (traditional LC filter) vs PVDD | <a href="#">Figure 58</a> |
|               | PVDD PSRR vs Frequency                            | <a href="#">Figure 53</a> |
| U300 and U301 | DVDD PSRR vs. Frequency                           | <a href="#">Figure 38</a> |
|               | AVDD PSRR vs. Frequency                           | <a href="#">Figure 39</a> |
|               | $C_{PVDD}$ PSRR vs. Frequency                     | <a href="#">Figure 40</a> |
|               | Powerdown Current Draw vs. PVDD                   | <a href="#">Figure 41</a> |

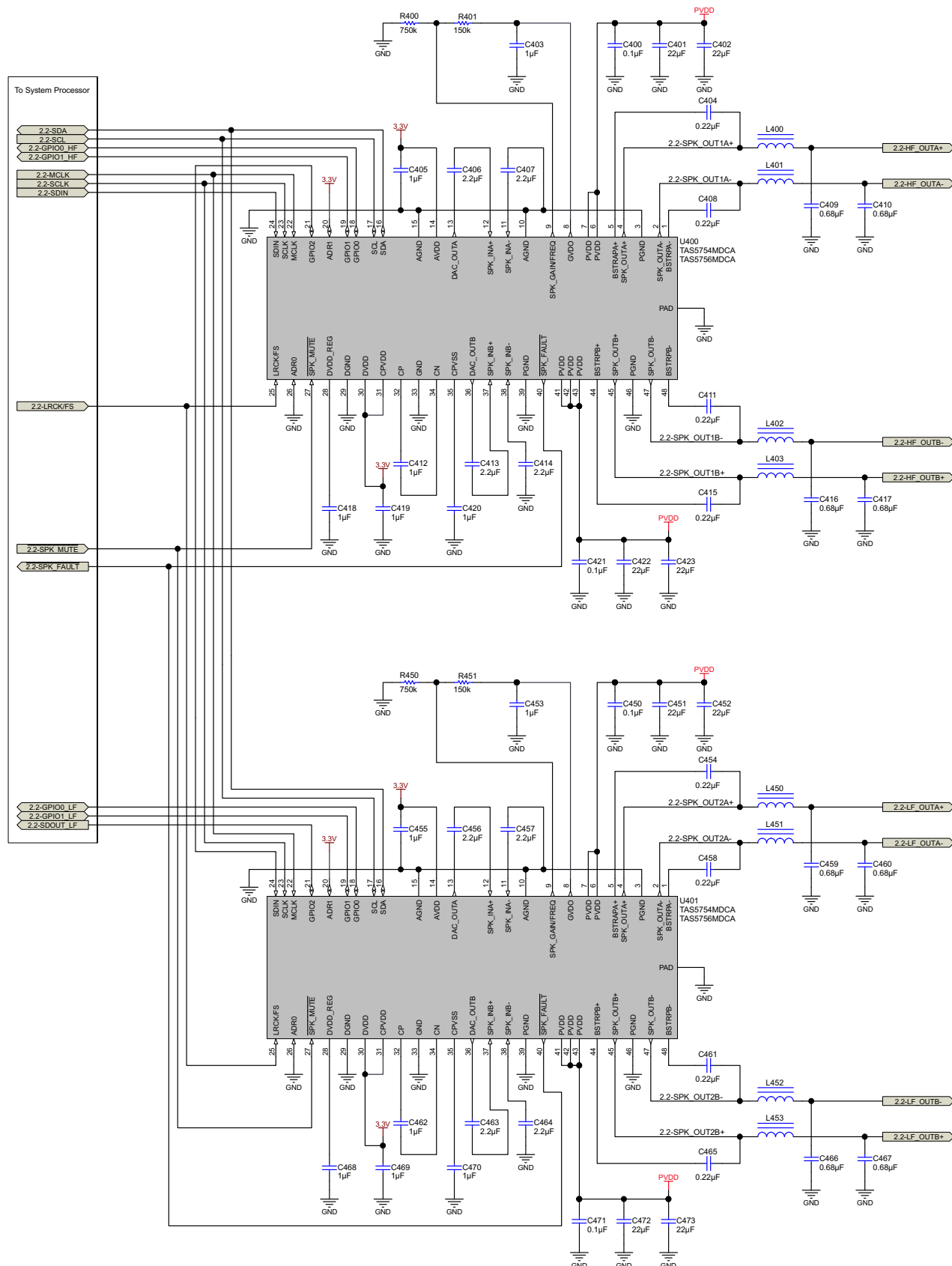
## 9.2.4 2.2 (Dual Stereo BTL) Systems

For the 2.2 (Dual Stereo BTL) PCB layout, see [Figure 92](#).

A 2.2 system consists of a stereo pair of loudspeakers with a pair of low frequency loudspeakers. In some cases, this is implemented as two stereo full-range speakers and two subwoofers. In others, it is implemented as two high frequency speakers and two mid-range speakers.

As in the case of the 2.1 system, the 2.2 system can be created by using the audio processing inside of the TAS5756M device and creating a subwoofer signal which is sent to a simple digital input amplifier like one of the TAS5760xx devices (or similar). This requires that a HybridFlow that contains a subwoofer generation processing block be used in the TAS5756M device. This signal is created by summing the left and right channel, filtering with a high-pass filter and sending it to the subwoofer amplifier. For this type of system, the TAS5756M device used for the high-frequency drivers must have a subwoofer generation processing block to provide the appropriate signal to the subwoofer amplifiers.

Alternatively, the low-frequency drivers can be driven by using two TAS5756M devices; each receiving their input from a central systems processor. This type of implementation allows for any stereo HybridFlow to be used for both the low-frequency and high-frequency drivers, increasing the processing options available for the system. This expands the processing capabilities of the system, introducing digital signal processing to the low-frequency drivers as well as the high-frequency drivers. This type of 2.2 system is described in [Figure 82](#).



### Figure 82. 2.2 (Dual Stereo BTL) Application Schematic

### 9.2.4.1 Design Requirements

- Power Supplies:
  - 3.3-V Supply
  - 5-V to 24-V Supply
- Communication: Host Processor serving as I<sup>2</sup>C Compliant Master
- External Memory (EEPROM, Flash, Etc.) used for Coefficients and RAM portions of HybridFlow < 5 kB

The requirements for the supporting components for the TAS5756M device in a 2.2 (Dual Stereo BTL) System is provided in [Figure 92](#).

**Table 28. Supporting Component Requirements for 2.2 (Dual Stereo BTL) Systems**

| REFERENCE DESIGNATOR                                       | VALUE                                                      | SIZE         | DETAILED DESCRIPTION                                                                            |
|------------------------------------------------------------|------------------------------------------------------------|--------------|-------------------------------------------------------------------------------------------------|
| U400, U401                                                 | TAS5756M device                                            | 48-pin TSSOP | Digital Input, Closed-Loop Class-D Amplifier with HybridFlow Processing                         |
| R400, R450                                                 | See <a href="#">Figure 83</a>                              | 0402         | 1%, 0.063 W                                                                                     |
| R401, R451                                                 | See <a href="#">Figure 83</a>                              | 0402         | 1%, 0.063 W                                                                                     |
| L400, L401, L402, L403, L450, L451, L452, L453             | See the <a href="#">Amplifier Output Filtering</a> section |              |                                                                                                 |
| C492, C493, C494, C495, C496, C497, C498, C499             | 0.01 $\mu$ F                                               | 0603         | Ceramic, 0.01 $\mu$ F, 50 V, $\pm$ 10%, X7R                                                     |
| C400, C421, C450, C471                                     | 0.1 $\mu$ F                                                | 0402         | Ceramic, 0.1 $\mu$ F, $\pm$ 10%, X7R, Voltage rating must be > 1.45 $\times$ V <sub>PVDD</sub>  |
| C404, C408, C411, C415, C454, C458, C461, C465             | 0.22 $\mu$ F                                               | 0603         | Ceramic, 0.22 $\mu$ F, $\pm$ 10%, X7R, Voltage rating must be > 1.45 $\times$ V <sub>PVDD</sub> |
| C409, C410, C416, C417, C459, C460, C466, C467             | 0.68 $\mu$ F                                               | 0805         | Ceramic, 0.68 $\mu$ F, $\pm$ 10%, X7R, Voltage rating must be > 1.8 $\times$ V <sub>PVDD</sub>  |
| C403, C453, C462                                           | 1 $\mu$ F                                                  | 0603         | Ceramic, 1 $\mu$ F, $\pm$ 10%, X7R, Voltage rating must be > 1.45 $\times$ V <sub>PVDD</sub>    |
| C405, C418, C419, C420, C455, C468, C469, C470, C412, C462 | 1 $\mu$ F                                                  | 0402         | Ceramic, 1 $\mu$ F, 6.3V, $\pm$ 10%, X5R                                                        |
| C406, C407, C413, C414, C456, C457, C463, C464             | 2.2 $\mu$ F                                                | 0402         | Ceramic, 2.2 $\mu$ F, $\pm$ 10%, X5R, Voltage rating must be > 1.45 $\times$ V <sub>PVDD</sub>  |
| C401, C402, C422, C423, C451, C452, C472, C473             | 22 $\mu$ F                                                 | 0805         | Ceramic, 22 $\mu$ F, $\pm$ 20%, X5R, Voltage rating must be > 1.45 $\times$ V <sub>PVDD</sub>   |

### 9.2.4.2 Detailed Design Procedure

#### 9.2.4.2.1 Step One: Hardware Integration

- Using the *Typical Application Schematic* as a guide, integrate the hardware into the system schematic.
- Following the recommended component placement, board layout and routing give in the example layout above, integrate the device and its supporting components into the system PCB file.
  - The most critical section of the circuit is the power supply inputs, the amplifier output signals, and the high-frequency signals which go to the serial audio port. Constructing these signals to ensure they are given precedent as design trade-offs are made is recommended.
  - For questions and support go to the E2E forums ([e2e.ti.com](http://e2e.ti.com)). If deviating from the recommended layout is necessary, go to the E2E forum to request a layout review.

#### 9.2.4.2.2 Step Two: HybridFlow Selection and System Level Tuning

- Use the *TAS5754/6M HybridFlow Processor User Guide and HybridFlow Documentation* ([SLAU577](#)) to select the HybridFlow that meets the needs of the target application.

- Use the TAS5754\_56MEVM evaluation module and the [PurePath ControlConsole](#) (PPC) software, to load the appropriate HybridFlow. Tune the end equipment by following the instructions in the [SLAU577](#).

#### 9.2.4.2.3 Step Three: Software Integration

- Use the *Register Dump* feature of the PPC software to generate a baseline configuration file.
- Generate additional configuration files based upon operating modes of the end-equipment and integrate static configuration information into initialization files.
- Integrate dynamic controls (such as volume controls, mute commands, and mode-based EQ curves) into the main system program.

### 9.2.4.3 Application Specific Performance Plots for 2.2 (Dual Stereo BTL) Systems

**Table 29. Relevant Performance Plots**

| PLOT TITLE                                                                   | PLOT NUMBER |
|------------------------------------------------------------------------------|-------------|
| <a href="#">Figure 23.</a> Output Power vs PVDD                              | C036        |
| <a href="#">Figure 24.</a> THD+N vs Frequency, $V_{PVDD} = 12\text{ V}$      | C034        |
| <a href="#">Figure 25.</a> THD+N vs Frequency, $V_{PVDD} = 15\text{ V}$      | C002        |
| <a href="#">Figure 26.</a> THD+N vs Frequency, $V_{PVDD} = 18\text{ V}$      | C037        |
| <a href="#">Figure 27.</a> THD+N vs Frequency, $V_{PVDD} = 24\text{ V}$      | C003        |
| <a href="#">Figure 28.</a> THD+N vs Power, $V_{PVDD} = 12\text{ V}$          | C035        |
| <a href="#">Figure 29.</a> THD+N vs Power, $V_{PVDD} = 15\text{ V}$          | C004        |
| <a href="#">Figure 30.</a> THD+N vs Power, $V_{PVDD} = 18\text{ V}$          | C038        |
| <a href="#">Figure 31.</a> THD+N vs Power, $V_{PVDD} = 24\text{ V}$          | C005        |
| <a href="#">Figure 32.</a> Idle Channel Noise vs PVDD                        | C006        |
| <a href="#">Figure 33.</a> Efficiency vs Output Power                        | C007        |
| <a href="#">Figure 34.</a> Idle Current Draw (Filterless) vs PVDD            | C013        |
| <a href="#">Figure 35.</a> Idle Current Draw (Traditional LC Filter) vs PVDD | C015        |
| <a href="#">Figure 38.</a> DVDD PSRR vs. Frequency                           | C028        |
| <a href="#">Figure 39.</a> AVDD PSRR vs. Frequency                           | C029        |
| <a href="#">Figure 40.</a> $C_{PVDD}$ PSRR vs. Frequency                     | C030        |
| <a href="#">Figure 41.</a> Powerdown Current Draw vs. PVDD                   | C032        |

### 9.2.5 1.1 (Dual BTL, Bi-Amped) Systems

The 1.1 use case is a special application of the 2.0 stereo BTL system. In this system, two channels of an amplifier are used to reproduce a single channel of an audio signal that has been separated based on frequency. This configuration removes the need for passive cross-over elements inside of a loudspeaker, because the signal is separated into a low-frequency and a high-frequency component before it is amplified. Systems which operate in this configuration, in which separate amplifier channels drive the low and high-frequency loudspeakers directly, are often called “bi-amped” systems.

Popular applications for this configuration include:

- Powered near-field monitors
- Blue-tooth Speakers
- Co-axial Loudspeakers
- Surround/Fill Speakers for multi-channel audio

From a hardware perspective, the TAS5756M device is configured in the same way as the Stereo BTL system. However, special HybridFlows which support 1.1 operation must be used, because HybridFlows that are designed for stereo applications frequently apply the same equalizer curves to the left and the right hand channel. Additionally, many 1.1 HybridFlows include a delay element which can improve time alignment between two loudspeakers that are mounted on the same baffle some distance apart.

For the 1.1 (Dual BTL, Bi-Amped) PCB layout, see [Figure 94](#).

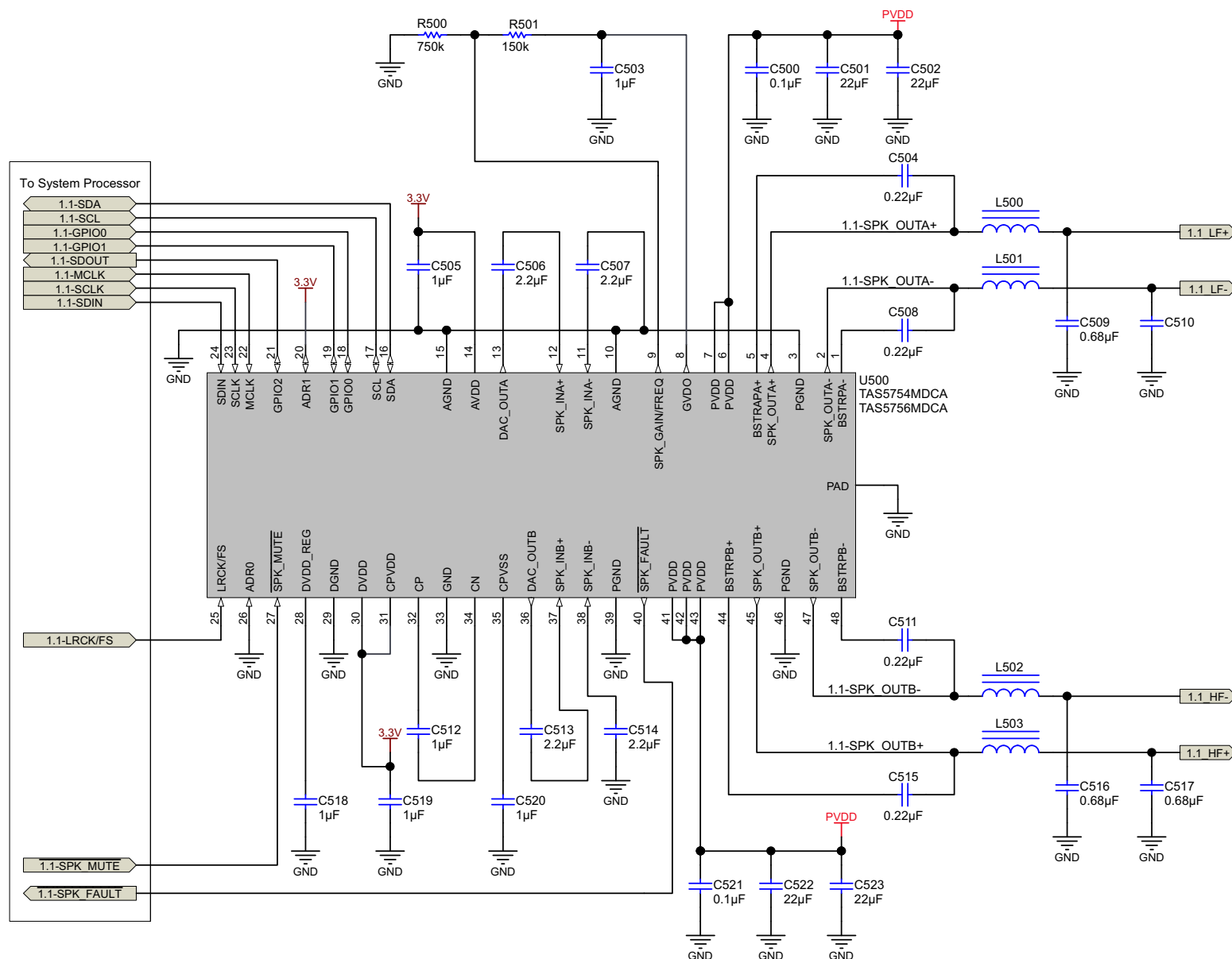


Figure 83. 1.1 (Dual BTL, Bi-Amped) Application Schematic

### 9.2.5.1 Design Requirements

- Power Supplies:
  - DVDD Supply, in compliance with the voltage ranges shown in the [Recommended Operating Conditions](#) table.
  - PVDD Supply, in compliance with the voltage ranges shown in the [Recommended Operating Conditions](#) table.
- Communication: Host Processor serving as I<sup>2</sup>C Compliant Master
- External Memory (EEPROM, Flash, Etc.) used for Coefficients and RAM portions of HybridFlow < 5 kB

The requirements for the supporting components for the TAS5756M device in a Dual BTL, Bi-Amped System is provided in [Figure 94](#).

**Table 30. Supporting Component Requirements for 1.1 (Dual BTL, Bi-Amped) Systems**

| REFERENCE DESIGNATOR         | VALUE                                                                                   | SIZE         | DETAILED DESCRIPTION                                                                              |
|------------------------------|-----------------------------------------------------------------------------------------|--------------|---------------------------------------------------------------------------------------------------|
| U500                         | TAS5756M                                                                                | 48 Pin TSSOP | Digital-input, closed-loop class-D amplifier with HybridFlow processing                           |
| R500                         | See <a href="#">Adjustable Amplifier Gain and Switching Frequency Selection</a> section | 0402         | 1%, 0.063 W                                                                                       |
| R501                         |                                                                                         | 0402         | 1%, 0.063 W                                                                                       |
| L500, L501, L502, L503       | See <a href="#">Amplifier Output Filtering</a> section                                  |              |                                                                                                   |
| C596, C597, C598, C599       | 0.01 $\mu$ F                                                                            | 0603         | Ceramic, 0.01 $\mu$ F, 50 V, $\pm$ 10%, X7R                                                       |
| C500, C521                   | 0.1 $\mu$ F                                                                             | 0402         | Ceramic, 0.1 $\mu$ F, $\pm$ 10%, X7R<br>Voltage rating must be > 1.45 $\times$ V <sub>PVDD</sub>  |
| C504, C508, C511, C515       | 0.22 $\mu$ F                                                                            | 0603         | Ceramic, 0.22 $\mu$ F, $\pm$ 10%, X7R<br>Voltage rating must be > 1.45 $\times$ V <sub>PVDD</sub> |
| C509, C510, C516, C517       | 0.68 $\mu$ F                                                                            | 0805         | Ceramic, 0.68 $\mu$ F, $\pm$ 10%, X7R<br>Voltage rating must be > 1.8 $\times$ V <sub>PVDD</sub>  |
| C503                         | 1 $\mu$ F                                                                               | 0603         | Ceramic, 1 $\mu$ F, $\pm$ 10%, X7R<br>Voltage rating must be > 1.45 $\times$ V <sub>PVDD</sub>    |
| C505, C518, C519, C520, C512 | 1 $\mu$ F                                                                               | 0402         | Ceramic, 1 $\mu$ F, 6.3V, $\pm$ 10%, X5R                                                          |
| C506, C507, C513, C514       | 2.2 $\mu$ F                                                                             | 0402         | Ceramic, 2.2 $\mu$ F, $\pm$ 10%, X5R<br>Voltage rating must be > 1.45 $\times$ V <sub>PVDD</sub>  |
| C501, C502, C522, C523       | 22 $\mu$ F                                                                              | 805          | Ceramic, 22 $\mu$ F, $\pm$ 20%, X5R<br>Voltage rating must be > 1.45 $\times$ V <sub>PVDD</sub>   |

### 9.2.5.2 Detailed Design Procedure

#### 9.2.5.2.1 Step One: Hardware Integration

- Using the *Typical Application Schematic* as a guide, integrate the hardware into the system schematic.
- Following the recommended component placement, board layout and routing give in the example layout above, integrate the device and its supporting components into the system PCB file.
  - The most critical section of the circuit is the power supply inputs, the amplifier output signals, and the high-frequency signals which go to the serial audio port. Constructing these signals to ensure they are given precedent as design trade-offs are made is recommended.
  - For questions and support go to the E2E forums ([e2e.ti.com](#)). If deviating from the recommended layout is necessary, go to the E2E forum to request a layout review.

#### 9.2.5.2.2 Step Two: HybridFlow Selection and System Level Tuning

- Use the *TAS5754/6M HybridFlow Processor User Guide and HybridFlow Documentation* ([SLAU577](#)) to select the HybridFlow that meets the needs of the target application.
- Use the TAS5754\_56MEVM evaluation module and the [PurePath ControlConsole](#) (PPC) software, to load the appropriate HybridFlow. Tune the end equipment by following the instructions in the [SLAU577](#).

### 9.2.5.2.3 Step Three: Software Integration

- Use the *Register Dump* feature of the PPC software to generate a baseline configuration file.
- Generate additional configuration files based upon operating modes of the end-equipment and integrate static configuration information into initialization files.
- Integrate dynamic controls (such as volume controls, mute commands, and mode-based EQ curves) into the main system program.

### 9.2.5.3 Application Specific Performance Plots for 1.1 (Dual BTL, Bi-Amped) Systems

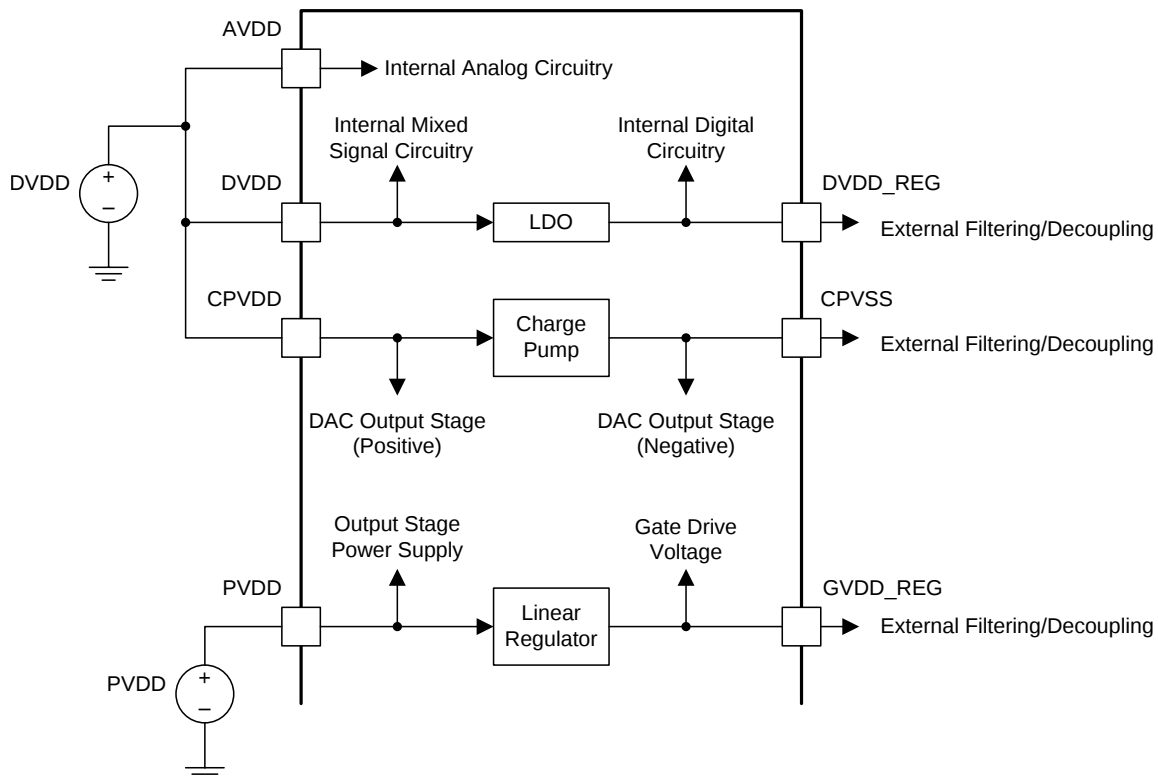
**Table 31. Relevant Performance Plots**

| PLOT TITLE                                                                   | PLOT NUMBER |
|------------------------------------------------------------------------------|-------------|
| <a href="#">Figure 23.</a> Output Power vs PVDD                              | C036        |
| <a href="#">Figure 24.</a> THD+N vs Frequency, $V_{PVDD} = 12\text{ V}$      | C034        |
| <a href="#">Figure 25.</a> THD+N vs Frequency, $V_{PVDD} = 15\text{ V}$      | C002        |
| <a href="#">Figure 26.</a> THD+N vs Frequency, $V_{PVDD} = 18\text{ V}$      | C037        |
| <a href="#">Figure 27.</a> THD+N vs Frequency, $V_{PVDD} = 24\text{ V}$      | C003        |
| <a href="#">Figure 28.</a> THD+N vs Power, $V_{PVDD} = 12\text{ V}$          | C035        |
| <a href="#">Figure 29.</a> THD+N vs Power, $V_{PVDD} = 15\text{ V}$          | C004        |
| <a href="#">Figure 30.</a> THD+N vs Power, $V_{PVDD} = 18\text{ V}$          | C038        |
| <a href="#">Figure 31.</a> THD+N vs Power, $V_{PVDD} = 24\text{ V}$          | C005        |
| <a href="#">Figure 32.</a> Idle Channel Noise vs PVDD                        | C006        |
| <a href="#">Figure 33.</a> Efficiency vs Output Power                        | C007        |
| <a href="#">Figure 34.</a> Idle Current Draw (Filterless) vs PVDD            | C013        |
| <a href="#">Figure 35.</a> Idle Current Draw (Traditional LC Filter) vs PVDD | C015        |
| <a href="#">Figure 38.</a> DVDD PSRR vs. Frequency                           | C028        |
| <a href="#">Figure 39.</a> AVDD PSRR vs. Frequency                           | C029        |
| <a href="#">Figure 40.</a> $C_{PVDD}$ PSRR vs. Frequency                     | C030        |
| <a href="#">Figure 41.</a> Powerdown Current Draw vs. PVDD                   | C032        |

## 10 Power Supply Recommendations

### 10.1 Power Supplies

The TAS5756M device requires two power supplies for proper operation. A *high-voltage* supply called PVDD is required to power the output stage of the speaker amplifier and its associated circuitry. Additionally, one *low-voltage* power supply called DVDD is required to power the various low-power portions of the device. The allowable voltage range for both the PVDD and the DVDD supply are listed in the [Recommended Operating Conditions](#) table.



**Figure 84. Power Supply Functional Block Diagram**

#### 10.1.1 DVDD Supply

The DVDD supply required from the system is used to power several portions of the device. As shown in the [Figure 84](#), it provides power to the DVDD pin, the CPVDD pin, and the AVDD pin. Proper connection, routing, and decoupling techniques are highlighted in the TAS5756M device *EVM User's Guide* [SLAU583](#) (as well as the [Application and Implementation](#) section and [Layout Example](#) section) and must be followed as closely as possible for proper operation and performance. Deviation from the guidance offered in the TAS5756M device *EVM User's Guide*, which followed the same techniques as those shown in the [Application and Implementation](#) section, may result in reduced performance, errant functionality, or even damage to the TAS5756M device.

Some portions of the device also require a separate power supply which is a lower voltage than the DVDD supply. To simplify the power supply requirements for the system, the TAS5756M device includes an integrated low-dropout (LDO) linear regulator to create this supply. This linear regulator is internally connected to the DVDD supply and its output is presented on the DVDD\_REG pin, providing a connection point for an external bypass capacitor. It is important to note that the linear regulator integrated in the device has only been designed to support the current requirements of the internal circuitry, and should not be used to power any additional external circuitry. Additional loading on this pin could cause the voltage to sag, negatively affecting the performance and operation of the device.

## Power Supplies (continued)

The outputs of the high-performance DACs used in the TAS5756M device are ground centered, requiring both a positive low-voltage supply and a negative low-voltage supply. The positive power supply for the DAC output stage is taken from the AVDD pin, which is connected to the DVDD supply provided by the system. A charge pump is integrated in the TAS5756M device to generate the negative low-voltage supply. The power supply input for the charge pump is the CPVDD pin. The CPVSS pin is provided to allow the connection of a filter capacitor on the negative low-voltage supply. As is the case with the other supplies, the component selection, placement, and routing of the external components for these low voltage supplies are shown in the TAS5756MDCAEVM and should be followed as closely as possible to ensure proper operation of the device.

### 10.1.2 PVDD Supply

The output stage of the speaker amplifier drives the load using the PVDD supply. This is the power supply which provides the drive current to the load during playback. Proper connection, routing, and decoupling techniques are highlighted in the TAS5756MDCAEVM and must be followed as closely as possible for proper operation and performance. Due the high-voltage switching of the output stage, it is particularly important to properly decouple the output power stages in the manner described in the TAS5756M device *EVM User's Guide*. Lack of proper decoupling, like that shown in the *EVM User's Guide*, results in voltage spikes which can damage the device.

A separate power supply is required to drive the gates of the MOSFETs used in the output stage of the speaker amplifier. This power supply is derived from the PVDD supply via an integrated linear regulator. A GVDD\_REG pin is provided for the attachment of decoupling capacitor for the gate drive voltage regulator. It is important to note that the linear regulator integrated in the device has only been designed to support the current requirements of the internal circuitry, and should not be used to power any additional external circuitry. Additional loading on this pin could cause the voltage to sag, negatively affecting the performance and operation of the device.

## 11 Layout

### 11.1 Layout Guidelines

#### 11.1.1 General Guidelines for Audio Amplifiers

Audio amplifiers which incorporate switching output stages must have special attention paid to their layout and the layout of the supporting components used around them. The system level performance metrics, including thermal performance, electromagnetic compliance (EMC), device reliability, and audio performance are all affected by the device and supporting component layout.

Ideally, the guidance provided in the applications section with regard to device and component selection can be followed by precise adherence to the layout guidance shown in . These examples represent exemplary *baseline* balance of the engineering trade-offs involved with laying out the device. These designs can be modified slightly as needed to meet the needs of a given application. In some applications, for instance, solution size can be compromised to improve thermal performance through the use of additional contiguous copper near the device. Conversely, EMI performance can be prioritized over thermal performance by routing on internal traces and incorporating a via picket-fence and additional filtering components. In all cases, it is recommended to start from the guidance shown in the [Layout Example](#) section and the TAS5754M-56MEVM, and work with TI field application engineers or through the [E2E](#) community to modify it based upon the application specific goals.

#### 11.1.2 Importance of PVDD Bypass Capacitor Placement on PVDD Network

Placing the bypassing and decoupling capacitors close to supply has been long understood in the industry. This applies to DVDD, AVDD, CPVDD, and PVDD. However, the capacitors on the PVDD net for the TAS5756M device deserve special attention.

It is imperative that the small bypass capacitors on the PVDD lines of the DUT be placed as close the PVDD pins as possible. Not only does placing these devices far away from the pins increase the electromagnetic interference in the system, but doing so can also negatively affect the reliability of the device. Placement of these components too far from the TAS5756M device may cause ringing on the output pins that can cause the voltage on the output pin to exceed the maximum allowable ratings shown in the *Absolute Maximum Ratings* table, damaging the device. For that reason, the capacitors on the PVDD net must be no further away from their associated PVDD pins than what is shown in the example layouts in the [Layout Example](#) section

#### 11.1.3 Optimizing Thermal Performance

Follow the layout examples shown in the [Layout Example](#) section of this document to achieve the best balance of solution size, thermal, audio, and electromagnetic performance. In some cases, deviation from this guidance may be required due to design constraints which cannot be avoided. In these instances, the system designer should ensure that the heat can get out of the device and into the ambient air surrounding the device. Fortunately, the heat created in the device would prefer to travel away from the device and into the lower temperature structures around the device.

##### 11.1.3.1 Device, Copper, and Component Layout

Primarily, the goal of the PCB design is to minimize the thermal impedance in the path to those cooler structures. These tips should be followed to achieve that goal:

- Avoid placing other heat producing components or structures near the amplifier (including above or below in the end equipment).
- If possible, use a higher layer count PCB to provide more heat sinking capability for the TAS5756M device and to prevent traces and copper signal and power planes from breaking up the contiguous copper on the top and bottom layer.
- Place the TAS5756M device away from the edge of the PCB when possible to ensure that heat can travel away from the device on all four sides.
- Avoid cutting off the flow of heat from the TAS5756M device to the surrounding areas with traces or via strings. Instead, route traces perpendicular to the device and line up vias in columns which are perpendicular to the device.
- Unless the area between two pads of a passive component is large enough to allow copper to flow in between the two pads, orient it so that the narrow end of the passive component is facing the TAS5756M device.

## Layout Guidelines (continued)

- Because the ground pins are the best conductors of heat in the package, maintain a contiguous ground plane from the ground pins to the PCB area surrounding the device for as many of the ground pins as possible.

### 11.1.3.2 Stencil Pattern

The recommended drawings for the TAS5756M device PCB foot print and associated stencil pattern are shown at the end of this document in the package addendum. Additionally, baseline recommendations for the via arrangement under and around the device are given as a starting point for the PCB design. This guidance is provided to suit the majority of manufacturing capabilities in the industry and prioritizes manufacturability over all other performance criteria. In elevated ambient temperatures or under high-power dissipation use-cases, this guidance may be too conservative and advanced PCB design techniques may be used to improve thermal performance of the system. It is important to note that the customer must verify that deviation from the guidance shown in the package addendum, including the deviation explained in this section, meets the customer's quality, reliability, and manufacturability goals.

#### 11.1.3.2.1 PCB footprint and Via Arrangement

The PCB footprint (also known as a *symbol* or *land pattern*) communicates to the PCB fabrication vendor the shape and position of the copper patterns to which the TAS5756M device will be soldered. This footprint can be followed directly from the guidance in the package addendum at the end of this data sheet. It is important to make sure that the thermal pad, which connects electrically and thermally to the PowerPAD of the TAS5756M device, be made no smaller than what is specified in the package addendum. This ensures that the TAS5756M device has the largest interface possible to move heat from the device to the board.

The via pattern shown in the package addendum provides an improved interface to carry the heat from the device through to the layers of the PCB, because small diameter plated vias (with minimally-sized annular rings) present a low thermal-impedance path from the device into the PCB. Once into the PCB, the heat travels away from the device and into the surrounding structures and air. By increasing the number of vias, as shown in the [Layout Example](#) section, this interface can benefit from improved thermal performance.

#### NOTE

Vias can obstruct heat flow if they are not constructed properly.

- Remove thermal reliefs on thermal vias, because they impede the flow of heat through the via.
- Vias filled with thermally conductive material are best, but a simple plated via can be used to avoid the additional cost of filled vias.
- The drill diameter of 8 mils or less. Also, the distance between the via barrel and the surrounding planes should be minimized to help heat flow from the via into the surrounding copper material. In all cases, minimum spacing should be determined by the voltages present on the planes surrounding the via and minimized wherever possible.
- Vias should be arranged in columns, which extend in a line radially from the heat source to the surrounding area. This arrangement is shown in the [Layout Example](#) section.
- Ensure that vias do not cut-off power current flow from the power supply through the planes on internal layers. If needed, remove some vias which are farthest from the TAS5756M device to open up the current path to and from the device.

#### 11.1.3.2.1.1 Solder Stencil

During the PCB assembly process, a piece of metal called a *stencil* on top of the PCB and deposits solder paste on the PCB wherever there is an opening (called an aperture) in the stencil. The stencil determines the quantity and the location of solder paste that is applied to the PCB in the electronic manufacturing process. In most cases, the aperture for each of the component pads is almost the same size as the pad itself.

However, the thermal pad on the PCB is quite large and depositing a large, single deposition of solder paste would lead to manufacturing issues. Instead, the solder is applied to the board in multiple apertures, to allow the solder paste to outgas during the assembly process and reduce the risk of solder bridging under the device. This structure is called an aperture array, and is shown in the [Layout Example](#) section. It is important that the total area of the aperture array (the area of all of the small apertures combined) covers between 70% and 80% of the area of the thermal pad itself.

## 11.2 Layout Example

### 11.2.1 2.0 (Stereo BTL) System

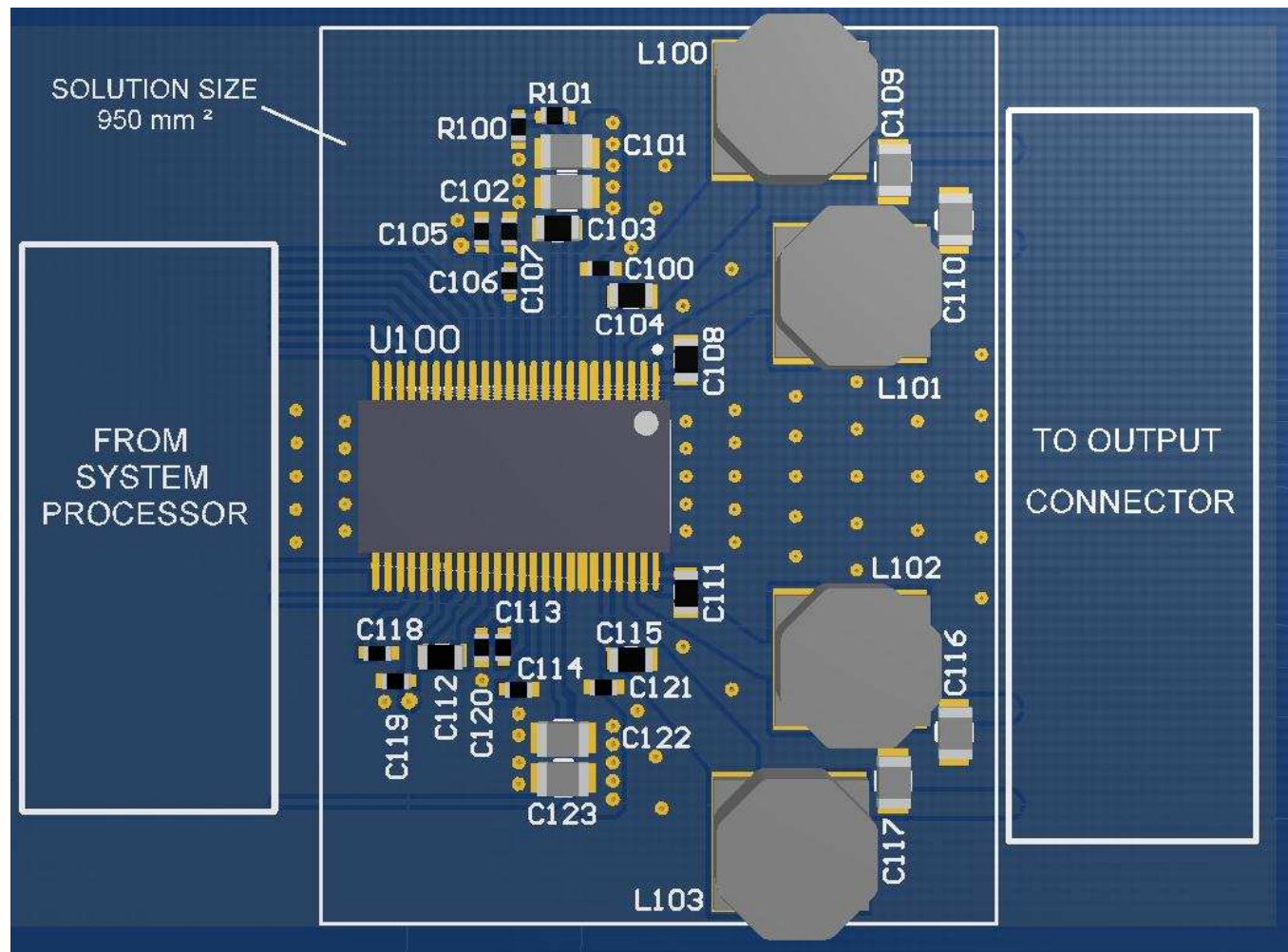


Figure 85. 2.0 (Stereo BTL) 3-D View

## Layout Example (continued)

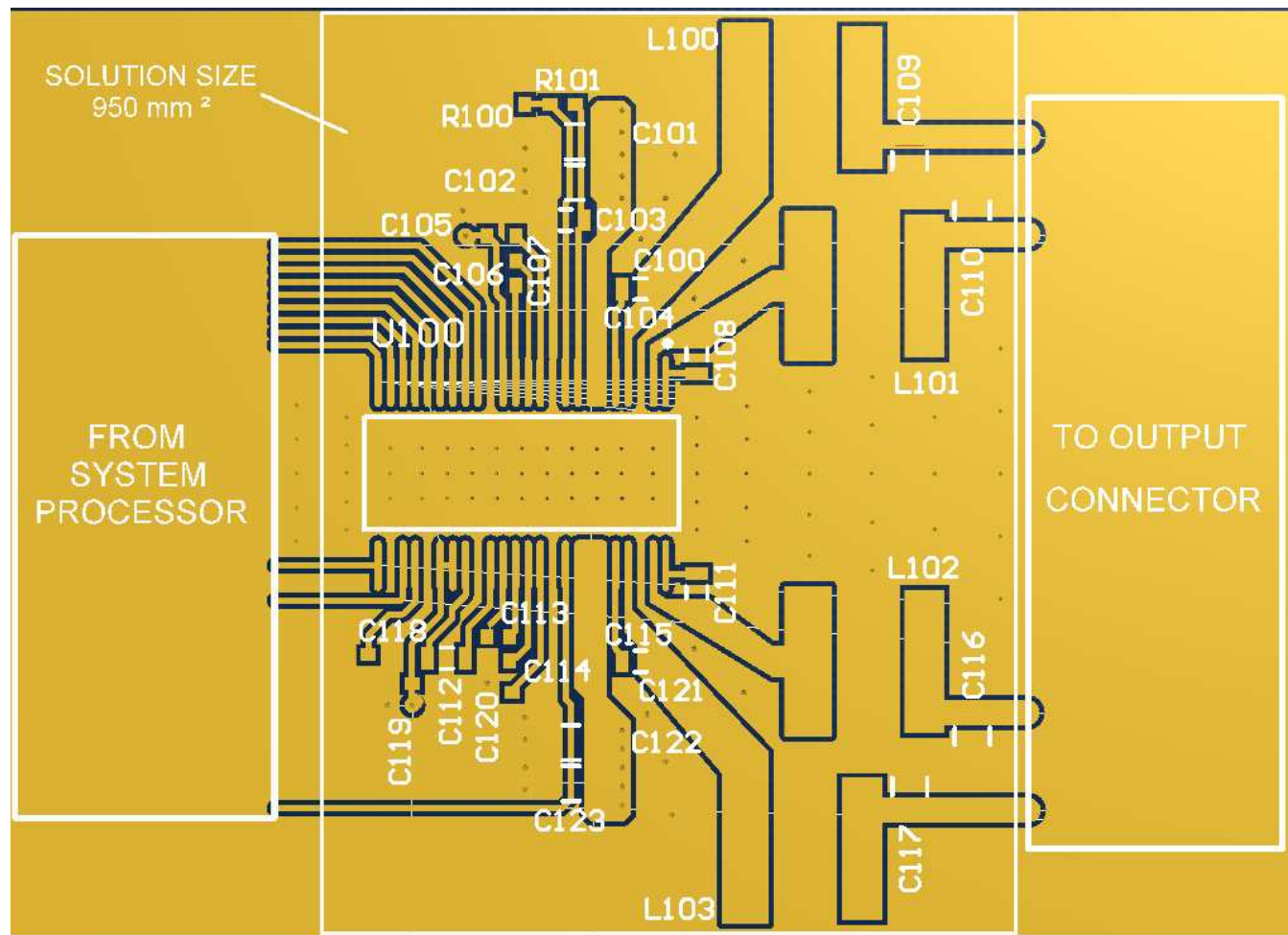
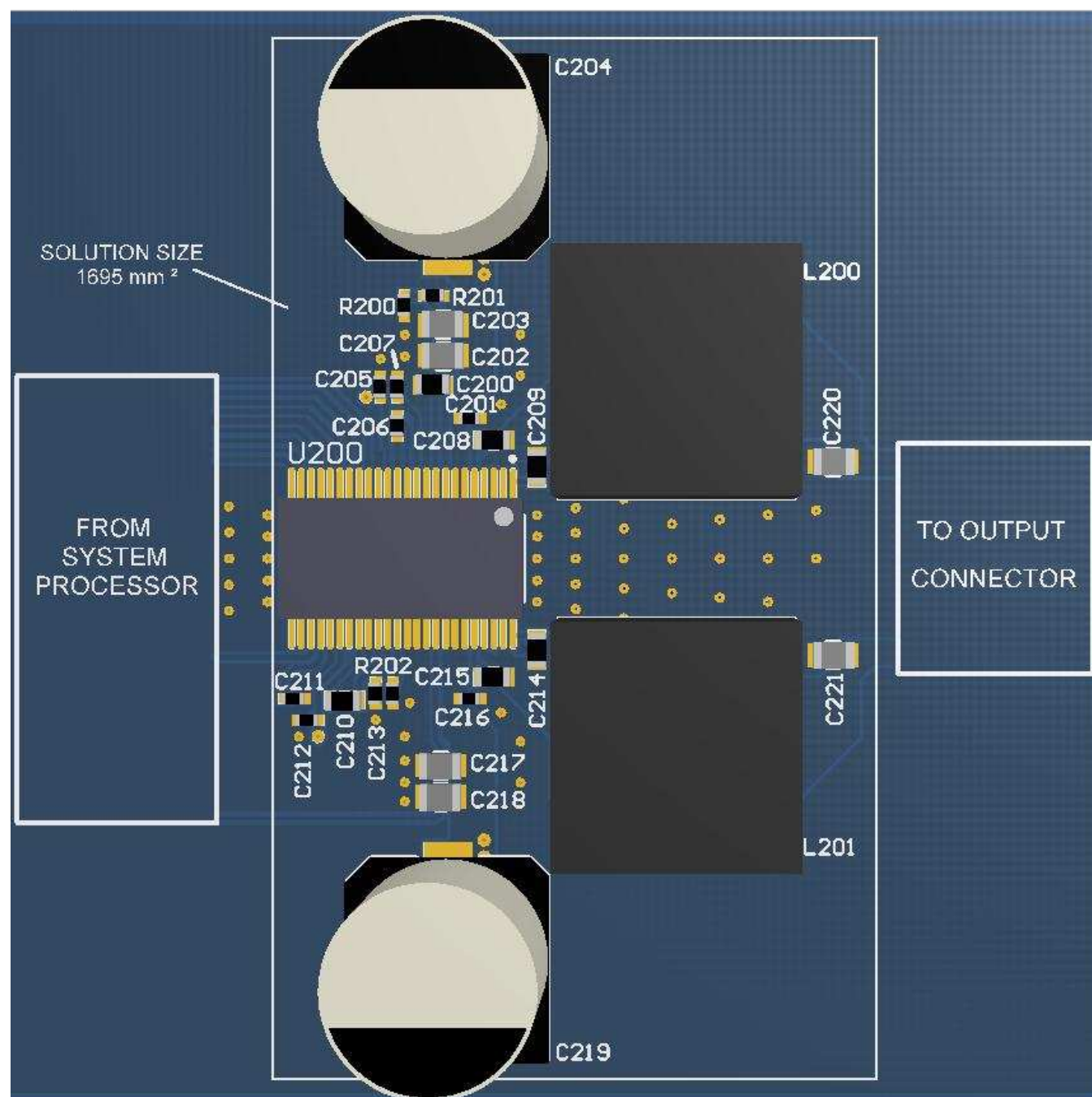


Figure 86. 2.0 (Stereo BTL) Top Copper View

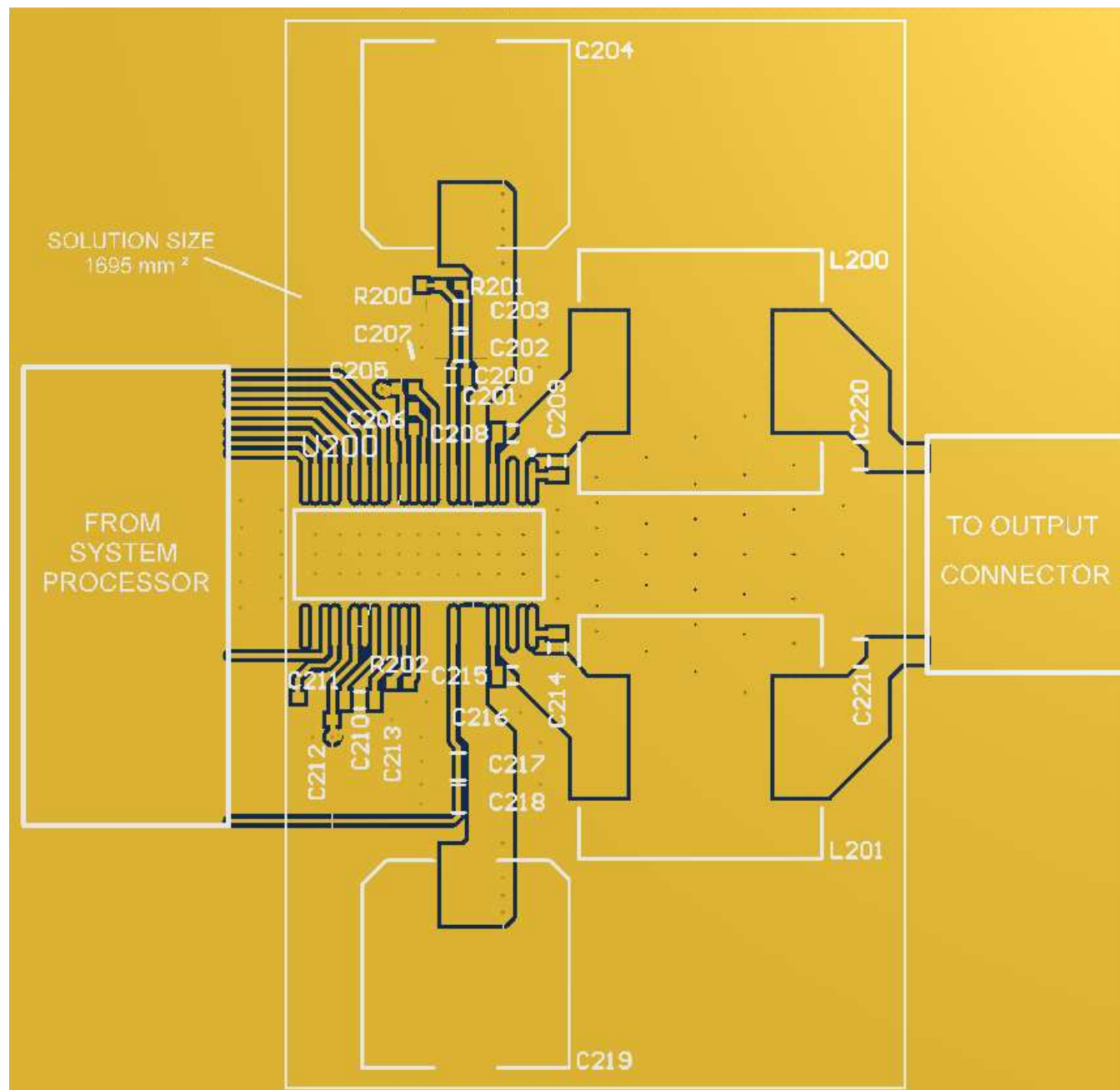
## Layout Example (continued)

### 11.2.2 Mono (PBTL) System



**Figure 87. Mono (PBTL) 3-D View**

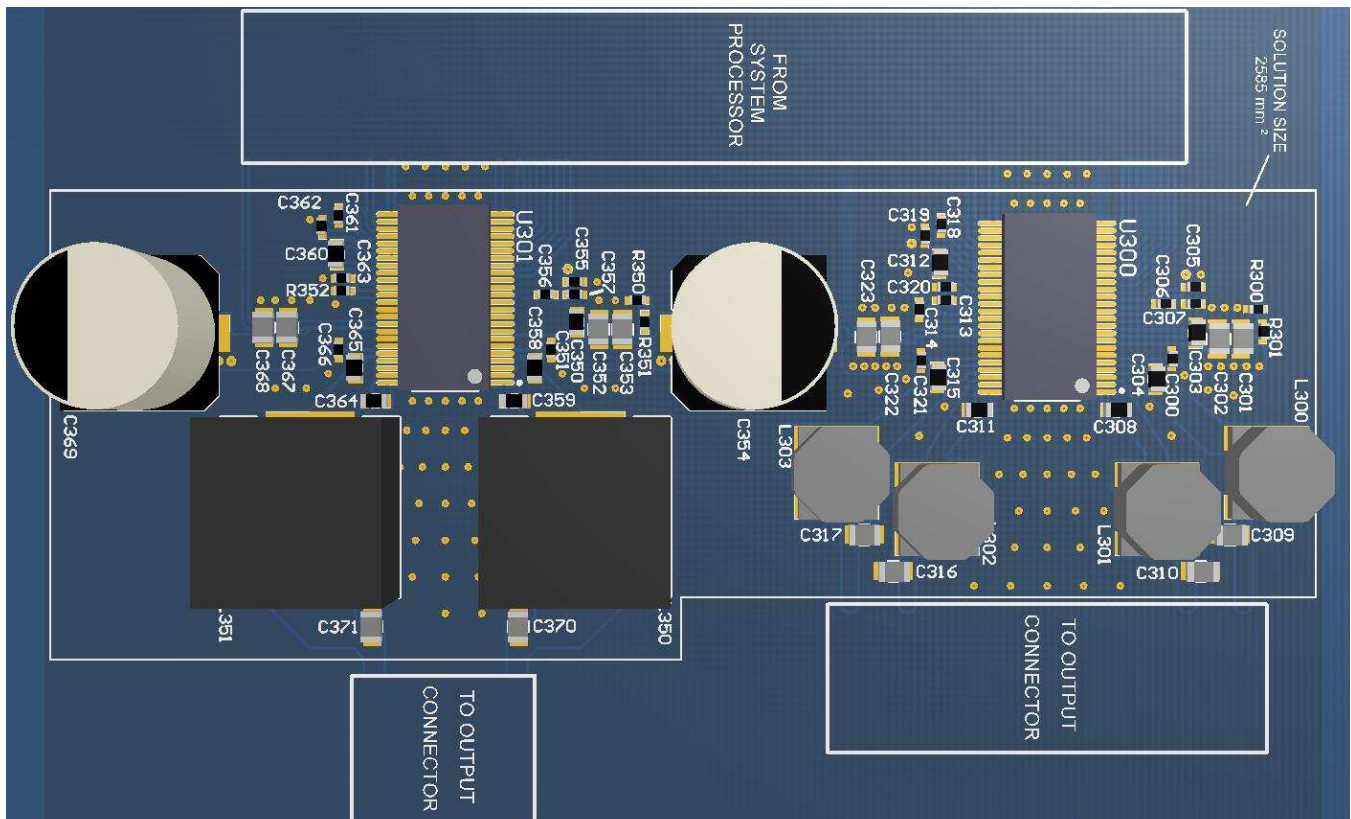
## Layout Example (continued)



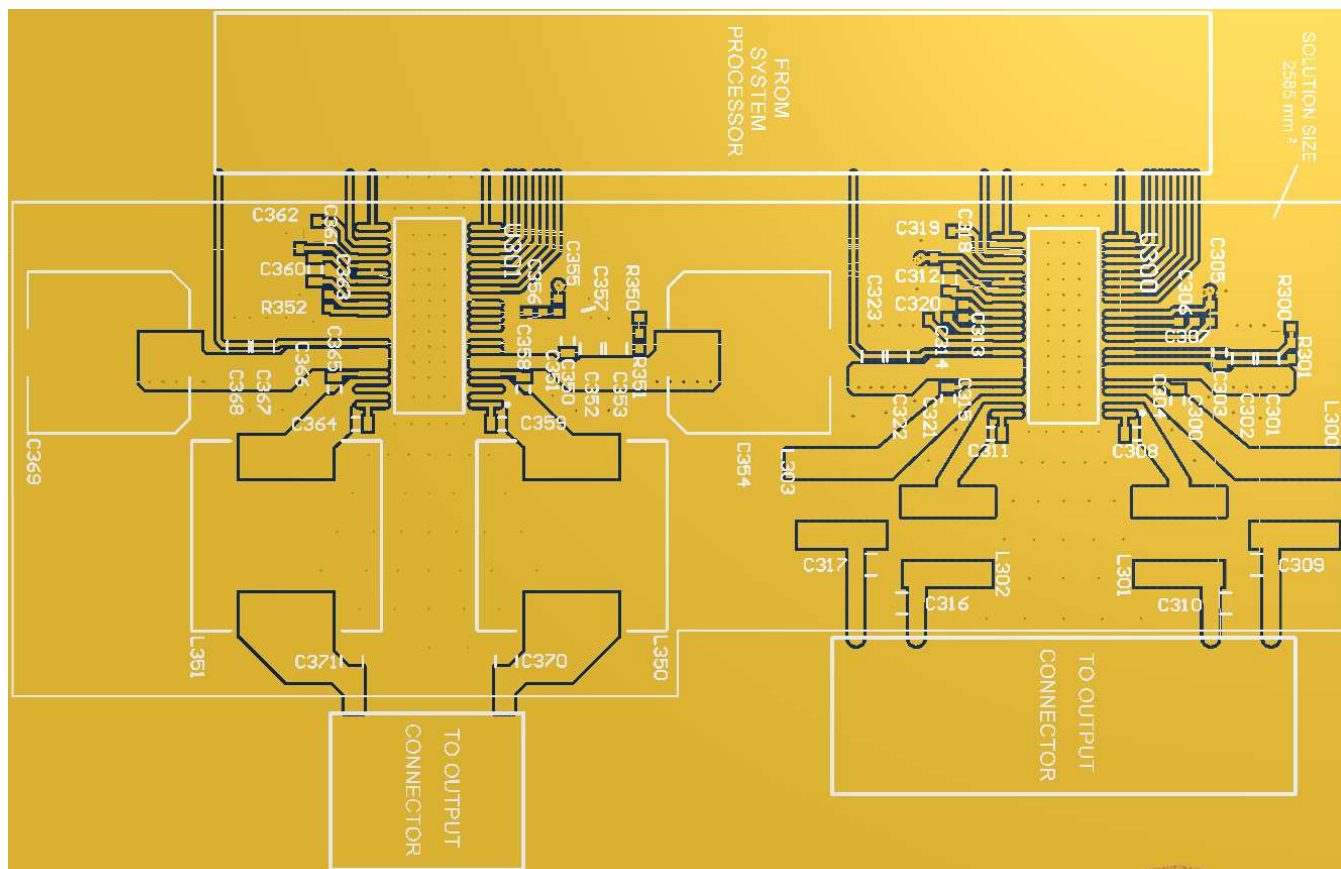
**Figure 88. Mono (PBTL) Top Copper View**

## Layout Example (continued)

### 11.2.3 2.1 (Stereo BTL + Mono PBTL) Systems



**Figure 89. 2.1 (Stereo BTL + Mono PBTL) 3-D View**



**Figure 90. 2.1 (Stereo BTL + Mono PBTl) Top Copper View**



## Layout Example (continued)

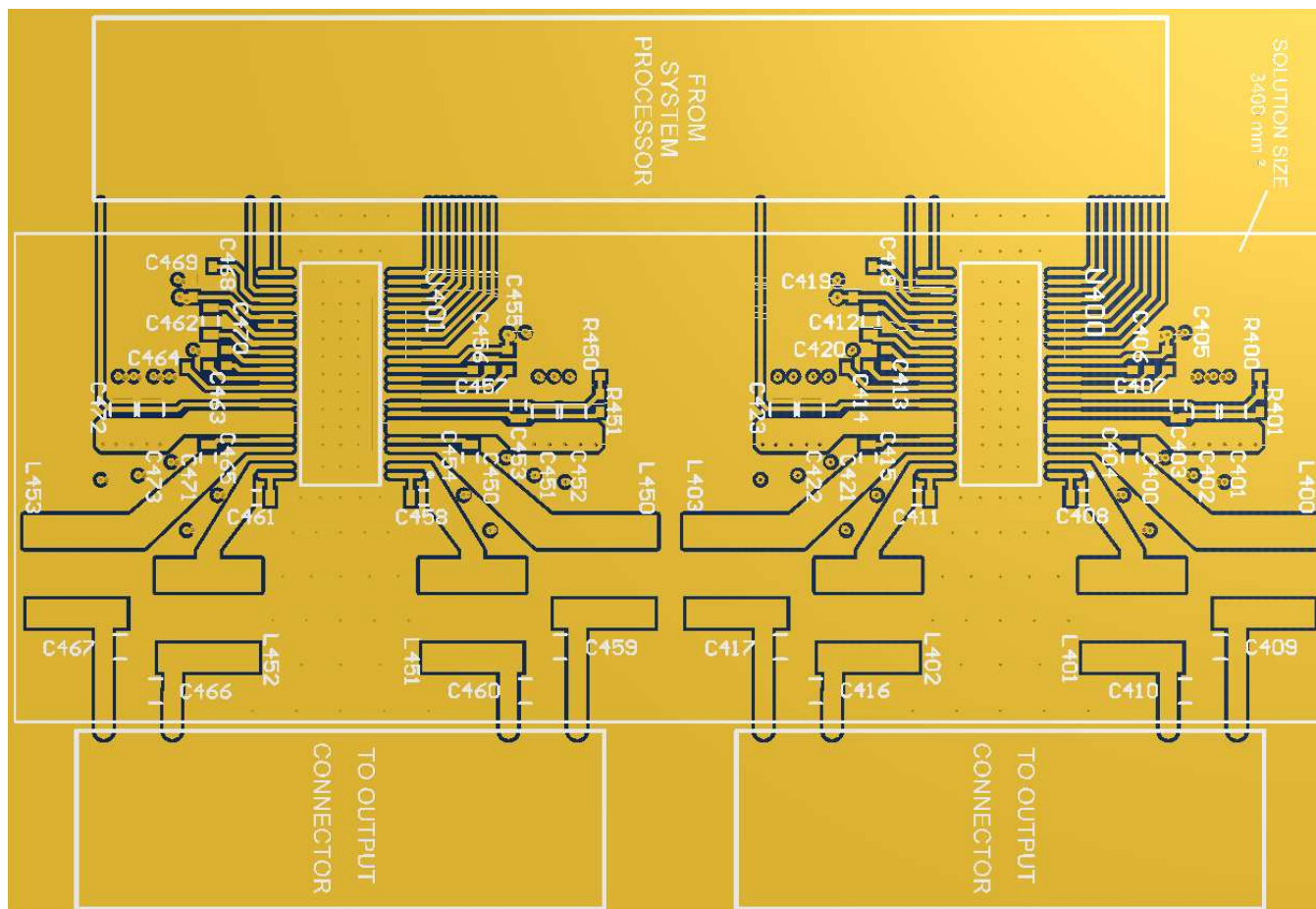
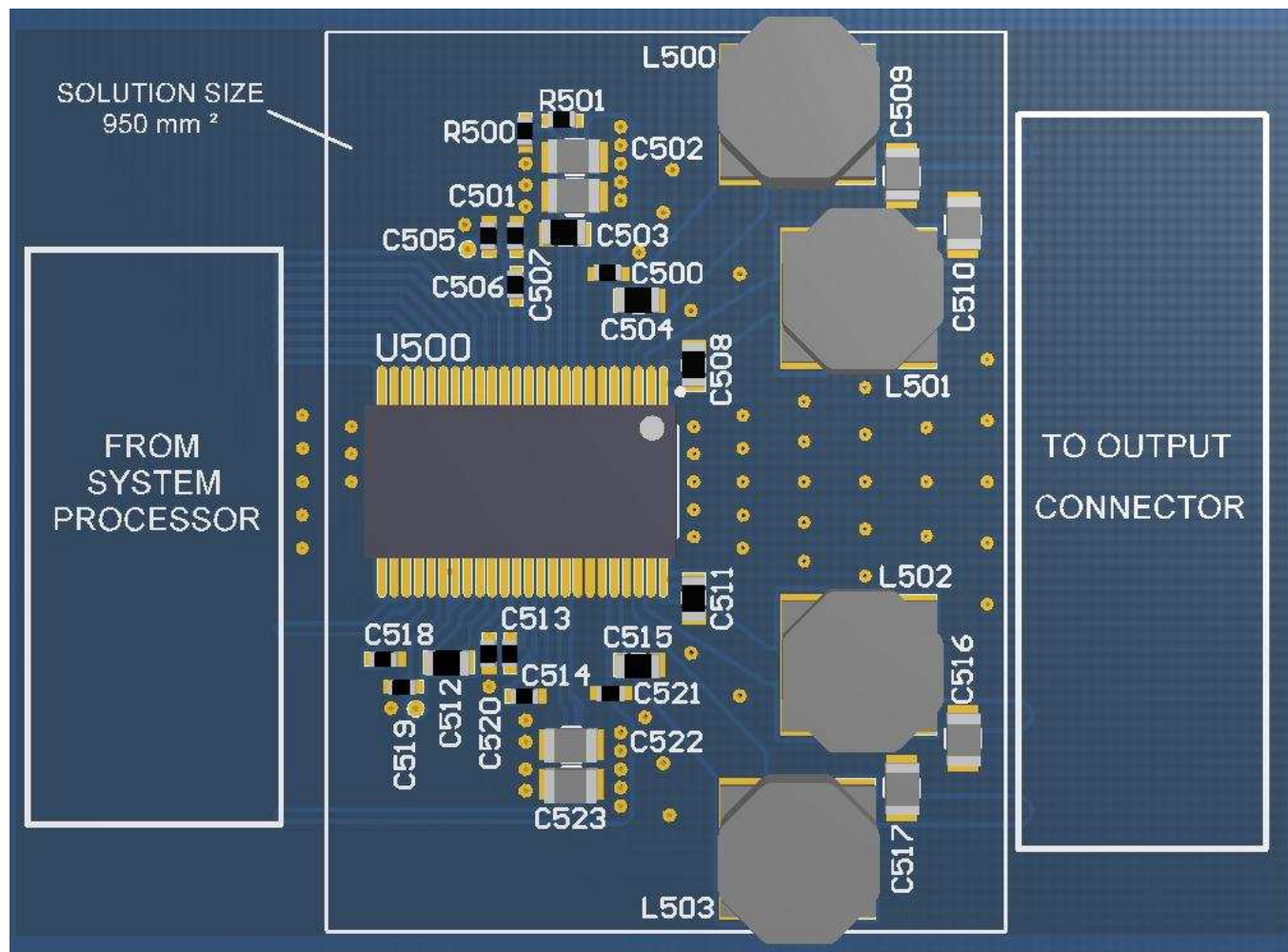


Figure 92. 2.2 (Dual Stereo BTL) Top Copper View

## Layout Example (continued)

### 11.2.5 1.1 (Bi-Amped BTL) Systems



**Figure 93. 1.1 (Bi-Amped BTL) 3-D View**

## Layout Example (continued)

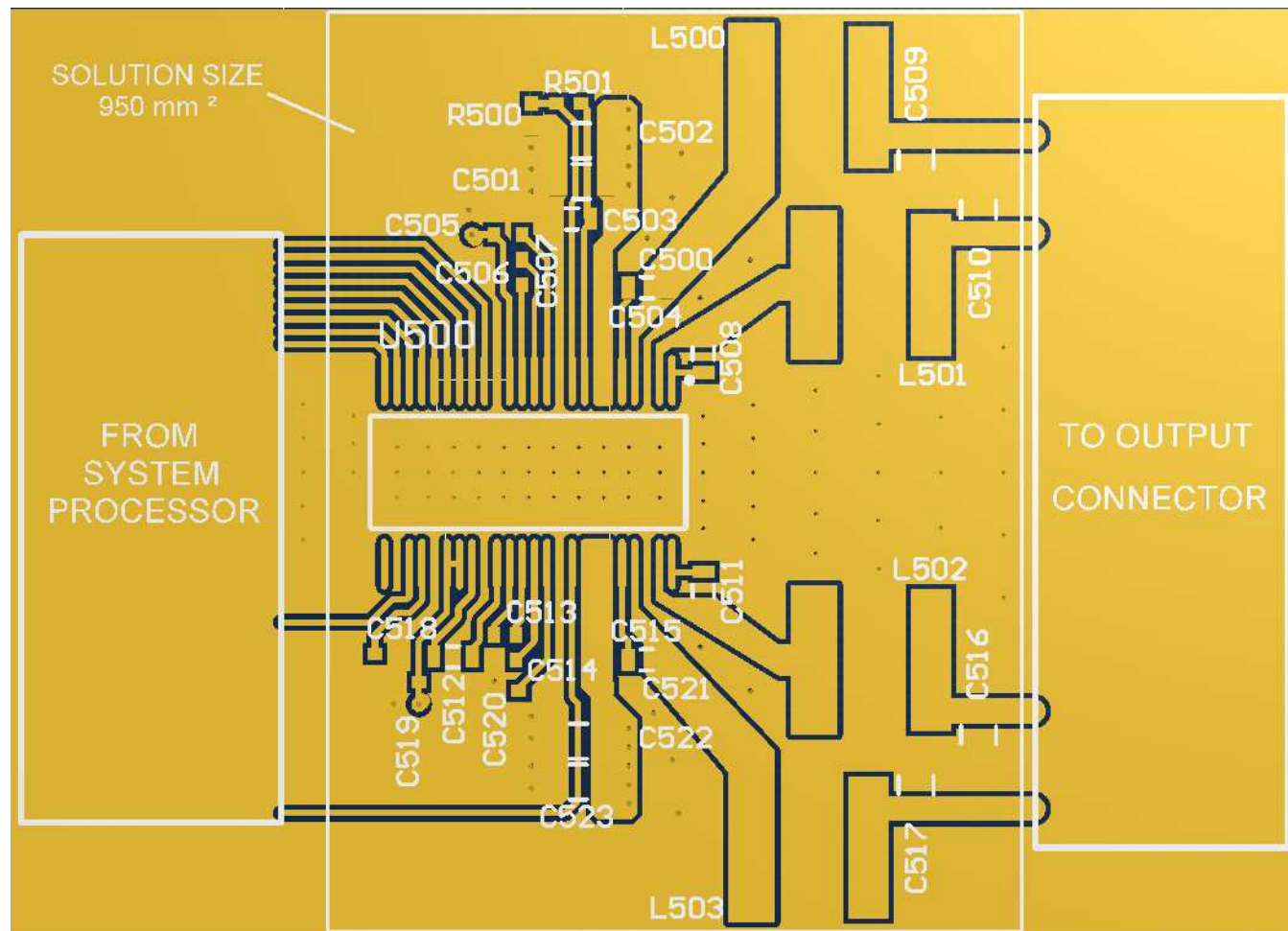


Figure 94. 2. 1.1 (Bi-Amped BTL) Top Copper View

## 12 Device and Documentation Support

### 12.1 Device Support

#### 12.1.1 Device Nomenclature

The glossary listed in the [Glossary](#) section is a general glossary with commonly used acronyms and words which are defined in accordance with a broad TI initiative to comply with industry standards such as JEDEC, IPC, IEEE, and others. The glossary provided in this section defines words, phrases, and acronyms that are unique to this product and documentation, collateral, or support tools and software used with this product. For any additional questions regarding definitions and terminology, please see the [e2e Audio Amplifier Forum](#).

**Bridge tied load (BTL)** is an output configuration in which one terminal of the speaker is connected to one half-bridge and the other terminal is connected to another half-bridge.

**DUT** refers to a *device under test* to differentiate one device from another.

**Closed-loop architecture** describes a topology in which the amplifier monitors the output terminals, comparing the output signal to the input signal and attempts to correct for non-linearities in the output.

**Dynamic controls** are those which are changed during normal use by either the system or the end-user.

**GPIO** is a general purpose input/output pin. It is a highly configurable, bi-directional digital pin which can perform many functions as required by the system.

**Host processor (also known as System Processor, Scalar, Host, or System Controller)** refers to device which serves as a central system controller, providing control information to devices connected to it as well as gathering audio source data from devices upstream from it and distributing it to other devices. This device often configures the controls of the audio processing devices (like the TAS5756M) in the audio path in order to optimize the audio output of a loudspeaker based on frequency response, time alignment, target sound pressure level, safe operating area of the system, and user preference.

**HybridFlow** uses components which are built in RAM and components which are built in ROM to make a configurable device that is easier to use than a fully-programmable device while remaining flexible enough to be used in several applications

**Maximum continuous output power** refers to the maximum output power that the amplifier can continuously deliver without shutting down when operated in a 25°C ambient temperature. Testing is performed for the period of time required that their temperatures reach thermal equilibrium and are no longer increasing

**Parallel bridge tied load (PBTL)** is an output configuration in which one terminal of the speaker is connected to two half-bridges which have been placed in parallel and the other terminal is connected to another pair of half bridges placed in parallel

$r_{DS(on)}$  is a measure of the on-resistance of the MOSFETs used in the output stage of the amplifier.

**Static controls/Static configurations** are controls which do not change while the system is in normal use.

**Vias** are copper-plated through-hole in a PCB.

#### 12.1.2 Development Support

For the PurePath Console Software, go to [www.ti.com/tool/purepathconsole](http://www.ti.com/tool/purepathconsole).

See the User Guide, *Using the TAS5754/6M HybridFlow Processor (SLAU577)* for detailed information regarding the HybridFlow Processing and available HybridFlows.

### 12.2 Community Resources

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's [Terms of Use](#).

**TI E2E™ Online Community TI's Engineer-to-Engineer (E2E) Community.** Created to foster collaboration among engineers. At [e2e.ti.com](http://e2e.ti.com), you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.

## Community Resources (continued)

**Design Support** *TI's Design Support* Quickly find helpful E2E forums along with design support tools and contact information for technical support.

### 12.3 Trademarks

PurePath, PowerPAD, E2E are trademarks of Texas Instruments.  
Burr-Brown is a registered trademark of Texas Instruments.  
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### 12.4 Electrostatic Discharge Caution



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

### 12.5 Glossary

[SLYZ022](#) — *TI Glossary*.

This glossary lists and explains terms, acronyms, and definitions.

## 13 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

## PACKAGING INFORMATION

| Orderable part number        | Status<br>(1) | Material type<br>(2) | Package   Pins    | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|------------------------------|---------------|----------------------|-------------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| <a href="#">TAS5756MDCA</a>  | Active        | Production           | HTSSOP (DCA)   48 | 40   TUBE             | Yes         | NIPDAU                               | Level-3-260C-168 HR               | -25 to 85    | TAS5756M            |
| TAS5756MDCA.A                | Active        | Production           | HTSSOP (DCA)   48 | 40   TUBE             | Yes         | NIPDAU                               | Level-3-260C-168 HR               | -25 to 85    | TAS5756M            |
| <a href="#">TAS5756MDCAR</a> | Active        | Production           | HTSSOP (DCA)   48 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-3-260C-168 HR               | -25 to 85    | TAS5756M            |
| TAS5756MDCAR.A               | Active        | Production           | HTSSOP (DCA)   48 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-3-260C-168 HR               | -25 to 85    | TAS5756M            |

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

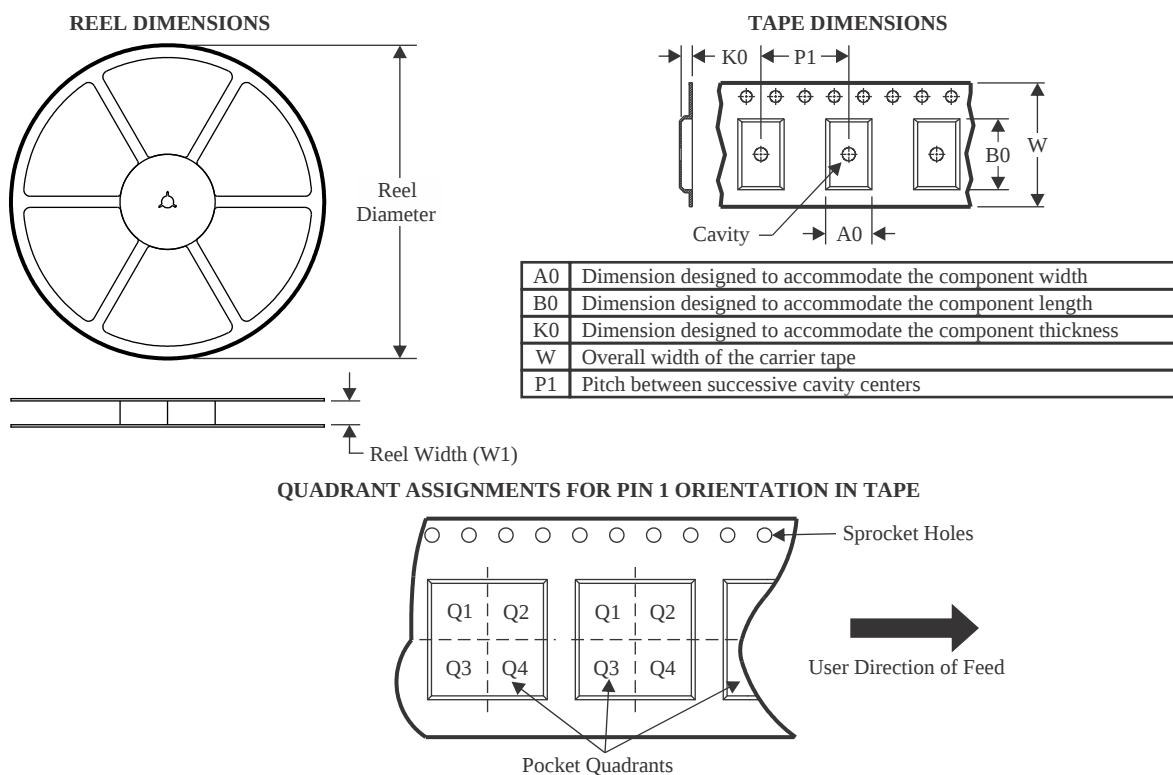
<sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "-" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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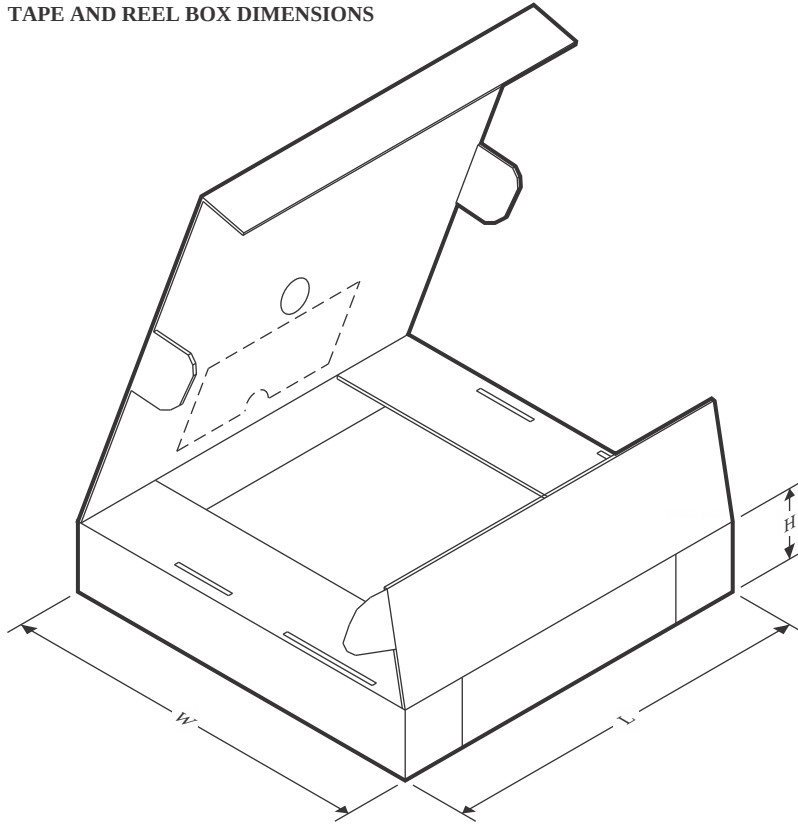
## TAPE AND REEL INFORMATION



\*All dimensions are nominal

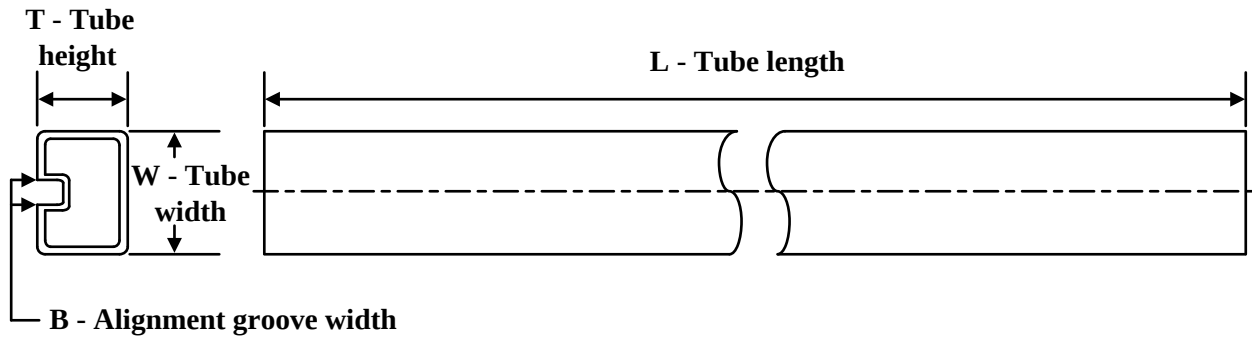
| Device       | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|--------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| TAS5756MDCAR | HTSSOP       | DCA             | 48   | 2000 | 330.0              | 24.4               | 8.6     | 13.0    | 1.8     | 12.0    | 24.0   | Q1            |

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device       | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|--------------|--------------|-----------------|------|------|-------------|------------|-------------|
| TAS5756MDCAR | HTSSOP       | DCA             | 48   | 2000 | 350.0       | 350.0      | 43.0        |

**TUBE**


\*All dimensions are nominal

| Device        | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (μm) | B (mm) |
|---------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| TAS5756MDCA   | DCA          | HTSSOP       | 48   | 40  | 530    | 11.89  | 3600   | 4.9    |
| TAS5756MDCA.A | DCA          | HTSSOP       | 48   | 40  | 530    | 11.89  | 3600   | 4.9    |

## GENERIC PACKAGE VIEW

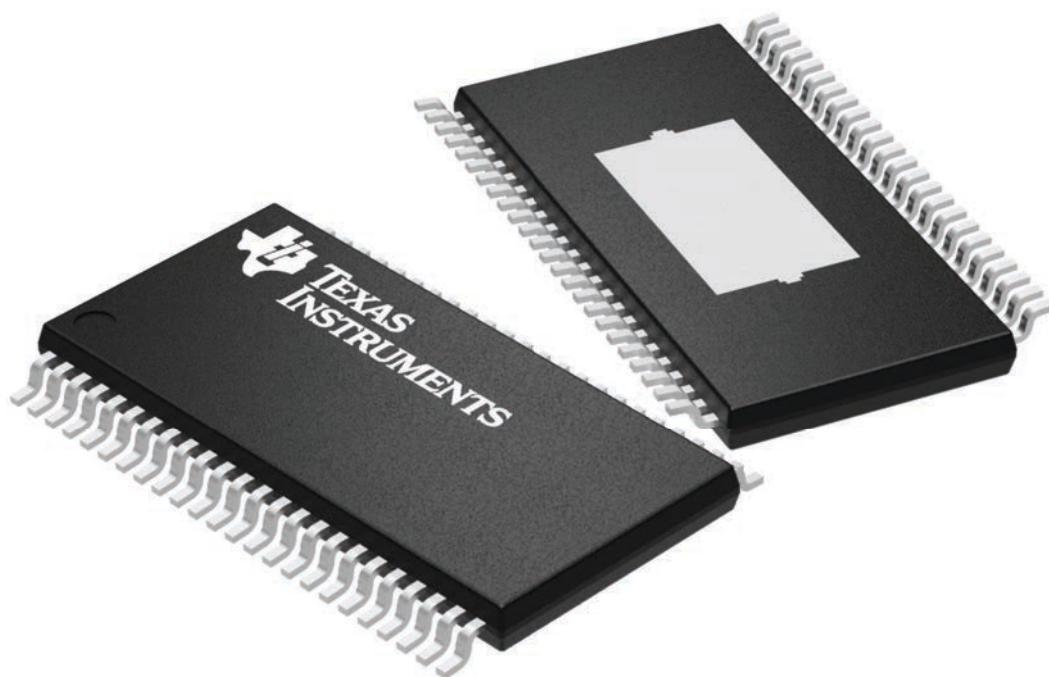
**DCA 48**

**HTSSOP - 1.2 mm max height**

12.5 x 6.1, 0.5 mm pitch

SMALL OUTLINE PACKAGE

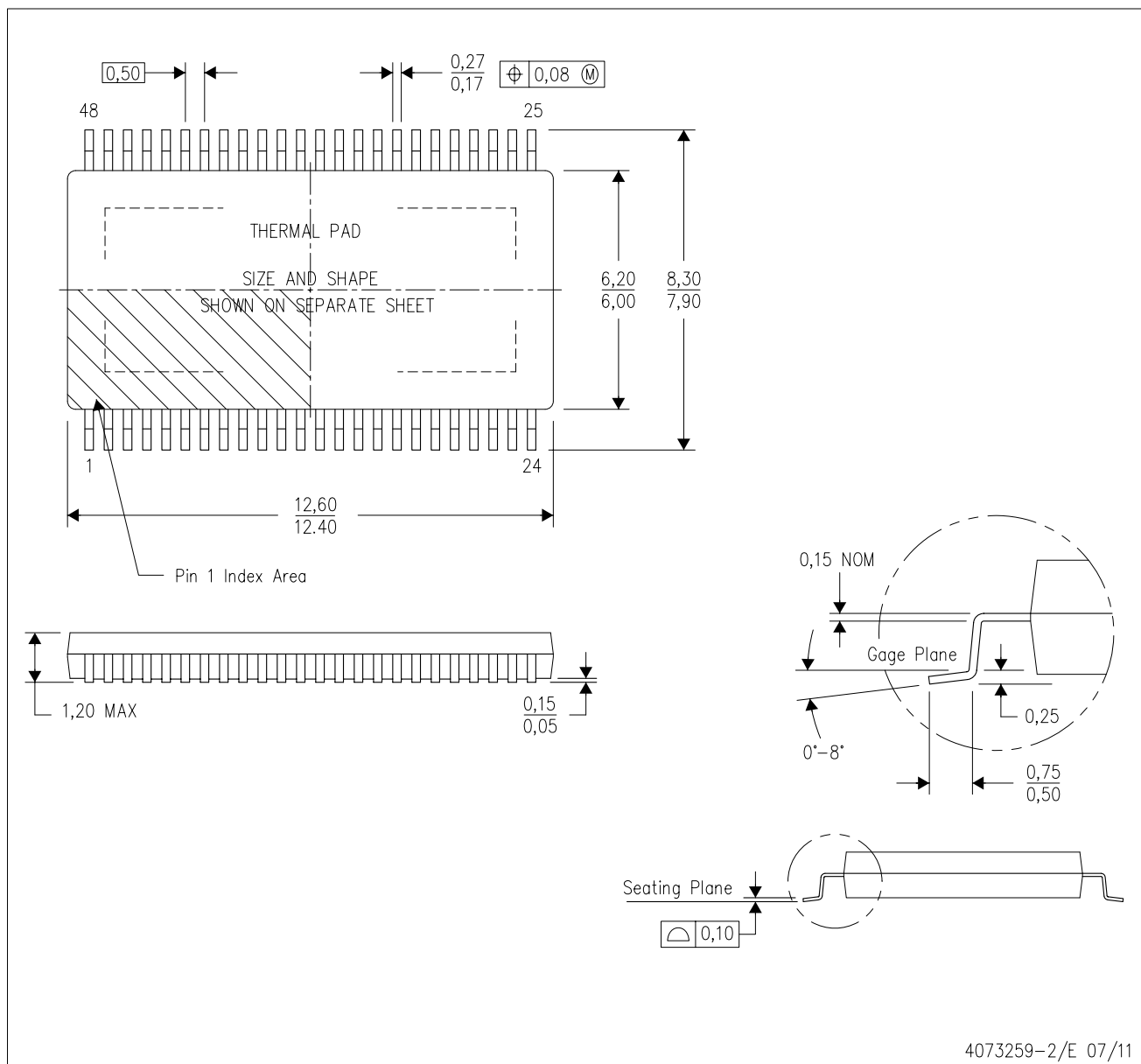
This image is a representation of the package family, actual package may vary.  
Refer to the product data sheet for package details.



4224608/A

DCA (R-PDSO-G48)

PowerPAD™ PLASTIC SMALL-OUTLINE



- NOTES:
- All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
  - This drawing is subject to change without notice.
  - Body dimensions do not include mold flash or protrusion not to exceed 0.15.
  - This package is designed to be soldered to a thermal pad on the board. Refer to Technical Brief, PowerPad Thermally Enhanced Package, Texas Instruments Literature No. SLMA002 for information regarding recommended board layout. This document is available at [www.ti.com](http://www.ti.com) <<http://www.ti.com>>.
  - See the additional figure in the Product Data Sheet for details regarding the exposed thermal pad features and dimensions.
  - Falls within JEDEC MO-153

PowerPAD is a trademark of Texas Instruments.

DCA (R-PDSO-G48)

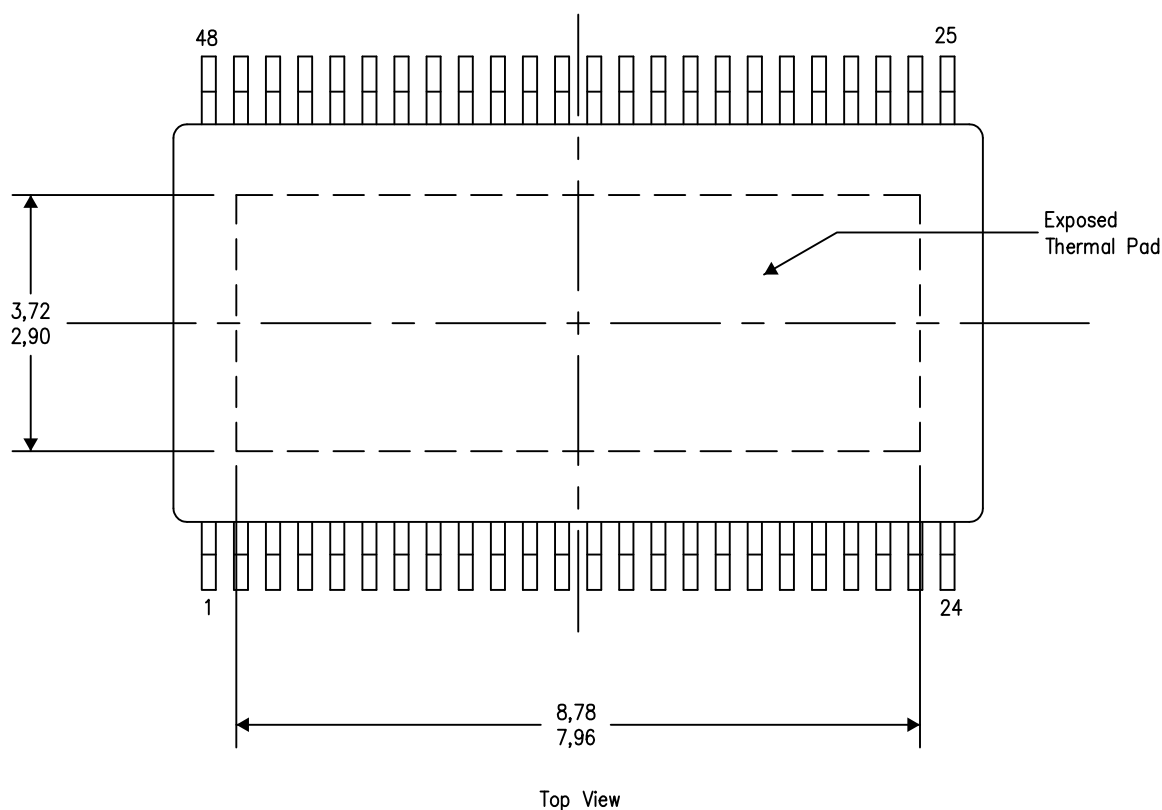
PowerPAD™ PLASTIC SMALL OUTLINE

## THERMAL INFORMATION

This PowerPAD™ package incorporates an exposed thermal pad that is designed to be attached to a printed circuit board (PCB). The thermal pad must be soldered directly to the PCB. After soldering, the PCB can be used as a heatsink. In addition, through the use of thermal vias, the thermal pad can be attached directly to the appropriate copper plane shown in the electrical schematic for the device, or alternatively, can be attached to a special heatsink structure designed into the PCB. This design optimizes the heat transfer from the integrated circuit (IC).

For additional information on the PowerPAD package and how to take advantage of its heat dissipating abilities, refer to Technical Brief, PowerPAD Thermally Enhanced Package, Texas Instruments Literature No. SLMA002 and Application Brief, PowerPAD Made Easy, Texas Instruments Literature No. SLMA004. Both documents are available at [www.ti.com](http://www.ti.com).

The exposed thermal pad dimensions for this package are shown in the following illustration.



Exposed Thermal Pad Dimensions

4206320-7/S 11/14

NOTE: A. All linear dimensions are in millimeters

PowerPAD is a trademark of Texas Instruments.

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